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AGREEMENT FOR ROBLAB(NxR)

This agreement is made as of the 25th day of July in the year 2023 at Mahendergarh by and between AICRA (ALL INDIA COUNCIL FOR ROBOTICS AND AUTOMATON), having its corporate office at 225, US Complex Insola, New Delhi 110076.

AND Rao Pahlad Singh Group of Institutions, (which expression shall, unless repugnant to the context or meaning thereof, include the successors and permitted assigns) located at village Balana, Mahendergarh (Haryana).

AND Shiva Institute of Technology and Management, Grain Market, Rewari, State Chapter Haryana of AICRA located at Rewari.

This agreement is made, aiming to constitute Institute's "RoboLab" with following Obligations and terms & conditions:

OBLIGATIONS OF AICRA:

- i. **Lab Set up:** AICRA will set up Zero Inception NxR Lab – Level 1 at college premise. The lab will consist required kits and components so all member students can develop projects as per syllabus in groups in classes.
- ii. **Member Certification:** AICRA would arrange a test for all enrolled and eligible RoboLab members online/off line (as decided mutually) (O-Level, A-Level and B-Level). Member will get respective certificate from AICRA after clearing the test successfully, conducted annually once.
- iii. **Communication:** AICRA'S National Coordinator would ensure all communications to College management as well as members via email for all updates on the industry, competitions etc.
- iv. **Member preparation for Robotics Competitions:** AICRA would ensure to help all RoboLab members to make their robotics project for National/International competitions. This support is limited to guiding members and not providing additional kits and components for the same.
- v. **Membership Fee:** AICRA would charge annual membership fee of INR 9200+GST from each learner who becomes the member of Robo Lab as per the proposed offer.
- vi. **Change in Membership Fee:** AICRA would not make any change in membership for running session but free to make changes every year at its own discretion based on the market situation or regulatory requirement.
- vii. **Usage of Partner's Logo:** AICRA authorize College to use its associate's logo for its promotion purpose.
- viii. **Marketing Support:** AICRA shall, on best effort basis, provide promotional materials like brochures, collaterals to college/school for effective promotion of the RoboLab and provide intimation to the college/school, in the event of any change(s) / revision (s) / updation (s) / alteration (s), from time to time in either services or fees.
- ix. **Internship:** Out of the first batch 2 to 3 students excelling in projects & theory will be picked up by Abira Automation Pvt Ltd for internship against stipend for a period of six months on their merit, absorption in the main stream of the company solely lies with AICRA.



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[Handwritten signature]
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

OBLIGATIONS of State Chapter (SC of AICRA < address >) :

- i. **Member's training:** State Chapter of AICRA will fix up training schedule for the entire year/semester subject to approval from college management. State Chapter Rewari is supposed to send its trainers to execute training sessions at college premise as per schedule.
- ii. **Training Modules:** State Chapter of AICRA would follow module designed and certified by "All India Council for Robotics & Automation (AICRA)"
- iii. **Progress Report:** State Chapter of AICRA would share progress report of training (attendance) and projects to College management and AICRA every month.

OBLIGATIONS OF COLLEGE:

- i. **Set up Cost:** M/S Rao Pahlad Singh Group of Institutions hereby agrees to pay INR1200/- + GST/annum against each member of RoboLab.
- ii. **Membership Count:** M/S Rao Pahlad Singh Group of Institutions hereby agrees and undertakes to provide minimum..... students at the starting of the session. Institute has flexibility to increase members throughout the year.
- iii. **Premise Usage:** M/S Rao Pahlad Singh Group of Institutions hereby agrees to provide dedicated premise for RoboLab activities along with required basic infrastructure facilities that includes audio and video, presentation board etc.
- iv. **RoboLab Coordinator:** M/S Rao Pahlad Singh Group of Institutions hereby agrees to appoint a faculty coordinator as "Single Point of Contact (SPOC)" to facilitate all communication with RoboLab members time to time.
- v. **Membership Fee Collection:** M/S Rao Pahlad Singh Group of Institutions shall be solely responsible for the collection of the membership fee from RoboLab members. The same shall be handed over to AICRA to start RoboLab services. All the collections have been made in advance.
- vi. **Member Support:** M/S Rao Pahlad Singh Group of Institutions hereby agrees to provide all cooperation to AICRA for directing the student interested in RoboLab activities.
- vii. **Market development obligation:** Unless otherwise contained in the Agreement, M/S Rao Pahlad Singh Group of Institutions will be solely responsible to promote and develop the concept effectively within college, ensuring members enrollment etc. in order to discharge its obligations, in an appropriate and efficient manner, as desired by State Chapter of AICRA & AICRA.
- viii. **Changes in terms and conditions of the agreement:** M/S Rao Pahlad Singh Group of Institutions agrees and understands that AICRA shall be entitled to make at any time and from time to time changes in the terms and conditions of this Agreement which in the absolute discretion of AICRA, becomes necessary due to any change in business requirements / emergencies, provisions of law, rules or regulations by government.
- ix. **MOU for 3 years :** M/S Rao Pahlad Singh Group of Institutions can retain the lab on "as is where basis" , on successful completion of 3 years with the same number of students enrolled as agreed upon on initiation or more .

IN WITNESS WHEREOF, AICRA with State Chapter of AICRA and the College/Institute cause this agreement to be executed by their duly authorized signatory/ies identified below:


Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)

For,
AICRA

Signature & Stamp: _____

Name: Raj. Kumar Sharma
PRESIDENT AICRA.

Designation: Prop / Partner / Director

SC of AICRA (_____)

Signature & Stamp: _____

Name: SACHIN AGARWAL

Designation: PARTNER

For
College / institution

Signature & Stamp: _____

Name: Dr. Mahesh Kumar Yadav

Designation :

M. Yadav
Director
R.P.S Group of Institutions
Balana, Mohindergarh
(Haryana)



M. Yadav
Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)

MEMORANDUM OF UNDERSTANDING

This Memorandum of Understanding ("MOU") is made and entered into on this 16th day of May, 2023 ("Effective Date") by and between:

Rao Pahlad Singh Group of Institutions, Balana an Educational Institute/Company, Affiliated with **Indira Gandhi University**, Meerpur- Rewari (Haryana) having its office at **Balana, Mahendragarh- Satnali Road, Mahendragarh- Haryana** represented by **Mr. Saroj Kumar Gupta** (918512878482) hereinafter referred to as "SPOC" (Which term shall unless repugnant to the context include its successor, representatives, administrators and permitted assign), of the First Part

AND

TalentServe India Private Limited (Referred as **TalentServe**), an EdTech StartUp DPIIT Registered incorporated under Companies Act and, having its corporate office at C-103, 1st Floor, Shree Sai Tower CHSL Sodawala Lane, Near Sterling Hospital, Borivali West, Mumbai, Maharashtra 400092 represented by **Business Head, Centre for Continuing Education (CCE) In Up Skilling & Reskilling to Students**, hereinafter referred to as "TalentServe" (which term shall unless repugnant to the context include its successor, representatives, administrators and permitted assign), of the Second Part.

WHEREAS **RPS GOI** and **TALENTSERVE** are hereinafter referred to individually as the Party and collectively as the Parties.

AND WHEREAS:

The function of **RPS GOI** includes Educational Institute.

TALENTSERVE is one of the premier EdTech Institutes to provide meaningful education, to conduct Course Curriculum original research, up skilling, Live Projects & Assured Placements of the highest standard and to enhance leadership in technological & managerial hiring for the industrial growth of the country. **TALENTSERVE** imparts and undertakes cutting-edge Learnings from Industry Experts in various areas of science, engineering, design, & management,

RPS GOI wishes to engage **TALENTSERVE** to undertake identified programs/activities like workshops and technical training programs as per general framework in Annexure-A, as agreed to between the Parties using **TALENTSERVE**'s academic expertise in the area and resources in conducting such meaningful programs/activities. The other programs/activities identified later would be detailed out in the due course.

Saraj Kumar Gupta

Saraj Kumar Gupta
Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)



...Mr. Ghanendra Singh.....from, TALENTSERVE will be the **Program Head** of the programs/activities to be undertaken under this MoU and would be responsible for all the required communications with **RPS GOI** and its representatives with respect to this MoU.

NOW THEREFORE, the Parties agree to the following terms and conditions:-

1. TALENTSERVE will organize and conduct the identified programs/activities for specific duration as mentioned hereunder (**Annexure-A**). The schedule of the identified program/ activities may be changed as per mutual consent of the Parties. The initial period of MoU will be for a period of 2 years from the Effective Date and thereafter the same can be extended in writing for a period as agreed upon by the Parties.
2. The main aim of the identified programs/activities will be **DATA Science SARTHI**. An output produced, if any, as an outcome of the identified activities, may be published as Discussion Notes, Industry Learning & Exposure or other means as feasible and as identified by TALENTSERVE.
3. TALENTSERVE would submit a financial proposal towards organizing program/activity for the specified number of participants to be nominated by **Mr. Saroj Kumar Gupta**
4. The program / activities may be hosted either at TALENTSERVE or at any other venue to be mutually decided by the Parties. The venue so decided may include locations within India and/or abroad. The responsibility for bearing the costs associated with the travel to/from the location, including incidental expenses, DA etc for the program participant faculties/ experts shall be as decided by **RPS GOI**. In consultation with TALENTSERVE, each program/activity and would be spelled out in the respective proposal for each program/activity.
5. To enhance diversity of participants and also in order to lower the costs in various programs/activities, TALENTSERVE may also enroll additional participants including those representing **RPS GOI** etc. Such participants would directly pay TALENTSERVE a registration fee as per process and as decided by TALENTSERVE, and which will be solely utilized by TALENTSERVE. The number of such participants should generally not exceed the participants from **100**. Some of the additional participants may be funded by other funding sources e.g. CSR Funds etc and /or activities coordinated by TALENTSERVE.
6. TALENTSERVE may engage necessary staff, either already employed and assisting other works at the department or specifically employed to assist in the delivery of such programs/ activities.

M. G. Das



M. G. Das
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

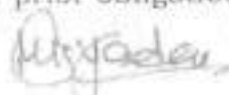


7. **RPS GOI** and TALENTSERVE would jointly decide the schedule and agenda for the program/activity (as submitted by TALENTSERVE) keeping in view the convenience, resource persons, required facilities and infrastructure on TALENTSERVE campus or any other locations as decided.
8. Program Coordinator would ensure necessary budgetary and administrative approvals as required for a smooth conduct of the programs/activities well in advance (normally at least one month in advance) and inform TALENTSERVE, so that appropriate arrangements can be initiated.
9. TALENTSERVE will provide Certificate of Participation to each participant on successful completion of the respective program/activity in the prescribed format as approved by Centre for Continuing Education (CCE).
10. The award of certificates by TALENTSERVE would in no-way means to establish that the said training programs/activity are part of a regular academic program at TALENTSERVE. Party can use name of the other Party and associated programs/activities, and its associated logos for any future programs/activities are covered under this MoU.
11. Relevant information about **RPS GOI** and TALENTSERVE (including the Centre for Continuing Education (CCE) and their respective logos may be used on brochures, advertisements, banners, websites/web pages, newsletters, discussion notes, working papers, program material (hard and/or soft copies), online content and other means for information dissemination about the programs/activities under this MoU.
12. TALENTSERVE and would have rights on the design content and outputs of the Programs/activities in all formats and forms of creation, display, delivery, sharing, publication, distribution, archival and retrieval. The copyright of the reports shall rest with the respective authors. All Intellectual Property Rights in any materials provided or made accessible by either Party to the other will remain with the Party providing or making available such materials and nothing in this MoU is intended to or shall affect a transfer of any such Intellectual Property Rights of either party to the other.
13. This MoU is on principal-to-principal basis and (save where expressly stated in writing in this MoU) nothing contained herein shall be deemed as any collaboration, partnership, joint venture, or agency between the Parties hereto, nor shall anything in this MoU create any employer-employee relationship among the parties or between one party and the employees, contractors, or agents of the other party, nor authorize any party to make or enter into any commitments for or on behalf of other party.
14. Prevalent taxes, duties, levies etc. as well as the applicable institutional overheads would be applicable on the amounts paid to TALENTSERVE from time to time. TALENTSERVE is exempted from payment of income tax.
15. The programs/activities to be conducted under this MoU would be interactive discussion/workshop-oriented/training activities. The programs/activities to be conducted under this MoU would be managed through CCE, TALENTSERVE



[Signature]

16. RPS GOI and TALENTSERVE can engage closely to work on variety of topics of mutual interest. TALENTSERVE would also be willing to host relevant officers from TALENT SERVE to Department of B Tech (ECE/ EE/ CSE/ ME & Civil)/ BBA/ MBA & Diploma for short durations, generally for about 1-2 weeks.
17. The Program Coordinator would arrange for suitable accommodation and working space for such visiting officers. However, all costs associated with travel and stay of the visiting officers would be borne by either party based on prior confirmation and approvals.
18. This document constitutes the entire understanding and agreement of the Parties. No amendment, change, or modification of this agreement shall be valid unless put in writing and signed by the Parties hereto.
19. In case of cancellation of a Program/activity, TALENTSERVE would not be liable for any costs or liabilities associated with the same. Any cost arising out of cancellation of reservations, and other committed expenses would be borne by TALENT SERVE to the extent of participants nominated by Mr. Saroj Kumar Gupta.
20. Neither Party shall be responsible for failure to fulfill any obligation for so long as, and to the extent to which, the fulfillment of such obligation is impeded by a Force Majeure Event.
21. Each Party shall at all times indemnify and hold harmless the other party from and against any and all third-party claims, damages, expenses (including without limitation, any attorney's fees and expenses), liabilities, judgments, awards, actions, suits, proceedings, claims, demands, investigations, penalties, damages, penalties, fines, settlements, costs etc.
22. Any dispute or difference that may arise between the parties out of or in connection with this MoU shall, at first instance, be amicably settled between the parties. However, if the dispute remains unresolved in spite of best efforts made by the parties, the same shall be referred to a mutually agreed Sole Arbitrator. The proceedings shall be conducted in accordance with the Arbitration and Conciliation Act, 1996, or any statutory modification thereof. The order passed by such Arbitrator shall be final and binding on the Parties to this MoU. The language of this arbitration shall be English, and the seat and venue of arbitration shall be Mumbai, Maharashtra.
23. This MoU shall be governed by and construed in accordance with the laws of India, without giving effect to any conflict of law provisions. The Parties agree that Courts at Mumbai, Maharashtra, India, shall have exclusive jurisdiction over any unsettled disputes arising out of and/or in connection with this MoU.
24. Each Party shall have the right to terminate the MoU by giving two months' prior notice in writing to the other Party at any time. If MoU is terminated by
25. Either Party, steps shall be taken to ensure that the termination does not affect any prior obligation, project or activity already in progress.





TalentServe

Shaping talent across

IN WITNESS WHEREOF, this MoU is duly executed on the day, month and year first herein above written in the presence of:

	Signed & delivered for & on behalf of RPS GOI.	Signed & delivered for & on behalf of TalentServe
Signature		
Name	Dr. Mahesh K. Yadav	
Designation	Director Rao Pahlad Singh Group of Institutions Balana, Mahendragarh- Haryana	Business Head, Centre for Continuing Education, TalentServe
Date	16 th May, 2023	

WITNESSES:

Witness 1:	Witness 2:
Signature:	Signature:
Name: Vikas Sharma	Name:



Principal
R.P.S. College of Engg. & Tech
Balana, Mohindergarh (HR.)

Annexure A

Program/Activity (Data Science Beta Programme)

About the Program/Activity

Key features of the Program

Features	Remarks
Program Title	Data Science Beta Programme
Duration	3 Months
Main Participants	Students
Other Participants	Teachers
No. of Participants	About 100 participants from Engg Dept
Funding	<u>1st Batch Cost will be borne by CSR Funding</u> (for ___ participants), registration fee, other funding support, post that Institute will bear cost ___ per student.
Location	India and/or international locations
Experts	Resources persons from related organizations



M. Yadav

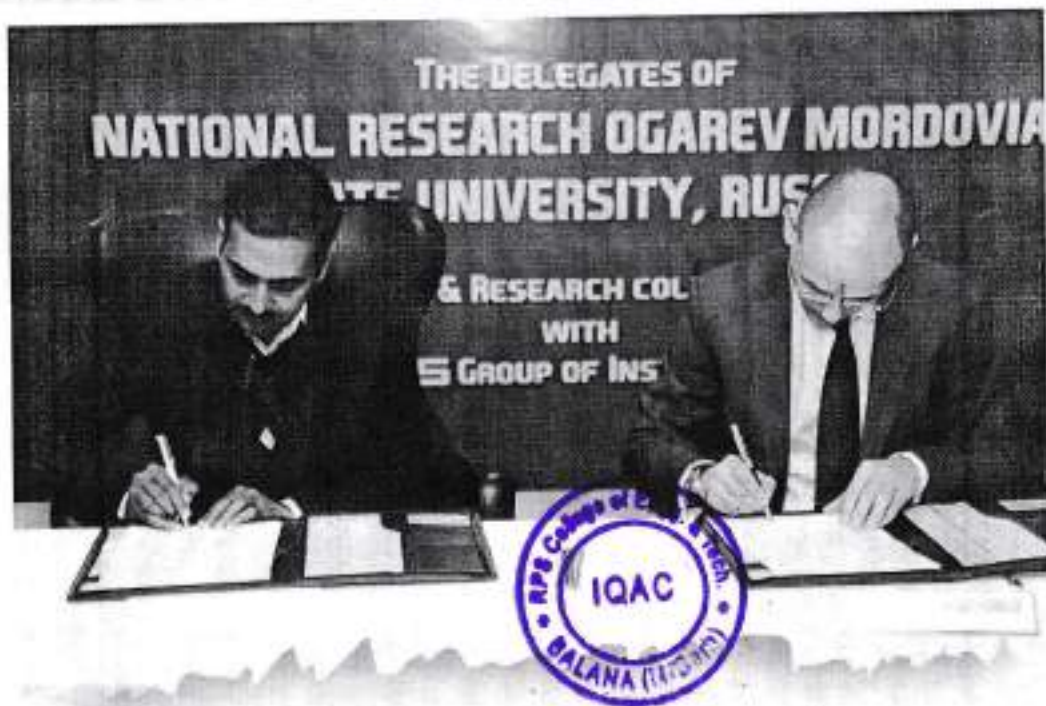
M. Yadav
Principal
RPS College of Engg. & Tech
Balana Mchindergarh (HR.)

Congratulations!



RPS GROUP OF COLLEGES
Under the aegis of RPS Education Society, M/Cart

Scripts
Academic & Research Collaboration
with
National Research Ogarev Mordovia
State University, Russia



*Signed MOU on January 6, 2023 for a
brighter future together.*

Ujjwala
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Congratulations!



RPS GROUP OF COLLEGES
Under the aegis of RPS Education Society, M/Garh

Scripts
Academic & Research Collaboration
with
National Research Ogarev Mordovia
State University, Russia



*Signed MOU on **January 6, 2023** for a
brighter future together.*

Nurjahan
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

आरपीएस कॉलेज का रूस की नेशनल रिसर्च ओगरेव विश्वविद्यालय मोरडोविया के साथ शैक्षिक सहभागिता पर किया गया समझौता

भारत न्यूज़ महेंदरगढ़



नेशनल रिसर्च ओगरेव विश्वविद्यालय मोरडोविया रूस के साथ आरपीएस कॉलेज का शैक्षिक सहभागिता व आपसी शिक्षा व अनुसंधान के क्षेत्र में सहयोग पर समझौते पर हस्ताक्षर हुए। इस समझौते में मोरडोविया रूस विश्वविद्यालय से दिमित्री ग्लुस्को-रेक्टर, प्रो विक्टर रेविन डीन ऑफ फैक्ट्री बायोटेक्नॉलोजी व बायोलॉजी, प्रो ओलगा खेवा डिप्टी डॉयरेक्टर मैडिसिन, प्रो अनाटोली लिसियाको हेड साइंटिफिक रिसर्च, डॉ धर्मेन्द्र कुमार डॉयरेक्टर एन.ई.एस व आरपीएस कॉलेज की तरफ से डीन वेटेनरी डॉ आरके चांदोलिया, डॉयरेक्टर डॉ महेश यादव, रजिस्ट्रार डॉ देवेन्द्र यादव, डॉ आनंद यादव मौजूद रहे। इस समझौते पर आरपीएस ग्रुप की तरफ से डॉ देवेन्द्र यादव, रजिस्ट्रार तथा रशियन यूनिवर्सिटी की तरफ से दिमित्री ग्लुस्को-रेक्टर ने हस्ताक्षर किए।

आरपीएस कॉलेज के रजिस्ट्रार डॉ. देवेन्द्र यादव ने कहा कि नेशनल रिसर्च ओगरेव विश्वविद्यालय मोरडोविया रूस की सबसे पुरानी रिसर्च विश्वविद्यालयों में से एक है। जिसकी स्थापना 1931ई. में हुई थी। हाल ही में इस आरपीएस कॉलेज बलाना के साथ शिक्षा के क्षेत्र में बहुत बड़ी सहभागिता व सहयोग तय हो गया है। इससे क्षेत्र की प्रतिभाएं विदेशी शोधात्मक व रचनात्मक शिक्षा के साथ आपसी शैक्षिक सहयोग करके एक-दूसरे के साथ सहज रूप से कार्य कर सकेंगीं। इसमें वेटेनरी कोर्स, तकनीकी कोर्स, मैनेजमेंट कोर्स व विभिन्न विज्ञान आधारित डिग्री, डिप्लोमा कोर्स में एक-दूसरे के साथ मिल-जुलकर शिक्षा व रिसर्च कार्यों पर कार्य करेंगीं। इससे शिक्षा में व्यापक सुधार होगा व शिक्षकों, विद्यार्थियों को शिक्षा के क्षेत्र में अनुसंधान व शोधात्मक कार्यों में विशेष लाभ के साथ क्षेत्र के लिए यह समझौता मौल का पत्थर साबित होगा।



इस अपार खुशी पर संस्था की चेयरपर्सन डॉ पवित्रा राव ने बधाई देते हुए कहा कि यह उपलब्धि व समझौता हम सब के लिए शिक्षा के क्षेत्र में सर्वांगण विकास में मौल का पत्थर साबित होगा। इस सहभागिता से हम विदेशी शिक्षा के विभिन्न आयामों व उपलब्धियों पर बढ़चढ़कर एक-दूसरे के साथ काम कर सकेंगे। जो विचारधारा संस्था के फाउंडर डॉयरेक्टर डॉ. ओपी यादव सोचते थे उन्हें वास्तविकता में उतार कर प्रत्येक अभिभावक, विद्यार्थी, शिक्षक के सपनों को साकार किया जा रहा है। यह उपलब्धि उनको सच्ची श्रद्धांजलि होगी। संस्था के सीईओ मनीष राव ने पूरे आरपीएस परिवार को बधाई देते हुए कहा कि आज का भारत नया भारत है। इस राष्ट्र का भविष्य स्वर्णिम रखने के लिए हमें पृथ्वी के हर छोर से शिक्षा के क्षेत्र में जुड़ने की आवश्यकता है ताकि हम अपनी प्रतिभाओं को दुनिया में महान बनाकर चमका सकें। आज क्षेत्र की प्रतिभाएं विदेशी शिक्षा के साथ काम करेंगी तो वे और अधिक रचनात्मक कार्य करके श्रेष्ठतम बन सकेंगी तथा अभिभावकों के सपनों को सहज रूप से साकार कर सकेंगीं। हम क्षेत्र की प्रतिभाओं को पूरे विश्व में शीर्ष पर रखने के लिए दृढ़ संकल्पित है। इस उपलब्धि पर कॉलेज के सभी विभागाध्यक्ष, शिक्षकों व विद्यार्थियों ने एक-दूसरे को बधाई दी।

Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

INDUSTRIAL VISIT

TRAINING & PLACEMENT RPS GROUP OF INSTITUTIONS

Dear Sir/ Madam

Greetings of The Day.....

RPS Group of Institutions arranging *Industrial Visit to Pilani- Rajasthan* for the students of **1st Year to Final Year (B Tech/ BBA/BCA & MBA)**.

HoDs are requested to ask interested students from above *Year/ Branch* to Register via QR Code or given link. **(latest by 04th June, 2022)**

Following are the instructions for your information and Compliance:

- All the students have to be in formal attire (**Male: Shirt & Trouser || Female: Salwar Suit or Shirt & Trouser**).
- Boys are supposed to be neat in appearance. (clean shaved)
- You can carry your refreshment (snacks, water, etc.)
- You are not supposed to engage in any unacceptable activity that would hamper the repute of the institute (*like smoking, chewing pan masala etc.*)
- You have to safeguard your own belongings & please avoid bringing any expensive gadget or valuables.
- You have to report to escorting faculty.
- You are not supposed to go anywhere without faculty permission.
- You are expected to be in line with the faculty decision, and behave in a decent manner.



<https://bit.ly/IndusVisit2022>



Feel free to give me a call if you have any query

Thanks & Regards,

Vikas Sharma

Head: Corporate Affairs || Trng. & Placements

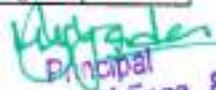
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Website: www.rpsinstitutions.org


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Sl. No.	Name	Class Roll No.	Mobile no. (Personal)	If Using College Bus, Write Bus No.	Mobile no. (Parents)	Course	Branch	Current Year
1	Abhishek sharma	21ME23	9306605541	46	8094019045	B Tech	Mechanical Engine	1st
2	AMAN KUMAR	21EC29	7082250889	57	7082250889	B Tech	Electronics & Com	1st
3	Aman kumar	21CS50	9729016179	40	8607847527	B Tech	Computer Science	1st
4	Amit kumar	21EE03	8307051932	58	8708653235	B Tech	Electrical Engineer	1st
5	Anita lamba	21cs80	9518629882	49	9416330080	B Tech	Computer Science	1st
6	Ankit Sharma	21CV10	9050261001	5	8295455418	B Tech	Civil Engineering	1st
7	Ankul	19BCA03	9467678600		9467678600	BCA	& Engineering	3rd
8	Ansh Sharma	21CS100	8053218181	12	9416838630	B Tech	Computer Science	1st
9	Anshul Naharwal	21CS88	8901721227	58	8708403996	B Tech	Computer Science	1st
10	Apurva	21bca31	9518993682	25	9518993682	BCA	& Engineering	1st
11	Arpit	21cs03	7988832205	22	9416318806	B Tech	Computer Science	1st
12	Asha	21CS44	9350327151	14	9817443743	B Tech	Computer Science	1st
13	Ashish kumar	21ME01	9350650895	37	8053781462	B Tech	Mechanical Engine	1st
14	Bhagatsingh	19BCA06	9817520654	20	8607408393	BCA	& Engineering	3rd
15	Bhunes	21EC22	9812012339		8930271293	B Tech	Electronics & Com	1st
16	Chhatrapal	21cs24	9728209731	54	9050239731	B Tech	Computer Science	1st
17	Deepak Gupta	21cs27	9053148835	58	9416750815	B Tech	Computer Science	1st
18	Deepanshu Rathore	21EE04	9050923858	53	9812396709	B Tech	Electrical Engineer	1st
19	Deepanshu Yadav	21CS01	9729298461	15	9466418013	B Tech	Computer Science	1st
20	Garima Dhillon	21CS20	7015259491	54	7015259491	B Tech	Computer Science	1st
21	Hari	19bca09	9350286783		9050208315	BCA	& Engineering	3rd
22	Himanshi	21bca43	9350115106	46	9416319042	BCA	& Engineering	1st
23	Himanshu	21EE08	8053497358	36	9308461738	B Tech	Electrical Engineer	1st
24	Himanshu	21cs78	9350857685	51	9991845860	B Tech	Computer Science	1st
25	JEET SINGH	21CS96	9050642962	5	8816966180	B Tech	Computer Science	1st
26	Jitendra Kumar	21ME18	8930818326		9467539806	B Tech	Mechanical Engine	1st
27	Jyoti	21BCA16	8638037123		8638037123	BCA	& Engineering	1st
28	Kajal yadav	21cs67	9813274185		8930353390	B Tech	Computer Science	1st
29	Kanchan	21cs11	8950617460	33	9518160193	B Tech	Computer Science	1st
30	Kapil	21CV01	9053723970	49	9813298108	B Tech	Civil Engineering	1st
31	Kartik rajput	21CS83	8708042328	54	8050433228	B Tech	Computer Science	1st
32	Keshav	21EC13	7988380401	33	94673524	B Tech	Electronics & Com	1st
33	Krish rao	21bca22	8398967279	53	9468660406	BCA	& Engineering	1st
34	Krishan	21cs91	8395942060	3	9468704437	B Tech	Computer Science	1st
35	Lakshay	21EC17	7015599704	53	805951959	B Tech	Electronics & Com	1st
36	Mahender kumar	21EC35	8307797914	10	8307797914	B Tech	Electronics & Com	1st
37	Chauhan	21CS49	7015271354	33	7015271354	B Tech	Computer Science	1st
38	Manish	21EC07	9991378260	24	9991378260	B Tech	Electronics & Com	1st
39	Manisha	21CS13	9671793919	19	9813493189	B Tech	& Engineering	1st
40	Mohammad Nofil	21CS23	7037510532		9548777723	M Tech	Computer Science	1st
41	Mohammad Zulkifl	21CS23	8193822287		8193822287	B Tech	Computer Science	1st
42	Mohdsuhail	21CV02	9045303811		7983107897	B Tech	Civil Engineering	1st
43	Mohit Kumar	21CS39	9817250425	4	9817250425	B Tech	Computer Science	1st
44	Monika	21CS21	8307636144	14	8307636144	B Tech	Computer Science	1st
45	Muskan Yadav	21BCA36	7892585132	1	7892585132	BCA	& Engineering	1st
46	Naveen	21ec15	9729474304	16	9812042304	B Tech	Electronics & Com	1st
47	Naveen kumar	21CS102	7027252303	54	8930307262	B Tech	Computer Science	1st
48	Navneet	21CS29	8059452650	35	9996975041	B Tech	Computer Science	1st
49	Nikhil	21cs52	9306845032	43	9991007708	B Tech	Computer Science	1st
50	Nitesh	21EC26	9671344613	8	9050408248	B Tech	Electronics & Com	1st
51	Nitin	21CS70	9802556300	36	9812502100	B Tech	Computer Science	1st
52	Nitin	21EE01	8053614922	40	8053614902	B Tech	Electrical Engineer	1st
53	Nitin Rao	21EE15	7027540167	22	7027540167	B Tech	Electrical Engineer	1st


 Principal
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54	Nitin singh	21EC06	7082239313	48	9671055457	B Tech	Electronics & Com	1st
55	Pankaj	21cv04	8816945546	26	9050261001	B Tech	Civil Engineering	1st
56	Pankaj Kumar	21CS72	9053713460	27	9991734458	B Tech	Computer Science	1st
57	Paramveer	21ec14	9729099196	57	8307116110	B Tech	Electronics & Com	1st
58	Parikshit	21EC11	8708416401		8708416401	B Tech	Electronics & Com	1st
59	Parth	21CS45	9813322922	51	9991556236	B Tech	Computer Science	1st
60	Parul	21cs17	9050623045	40	8816826371	B Tech	Computer Science	1st
61	Parvinder Kumar	21EC20	9350379796	51	9485765758	B Tech	Electronics & Com	1st
62	Piyush Kumar	21CS64	8396937863	6	9416237863	B Tech	Computer Science	1st
63	Pooja	21cs95	9306825421	55	9992145080	B Tech	Computer Science	1st
64	Preeti	12	8950480873	47	7497829648	BCA	& Engineering	1st
65	Priti	21CS34	9996266846	32	7206864927	B Tech	Computer Science	1st
66	Priya	21cs59	9518884606	20	9728208030	B Tech	Computer Science	1st
67	Priya	21CS69	9050996073	26	9416395254	B Tech	Computer Science	1st
68	Priya	21CS14	9813815591	19	9813815591	B Tech	Computer Science	1st
69	Priya Yadav	21CS75	9416455344	54	9050934784	B Tech	Computer Science	1st
70	Punit Rao	21CS58	7988144966	22	7988144966	B Tech	Computer Science	1st
71	Ravindra	19bca32	9053839907	26	8607638399	BCA	& Engineering	3rd
72	Rinki Sheoran	21cs81	9306581184	25	9812252878	B Tech	Computer Science	1st
73	Ritu kumari	21CS42	7404312860	18	9992644034	B Tech	Computer Science	1st
74	Rohit Kumar	21CS26	7206593941	10	9466082204	B Tech	Computer Science	1st
75	Rohit Yadav	19BCA34	8569913202	45	8569913202	BCA	& Engineering	3rd
76	Rupesh kumar	21CS19	9466497198	24	9416886050	B Tech	Computer Science	1st
77	Sachin	21CS82	8053382808		8901023808	B Tech	Computer Science	1st
78	Sachin Kumar	21CV11	8307884135	8	9813544723	B Tech	Civil Engineering	1st
79	saleem khan	21CS15	9812481080	20	8607063776	B Tech	Computer Science	1st
80	Sameen	21cs60	8059476777		9991212773	B Tech	Computer Science	1st
81	Santosh	21BCA19	8950505245	56	9587692800	BCA	Computer Science	1st
82	Satyavrit yadav	21CS18	9518884606	11	9992273888	B Tech	Computer Science	1st
83	Sumit	21EE10	9053441007		9050041007	B Tech	Electrical Engineer	1st
84	Sumit Singh	21CV07	9306581184	55	9813837984	B Tech	Civil Engineering	1st
85	Sushma	21CS55	8307798739	30	9813927156	B Tech	Computer Science	1st
86	Tamanna	21CS36	6393657128		9467350482	B Tech	Computer Science	1st
87	Tanuj	21CS77	9350756339	43	9416489576	B Tech	Computer Science	1st
88	Umang Dahiya	21cs62	9588925673	43	9813413647	B Tech	Computer Science	1st
89	Umar Khan	21CS68	9468401439	53	8950766267	B Tech	Computer Science	1st
90	Vashu	21ME24	9468131572	43	8307166352	B Tech	Mechanical Engine	1st
91	Vedvart	21cs05	8397814435	57	9416442477	B Tech	Computer Science	1st
92	Vivek	21CS98	7206273611	8	7206273611	B Tech	Computer Science	1st
93	Yatan Yadav	21ME05	9053692622	39	9671257921	B Tech	Mechanical Engine	1st
94	Yuvraj	21CS46	9050147320	29	9518199223	B Tech	Computer Science	1st


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LIST For Industrial Visit- 13 June, 2022

Sl. No.	Name	Class Roll No.	Mobile no. (Personal)	If Using College Bus, Write Bus No.	Mobile no. (Parents)	Course	Branch
1	Abhisek	20BCA21	8569869382	43	9416939983	BCA	Computer Science & E
2	Ajay	20CS01	9053243822	40	9896370564	B Tech	Computer Science & E
3	Akash Akash	20bca69	9350638317	14	9350638317	BCA	Computer Science & E
4	Aman Kumar	Btech	9485697216		9485697216	B Tech	Computer Science & E
5	Amanat	20bca40	8708286357	1	9306843880	BCA	Computer Science & E
6	Anil Kumar Siroha	20EC02	8278484459	13	8278484459	B Tech	Electronics & Communicati
7	Anita Sangwan					B Tech	Civil
8	Ankit	20CS92	9812524954	56	9812524954	B Tech	Computer Science & E
9	Ankit					B TEch	Civil
10	Ankit lamba	20EC03	8053223913	3	8053223913	B Tech	Electronics & Communicati
11	Ankit rana	20bca64	8684924923	77	8684924923	BCA	Computer Science & E
12	Antim Kumari	20CS04	8901920612	24	8930082880	B Tech	Computer Science & E
13	Anurag saini	20cs94	7015583866	35	8569809330	B Tech	Computer Science & E
14	Ashwani					BCA	
15	Ayush					BCA	
16	Balram					B TEch	Civil
17	Bharti	20CS09	9053235059	32	9812839542	B Tech	Computer Science & E
18	Bhawana	20CS10	8081641944		7766916818	B Tech	Computer Science & E
19	Bhuwan	20bca31	8607179188		9466021870	BCA	Computer Science & E
20	Chetan	20CS11	8307148798	33	8816992009	B Tech	Computer Science & E
21	Deeksha	20BCA33	8607123011	29	9813964140	BCA	Computer Science & E
22	Deepanshu	20CS12	9518695279	40	9896856346	B Tech	Computer Science & E
23	Deepanshu	20EE03				B Tech	Electical
24	Deepika	20bca20	7206129925	54	7206129925	BCA	Computer Science & E
25	Deepika Luhach					B TEch	Civil
26	Devender Singh	20EC05	9813223036	17	9812062163	B Tech	Electronics & Communicati
27	Devnidhi	20cs14	8295587949	58	8295587949	B Tech	Computer Science & E
28	Dushyant	20cs15	9050124280	57	9416841785	B Tech	Computer Science & E
29	Gaurav Yadav	20CS17	9306356724	10	8178331833	B Tech	Computer Science & E
30	Gopesh					B Tech	CSE
31	Hariom sharma	20bca61	9306971441		7027269051	BCA	Computer Science & E
32	Harish	20CS20	7027726088	54	7027726088	B Tech	Computer Science & E
33	Hemant	20EE04				B Tech	Electical
34	Hitesh	20CS24	8396968166	46	9812068535	B Tech	Computer Science & E
35	Jitender Sharma	20EC07	7015823742	38	9416415221	B Tech	Electronics & Communicati
36	Kajal	20cs26	9817339037	58	9050733923	B Tech	Computer Science & E
37	Kalpana	20CS27	8685084010	49	9991159467	B Tech	Computer Science & E
38	Kapil	20bca12	9518665371	20	9518665371	BCA	Computer Science & E
39	Kapil Sharma	20CS31	7082742272	40	9416457318	B Tech	Computer Science & E
40	Karan Singh	20CS33	7082511938		9812350476	B Tech	Computer Science & E
41	Kunal	20CS35	8307435060	Hostler	9992051168	B Tech	Computer Science & E
42	Madhu	20cs37	9350180155	37	8569973687	B Tech	Computer Science & E
43	Mahak	20CS100	8307417884		9541981100	B Tech	Computer Science & E
44	Mamta	20cs39	8168412439	32	9728779545	B Tech	Computer Science & E
45	Manish	20cs89	9817762919	46	9817762919	B Tech	Computer Science & E
46	Manisha	20CS40	9050930418	27	9671604416	B Tech	Computer Science & E
47	Manisha	20cs41	7027427939	36	7027427939	B Tech	Computer Science & E
48	Mayank	20EE18				B Tech	Electical
49	Minakshi Sharm	20cs93	9588748643	40	9991669392	B Tech	Computer Science & E



50	Monika	20CS46	9817744686	57	9817744686	B Tech	Computer Science & E
51	Muskan	20bca48	9306539405	59	9306539405	BCA	Computer Science & E
52	Nandinee	20CS49	9812725385	58	8930036366	B Tech	Computer Science & E
53	Naveen	20BCA28	8199909740	54	9416574902	BCA	Computer Science & E
54	Naveen Kumar	20BCA11	8950079427		6005204581	BCA	Computer Science & E
55	Navneet	20EE07				B Tech	Electical
56	Neeru	20cs50	9306729229	54	8053773828	B Tech	Computer Science & E
57	Neha	20CS51	8708233260	49	8708233260	B Tech	Computer Science & E
58	Pawan Kumar					B TEch	Civil
59	Pinki	20BCA32	8571883727	35	8571883727	BCA	Computer Science & E
60	Prashant Kumar					B TEch	Civil
61	Pratik					B TEch	Civil
62	Preeti	20CS60	9728934010	49	9991344010	B Tech	Computer Science & E
63	Priyanka	20BCA45	8708669203, 972	26	9416891894	BCA	Computer Science & E
64	Priyanshu	20cs88	9817823683	10	9729851581	B Tech	Computer Science & E
65	Priyawar					BCA	
66	Rahul Barolia	20CS85	8199070585	20	9992014110	B Tech	Computer Science & E
67	Rajni verma	20BCA16	9350951135	30	9813462655	BCA	Computer Science & E
68	Reetik sangwan	20Bca02	9728330769	36	9050866937	BCA	Computer Science & E
69	Renu	20cs65	9817505280	49	9813024606	B Tech	Computer Science & E
70	Rishita	20bca46	9350625968	45	9813750965	BCA	Computer Science & E
71	Ritik Dhillon	20cs67	8595488513	54	7056901945	B Tech	Computer Science & E
72	Rohit kumar	20bca54	7014134310		9660671947	BCA	Computer Science & E
73	Sagar	20EC11	0805 338 1422	15	0805 338 1422	B Tech	Electronics & Communicati
74	Sahil	20CS70	9350543569	43	9466876912	B Tech	Computer Science & E
75	Sahil	20EC12	9306834383	10	9306834383	B Tech	Electronics & Communicati
76	Sanket yadav	20BCA42	9817202268		9817202268	BCA	Computer Science & E
77	Shubham Kumar					B TEch	Civil
78	Sonam	20CS73	8053640948		8053640948	B Tech	Computer Science & E
79	Suman	20BCA03	#####	20	9671549020	BCA	Computer Science & E
80	Sumit kumar	20cs74	8307239919		9518432961	B Tech	Computer Science & E
81	Sunita sheoran	20bca19	9671696458	25	9671696458	BCA	Computer Science & E
82	Sunny yadav	20cs76	8689050787	33	9050789825	B Tech	Computer Science & E
83	Tannu	20BCA08	9817873024	8	9991270245	BCA	Computer Science & E
84	Tushar	20CS78	7206192113	38	7206192113	B Tech	Computer Science & E
85	Tushar Yadav					B TEch	Civil
86	Ujwal	20EC15	7015323995	57	9166567267	B Tech	Electronics & Communicati
87	Vaibhav	20CS91	7404809461	14	9034987500	B Tech	Computer Science & E
88	Yash					B TEch	Civil
89	Yash Raj	20EC13	9466381043		9817469760	B Tech	Electronics & Communicati
90	Yogesh					B TEch	Civil
91	Yogesh					B Tech	CSE
92	Yogesh	20EC14	9671633145	24	8816986390	B Tech	Electronics & Communicati
93	Yogesh kumar	20CS83	8168035161	32	9050921551	B Tech	Computer Science & E
94	Yogesh Pratap S	20cs84	8708174278		9034912379	B Tech	Computer Science & E




 Principal
 R.P.S. College of Engg. & Tech
 Balana Mohindergarh (HR.)

INDUSTRIAL VISIT

TRAINING & PLACEMENT RPS GROUP OF INSTITUTIONS

Dear Sir/Madam

Greetings of The Day.....

RPS Group of Institutions arranging *Industrial Visit to Piloni- Rajasthan* for the students of **1st Year to Final Year (B Tech/ BBA/BCA & MBA)**.

HoDs are requested to ask interested students from above *Year/ Branch* to Register via QR Code or given link. **(latest by 04th June, 2022)**

Following are the instructions for your Information and Compliance:

- All the students have to be in formal attire (*Male: Shirt & Trouser || Female: Salwar Suit or Shirt & Trouser*).
- Boys are supposed to be neat in appearance. (clean shaved)
- You can carry your refreshment (snacks, water, etc.)
- You are not supposed to engage in any unacceptable activity that would hamper the repute of the institute (*like smoking, chewing pan masala etc.*)
- You have to safeguard your own belongings & please avoid bringing any expensive gadget or valuables.
- You have to report to escorting faculty.
- You are not supposed to go anywhere without faculty permission.
- You are expected to be in line with the faculty decision, and behave in a decent manner.



<https://bit.ly/IndusVisit2022>



Feel free to give me a call if you have any query

Thanks & Regards,

Vikas Sharma

Head: Corporate Affairs || Trng. & Placements

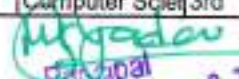
email: placement@rpsinstitutions.org, vikas.raison@gmail.com

+91 8222999151, 8295379956 (Whatsapp) (1285) 241431

Website: www.rpsinstitutions.org

Principal
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Balana Mohindergam (HR.)

Sl. No.	Name	Class Roll No.	Mobile no. (Personal)	If Using College Bus, Write Bus No.	Mobile no. (Parents)	Course	Branch	Current Year
1	Ajay sharma	21mba15	9079483635	56	9116303739	MBA	Management	1st
2	Akshay	19CS02	9728775375	42	9255321491	B Tech	Computer Scier	3rd
3	Aman	21 MBA12	8708568525	54	9518164028	MBA	Management	1st
4	Amit	21MBA26	9817177961	47	72066679610	MBA	Management	1st
5	Anil	19BBA02	9896029969	8	9416288423	BBA	Management	3rd
6	Ankit yadav	19BCA02*	9813382336	24	9466021201	BCA	Computer Scier	3rd
7	Ankita	19EC02	9350165334	58	8708756814	B Tech	Electronics & C	3rd
8	Ankita	20MBA06	8571838597	39	8571838597	MBA	Management	2nd
9	Ankita	21BBA30	8401579186	32	8708496787	BBA	Management	1st
10	Annu yadav	19BBA03	9416622531	13	8570993531	BBA	Management	3rd
11	Anubhav Aggerwal	19CS04	8295454711	27	8295454711	B Tech	Computer Scier	3rd
12	Archi gupta	19cs05	9991073587	52	9728025480	B Tech	Computer Scier	3rd
13	Arju	21MBA35	9518684759	4	8930320824	MBA	Management	1st
14	Arjun	19bca04	8396868853	11	8958566347	BCA	Computer Scier	3rd
15	Arti	19BBA05	8570946222	23	9416574066	BBA	Management	3rd
16	Arvind	20MBA33	8813853189	44	8813853189	MBA	Management	2nd
17	Avinash rai	19cs09	9351641768	22	9351641768	B Tech	Computer Scier	3rd
18	Babli	19bca05	8053262058	77	8053262096	BCA	Computer Scier	3rd
19	Bijender	19EC03	8750666109	77	8750666109	B Tech	Electronics & C	3rd
20	Deepak	21BBA25	9992844763	50	9992844763	BBA	Management	1st
21	Devender Singh	21MBA27	8901354885	10	9466345419	MBA	Management	1st
22	Diksha yadav	19bca08	9350176757	11	8059217050	BCA	Computer Scier	3rd
23	Dipen	19BCA44	8395916677	56	9416366254	BCA	Computer Scier	3rd
24	Dishu Goyal	19BBA07	7988303609	23	9466038687	BBA	Management	3rd
25	Gunjan	19EC05	8607018922	50	9466580361	B Tech	Electronics & C	3rd
26	Himalaya	20mba10	8816051463	41	8816051463	MBA	Management	2nd
27	Himanshu	19BCA11	7082834509	24	7082834509	BCA	Computer Scier	3rd
28	Himanshu	21MBA04	8708968668	10	9416909751	MBA	Management	1st
29	Himanshu Gurjar	19BCA47	8295075773	36	8295075773	BCA	Computer Scier	3rd
30	Isha	19bba11	8295817316	24	9996314616	BBA	Management	3rd
31	Ishika Yadav	19BBA12	9.19051E+11	26	9.19468E+11	BBA	Management	3rd
32	Jyoti	20MBA12	9306815476	45	8053014437	MBA	Management	2nd
33	Kanchan	19bba13	8930440502	27	9896243328	BBA	Management	3rd
34	Kapil	19CS15	893072990	59	9468288538	B Tech	Computer Scier	3rd
35	KESHAV	21bba35	8397857968		9671627768	BBA	Management	1st
36	Komal	19BCA14	9417725126		9817625426	BCA	Computer Scier	3rd
37	Kumari Mikkey	21Bba26	8708884660		9416909751	BBA	Management	1st
38	Kunal Yadav	19BCA15	7082571426		7082571426	BCA	Computer Scier	3rd
39	Lalit Yadav	19BBA15	8569952862	39	9466295445	BBA	Management	3rd
40	MANAN SINGHAL	19bba16	9817606366	55	9416751551	BBA	Management	3rd
41	Mandeep	19BCA16	9050797686	31	9050797686	BCA	Computer Scier	3rd
42	Manish	19CS18	8307239712		7011842010	B Tech	Computer Scier	3rd
43	Manish Jangra	19CS19	9306560741	52	9817887630	B Tech	Computer Scier	3rd
44	Manjeet	21BBA17	9996631796	39	9671663674	BBA	Management	1st
45	Manju	19bca17	9350164879	32	9991634585	BCA	Computer Scier	3rd
46	Manju	19bba17	7015267049	40	8264161147	BBA	Management	3rd
47	Mohit	19 Bca 19	9306217108		9416990394	BCA	Computer Scier	3rd
48	Mohit	19EC08	8571847520	31	8950579022	B Tech	Electronics & C	3rd
49	Mohit	20MBA13	9.1806E+11		9.1806E+11	MBA	Management	2nd
50	Mohit kumar yadav	21MBA37	8058006753	33	8058006753	MBA	Management	1st
51	Mohit Yadav	19CS22	8094307557	6	9024689726	B Tech	Computer Scier	3rd


 Annu Yadav
 Principal
 R.P.S. College of Engg. & Tech
 Balana Mohindergarh (HR.)

52	Muskan	21BBA19	8307049084	24	9306108296	BBA	Management	1st
53	Muskan Rani	20MBA20	7419206599	49	7419206599	MBA	Management	2nd
54	Neeraj Yadav	19cs23	9306869630	43	8168053442	B Tech	Computer Scier	3rd
55	Neetu	21BBA14	7015161483	29	9812243124	BBA	Management	1st
56	Neha	21MBA31	7976261776	51	8814849835	MBA	Management	1st
57	Nidhi	19CS24	8816881299	13	9466009345	B Tech	Computer Scier	3rd
58	Nikhil Yadav	19EC09	9588758007	3	9466930262	B Tech	Electronics & C	3rd
59	Nisha Rao	21MBA28	7988205515	13	7027281420	MBA	Management	1st
60	NITIN KUMAR	19BBA20	7419217271	36	9818771408	BBA	Management	3rd
61	Nitin Kumar Yadav	20MBA39	9555155625		7494855625	MBA	Management	2nd
62	Paramjeet	21mba29	9896093735	40	8398093054	MBA	Management	1st
63	PARMOD	19EC10	9485637178		9671012451	B Tech	Electronics & C	3rd
64	Parul	20MBA30	9813875861		8814818443	MBA	Management	2nd
65	Parul Yadav	20MBA27	9671815276		7056815376	MBA	Management	4th
66	Payal Rao	19BCA24	9518470128	4	9416426670	BCA	Computer Scier	3rd
67	piyush	19cs27	9.19306E+11	10	9.19306E+11	B Tech	Computer Scier	3rd
68	Pooja	20 MBA 11	8930182554	45	7027518706	MBA	Management	2nd
69	Pooja	21bba01	7534036008	58	9410361040	BBA	Management	1st
70	Priya yadav	21bba22	9671256995	27	8396965311	BBA	Management	1st
71	Priyanka	21MBA11	9050570434	35	9996045652	MBA	Management	1st
72	Radhika	19cs32	8307653180	54	9416496403	B Tech	Computer Scier	3rd
73	raahul kumar	L20EE18	8813968733	46	8813968733	B Tech	Electrical Engin	3rd
74	Rahul Poonia	19BCA29	9802776440	45	9812686440	BCA	Computer Scier	3rd
75	Raja	20MBA23	7988376347		9466884664	MBA	Management	2nd
76	Rajkumar	19BCA31	9818533660		9818533660	BCA	Computer Scier	3rd
77	Rekha aggarwal	21 MBA 24	7298104977	56	7298104977	MBA	Management	1st
78	Renu	19cs37	9350286917	57	8930996551	B Tech	Computer Scier	3rd
79	Rinkee	19cs38	7015830447	16	7015830447	B Tech	Computer Scier	3rd
80	Ritu	19BCA45	9306308848	59	9817543950	BCA	Computer Scier	3rd
81	Rohit	19BCA33	9050095192	32	9671373274	BCA	Computer Scier	3rd
82	Rohit sharma	19cs40	7827254472		8860889824	B Tech	Computer Scier	3rd
83	Sachin	19bca 43	9518663105		9587133169	BCA	Computer Scier	3rd
84	Sahil	19bba26	8168815070	57	9416267831	BBA	Management	3rd
85	Sahil Saini	19BBA27	9050658174		9050658174	BBA	Management	3rd
86	Sapna	19bba30	9050848369	53	9813346501	BBA	Management	3rd
87	SAURABH	19BCA36	9588589376	46	9991507719	BCA	Computer Scier	3rd
88	Savin kumar	20 MBA 07	8683050272		8683050272	MBA	Management	2nd
89	Sheetal	19BCA37	8295014992	31	9813821992	BCA	Computer Scier	3rd
90	Simran goyal	20MBA01	981718435	23	9416314670	MBA	Management	2nd
91	Sumit kumar	19BCA46	9728320224	16	9728320224	BCA	Computer Scier	3rd
92	SUNIL	21bba34	8397957968		8397957968	BBA	Management	1st
93	Swati	19CS48	8307367686	22	8307367686	B Tech	Computer Scier	3rd
94	Tannu	21mba14	9813766315	45	9813766315	MBA	Management	2nd
95	Usha	21mba30	7082380688	58	7082380688	MBA	Management	1st
96	Vanshika	21MBA01	9996753821	6	9896376021	MBA	Management	1st
97	Vinay kumar	19EE12	8685825896	24	8685825896	B Tech	Electrical Engin	3rd
98	Vishal	20MBA09	8571875484	33	9050578890	MBA	Management	2nd
99	Yavnish Yadav	19CS59	9350185077	39	92126567777	B Tech	Computer Scier	3rd
100	Yogender kumar	21mba20	8813031001	17	8813031001	MBA	Management	1st

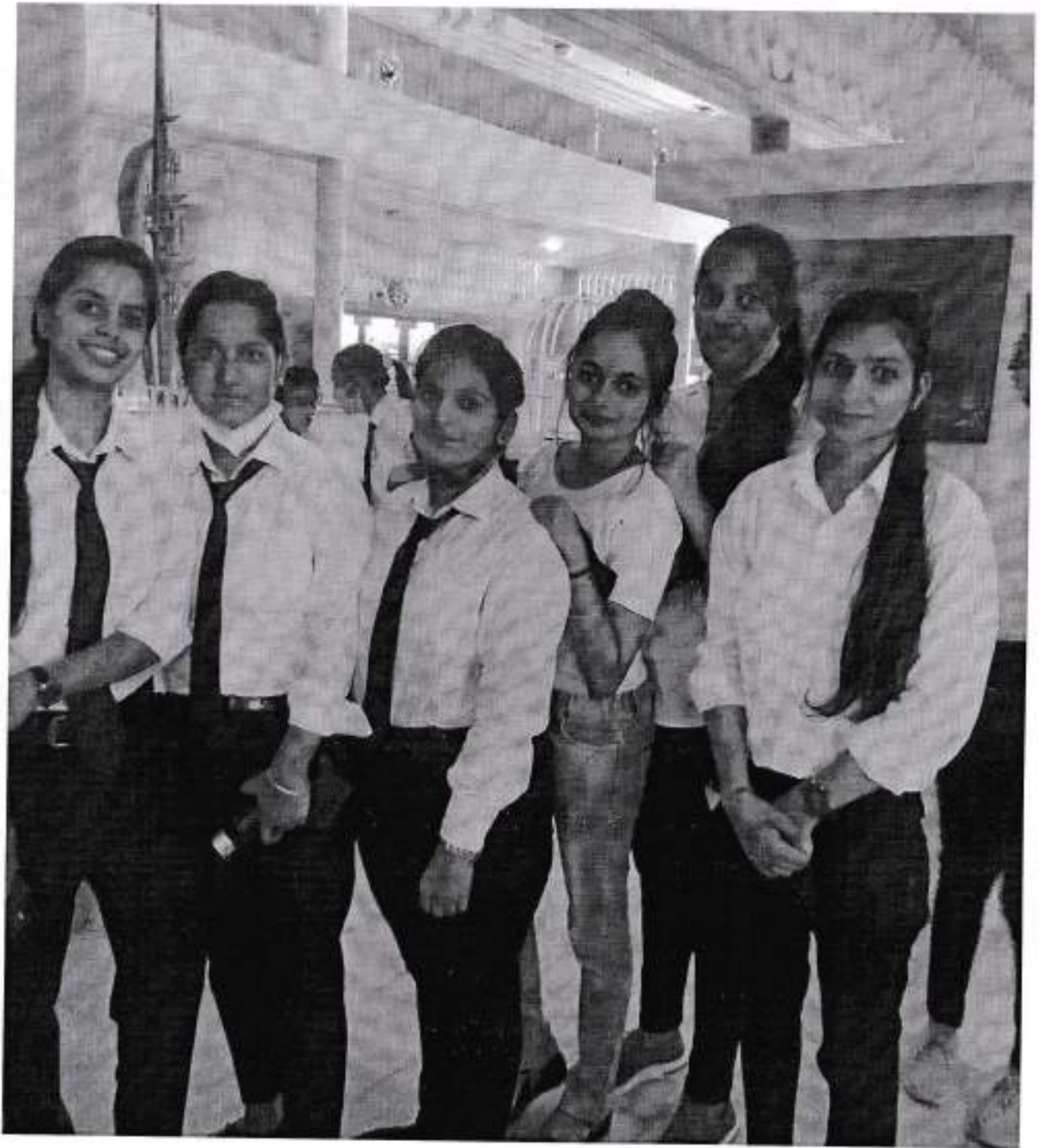

 Principal
 R.P.S. College of Engg. & Tech
 Balana Mohindergam (HR.)



Wijesekera
Principal
R.P.S. College of Engg. & Tech
Batana Mohindergarh (HR.)



Principal
R.P.S. College of Engg. & Tech
Batana Mohindergarh (HR.)



M. P. Singh
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



R.P.S.
Principal
R.P.S. College of Engg. & Tech
Bilaspur (M.P.)



R.P.S.
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

RPS Group of Institutions

Satnali Road, Balana, Mohindergarh, Haryana- 123029

INDUSTRIAL VISIT REPORT

Name of Faculty Member: Vikas Sharma, TPO Designation: TPO / Asst. Prof
Dr. Yogita Yadav
Name of Company/ Institute visited: Nucleus Software, Noida
Person whom meet: Ms. Vaani Pandya No. of Students: 42
Branch: B.Tech CSE 2nd/3rd Date of Visit: 13/Apr/18

Report: We started our journey at 9:30 AM from college campus along with 42 students. Students were from B.Tech CSE 2nd & 3rd yr. Ms. Yogita Yadav escorted us with me.

As per given slot we reached at Nucleus Software at 2:30 PM. We were (it bit late to Jam at Kuria and in Gurgaon.

Students took lunch before starting program. first video was shown to students so they get brief knowledge about company work. After that presentation was given by Rep. that some activities were done by students. We left company at 5:30 PM and reached to campus at 1:30 AM.



Yogita Yadav
Principal
RPS College of Engg. & Tech.
Balana, Mohindergarh (Haryana)

RPS Group of Institutions

Satnali Road, Balana, Mohindergarh, Haryana- 123029

INDUSTRIAL VISIT REPORT

Name of Faculty Member: Vikas Sharma / Khushboo Yadav Designation: TPO / Asst. Prof.

Name of Company/ Institute visited: Network Bulls, Gurgaon

Person whom meet: Amali Gini No. of Students: 36

Branch: B.Tech ECE/EE/CSE Date of Visit: 23/Feb/2018

Report: We started our journey at 9.30 AM from RPS Gol, Balana Campus with 25 students from B.Tech ECE/EE/CSE pre final year.

We reached Network Bulls at 12.30 PM via Rewari, Kanina route. On the way rest 10 students join us from Rewari, Kanina, and Gurgaon.

After reached their Theory Session was started at 1.15 PM. The duration of theory Session was 45 min. After that Company representative took all the students for visit of premises and then we had lunch there.

The session (theory) was covered by Mr Gupta Sir. After all process we had a Group Photo Session. At 4.30 PM we left Gurgaon for Campus. On the way we dropped students after consultation of their parents. Six girls reached with me at Campus.

According to me & as per students, the session was interesting & helpful to enhance ✓



Amali Gini
Principal

RPS College of Engg. & Tech
Balana, Mohindergarh, Haryana

Interested students list for Industrial Visit to Gurugram on Friday (23.02.2018)

ECE 3RD YR

Sr No.	College Roll No	Name of student	Father's Name	Signature
1	15EC02	ANKIT ✓	GIAN SINGH	
2	15EC03	ANSHU ✓	ANIL KUMAR - ^{ggr} _{Munro college}	Anshu
3	15EC07	KRISHAN ✓	LAXMINARAYAN	
4	15EC08	LOVE KUMAR ✓	KLUNDAN LAL	Love Kumar
5	15EC11	NITESH	RAGHUBIR SINGH	Nitesh
6	15EC12	OMBIR ✓	CHANDER BHAN	
7	15EC13	PRIYANKA	ISHWAR SINGH	from Ugm itself
8	15EC14	RAJU BASUMATARY	BINAY KUMAR BASUMATARY	Raju
9	15EC16	RAVINDER SHEKHAWAT	RAJVEER SINGH	
10	15EC18	SANGEETA YADAV ✓	SATISH KUMAR YADAV ^{School} _{Conduct}	Sangeeta Yadav
11	15EC19	SHUBHAM BHARDWAJ	MUKESH KUMAR	Shubham
12	15EC21	VIPIN BUNDWAL ✓	BABU LAL BUNDWAL	Vipin

EE 3RD YR

1	15EE08	MITHILESH KUMAR	BIGU SHARMA	
2	15EE09	OMESH YADAV	SHAMSHER SINGH YADAV	Omesh
3	15EE12	RAVI KUMAR ✓	GAJENDER	Ravi
4	15EE14	SAGAR YADAV ✓	MANENDER SINGH	Sagar
5	15EE16	SUMIT	MAHESH	
6	L16EE18	HIMANSHU MEHRA ✓	KISHAN LAL	HIMANSHU
7	L16EE19	KULDEEP ✓	SURAJEHAN	KULDEEP
8	L16EE20	MAHESH	MAHESH KUMAR	Mahesh

08 present



14
19
7
40

A. Yadav
Principal
RPS College of Engg. & Tech.
Balana Mohindergarh (HR.)

20 → P
16 → P

Bharti

S. No.	College Roll No.	Name of student	Parent's Contact number	Interested / Not
	15CS01	AARTI	9466274617	Yes, 9991610311
	15CS02	AJAY MULODHIA		
	15CS06	ANKIT KUMAR	9992996542	Yes, 9992996542
	15CS11	DEEPAK KUMAR	8813096817	Yes, 9992506817
	15CS13	DIMPLE CHAUHAN	7056015840	Yes, 7056015840
	15CS15	GEETA YADAV	9416242448	Yes, 999200542
	15CS16	HARSHIT HARIT	7988665726	Yes, 7988665726
	15CS17	HEMLATA	9467638303	Yes, 9467638303
	15CS19	HITESH KUMAR		
	15CS20	INDU KUMARI	89416903849	Yes, 89416903849
	15CS21	JAIVEER SINGH	9992506817	Yes, 9518295397
	15CS22	JAYANT	9466918402	Yes, 7056012180
	15CS23	JYOTI YADAV	8395917062	Yes, 8395917062
	15CS25	KAPIL KUMAR YADAV		
	15CS30	MADHU		
	15CS32	MONA	999240751	Yes, 805744735
	15CS33	MONIKA		
	15CS34	MONIKA		
	15CS36	NEHA SINGHLA	981275522	Yes, 9671617788
	15CS40	PRAGATI		
	15CS41	PRAMUJ Kt KALIYA		
	15CS42	PRIYANKA	94164218	Yes, 9729382839
	15CS43	RAHUL VASHISTH		
	15CS44	REETU SHARMA		Yes, 8684837037
	15CS46	SANDEEP		
	15CS47	SANDEEP		
	15CS48	SHIKHAR MAHERSHI	9087850850	Yes, 9087850850
	15CS49	SHUBHAM MUDGIL	941678133	Yes, 9671788133
	15CS50	SUDESH YADAV		
	15CS51	SUNITA	9992732614	Yes, 8607123976
	15CS52	SUSHMA KUMARI		
	15CS54	TARUN	9991708053	Yes
	L16CS58	SHIKHA SHARMA		
	15CS57	VIKAS YADAV		



M. P. Yadav
Principal

RPS College of Engg. & Tech.
Balana Mohindergarh (HR.)



Industrial Visit – Feedback form

Date: _____

PART A: Participants Information:

Roll No: 156530 Participant Name: Madhu
Department: CSE Company Visited: Networks bulls
Name of the concern person: Mr. Baljit

PART B: FEEDBACK

Please rate the following on a scale of 1 – 5, with 1 being the lowest rating and 5 the highest.

	1	2	3	4	5
Was the visit relevant?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
Was the subject covered adequately?	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
Were you satisfied with the visit?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
Was the speaker enthusiastic and interested?	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
Overall rating for the program:	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>

Any other suggestions and comments:

No comments



*** THANK YOU ***



Industrial Visit – Feedback form

Date: _____

PART A: Participants Information:

Roll No: 156520 Participant Name: Indu yadav
Department: CSE Company Visited: Network bulls
Name of the concern person: Mr. Baljit

PART B: FEEDBACK

Please rate the following on a scale of 1 – 5, with 1 being the lowest rating and 5 the highest.

	1	2	3	4	5
Was the visit relevant?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
Was the subject covered adequately?	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
Were you satisfied with the visit?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
Was the speaker enthusiastic and interested?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
Overall rating for the program:	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>

Any other suggestions and comments:

*** THANK YOU ***

Indu yadav
Principal

R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)



Industrial Visit - Feedback form

Date: 23-9-18

PART A: Participants Information:

Roll No: Vipin Bundwal Participant Name: Vipin Bundwal
(ISEC22)
Department: E.C.E Company Visited: Network - Boll

Name of the concern person: _____

PART B: FEEDBACK

Please rate the following on a scale of 1 - 5, with 1 being the lowest rating and 5 the highest.

	1	2	3	4	5
Was the visit relevant?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
Was the subject covered adequately?	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
Were you satisfied with the visit?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
Was the speaker enthusiastic and interested?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
Overall rating for the program:	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>

Any other suggestions and comments:

Satisfied

*** THANK YOU ***



Industrial Visit - Feedback form

Date: 24/02/2018

PART A: Participants Information:

Roll No: 13EE12 Participant Name: Ravi Kumar
Department: Electrical Company Visited: Network Boll

Name of the concern person: _____

PART B: FEEDBACK

Please rate the following on a scale of 1 - 5, with 1 being the lowest rating and 5 the highest.

	1	2	3	4	5
Was the visit relevant?	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
Was the subject covered adequately?	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
Were you satisfied with the visit?	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
Was the speaker enthusiastic and interested?	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
Overall rating for the program:	<input checked="" type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>

Any other suggestions and comments:

Very Bad, Boring, Unhelpful

*** THANK YOU ***

M. S. Yadav
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

RPS Group of Institutions

Satnali Road, Balana, Mohindergarh, Haryana- 123029

INDUSTRIAL VISIT REPORT

Name of Faculty Member: Vikas Sharma TPO Designation: TPO
Name of Company/ Institute visited: HCL-TSS Meerut
Person whom meet: Mr. Rahul Masin & Harsh No. of Students: 41 (3rd & 4th yrs) CSE
Branch: Computer Science Date of Visit: 30th Sep-16

Report: I started journey from RPSG01 campus at 8.30 AM with 10 students. At H. Gash we pick 05 students, then at Kanina & Dahim, Rewari rest of students joined us.

We reached at venue at 10.30 AM as per time allotted to us by the company.

One of my colleague Mr. S.S. Yadav accompanied me from H. Gash & another faculty member Mr. Sheela from Rewari.

Session started at 11.15 AM. According to me & my colleagues overall program was beneficial for students.

We left venue (HCLTSS) at 4 PM &

Reached back RPSG01 at 7.30 PM with 08 students.

We drop Rest of students at their native place stands.

Vikas
17/10/16

Students feedback also attached
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

16

NOMINATIONS: INDUSTRIAL VISIT

Event Date: 30th Sep,2016 (tentative)

Session : 2016-2017 - Total Strength - 29

Class : B.TECH(CSE)-FORTH (Strength - 29)

Sno	Adm. No	Student Name	Father Name	Signature
1	L14CS47	KAPIL VERMA	RISHIPAL	[Signature]
2	L14CS48	SUSHILA BAI	KANWAR SINGH	[Signature]
3	H4CS49	POOJA RANI	RAMESH KUMAR	Sushila Bai
4	13CS24	POONAM	SUNIL YADAV	Poojanani
5	13CS19	NEHA RANGA	KAUSHAL KUMAR	Poonam
6	13CS38	VIKRAM	ANIL KUMAR	[Signature]
7	13CS18	NEHA PERWEEN	SHABIR AHMAD	Neha Perween
8	13CS36	SUSHILA	BALBIR SINGH	Sushila
9	13CS02	AMAN YADAV	VIJAY YADAV	
10	13CS13	MAMTA	ANANTRAM	
11	13CS05	ARUN KUMAR PUNIA	SHISHU PAL SINGH	Mamta
12	13CS06	ASHISH	PAWAN KUMAR	Ashish
13	13CS07	BHARTI KUMARI	SATBIR SINGH	Bharti
14	13CS08	DEEPAK	JAGDISH	
15	13CS10	JYOTI YADAV	PARWESH KUMAR	
16	13CS16	MEENA KUMARI	MAHESH KUMAR	
17	13CS21	PANKAJ KUMAR	AJAY PAL SINGH	Pankaj Kumar
18	13CS22	PARVESH	ANIL KUMAR	
19	13CS35	SEEMA KUMARI	RAJESH SINGH	
20	13CS11	KAVITA	ISHAN SINGH	Kavita
21	13CS14	MANISHA	RAJARAM	
22	13CS09	HEENA KUMARI	RAJAN SHERMA	Manisha
23	13CS12	KAVITA YADAV	SANTU SINGH	Heena
24	13CS25	POONAM	RAM BHAGAT	Kavita
25	13CS30	RAVINA	RAJ PAL	Poonam
26	13CS41	HARSHITA	VIJAY KUMAR	Ravina
27	13CS42	SHYAMSUNDER SONI	ANAND SONI	Harshita
28	13CS31	REKHA	VED PRAKASH	
29	13CS23	PINKI	HARI PRASAD	Pinki

Kewari

Hostel

M-gash

Kewari

Dahina

Hostel

Hostel

College



RPS College of Engg. & Tech
Balana Mohindergarh (HR.)

23+2

NOMINATIONS: INDUSTRIAL VISIT

G.T. 41+4 = 45 (Incl. Drives)

Event Date: 30th Sep, 2016

Session : 2016-2017 - Total Strength - 49

S.No	Adm. No	Student Name	Father Name	Signature
1	14CS01	ANISH KUMAR	PAWAN KUMAR	Anish Kumar
2	14CS02	ABHISHEK	NARESH KUMAR	Abhishek M. Gosh
3	14CS04	ASHISH	VIRENDER	Ashish M. Gosh
4	14CS05	CHANDER KANT	PRITAM SINGH	Chander Kant
5	14CS06	DARWIN	NAND RAM	Darwin
6	14CS07	DEEPESH YADAV	SATINDER KUMAR	Deepesh Yadav Hospital
7	14CS08	GOPAL	VIJAY KUMAR	Gopal
8	14CS09	HIMANSHU AGGARWAL	ANIL AGGARWAL	Himanshu
9	14CS10	JATIN SHARMA	PRAMOD KUMAR	Jatin Sharma - Kamina
10	14CS11	KAJAL	RAMESH KUMAR	Kajal - Clg
11	14CS12	KAPIL	RAMPHAL	Kapil
12	14CS13	KAVITA	OM PRAKASH	Kavita - Clg
13	14CS14	KAVITA	BAHADUR SINGH	Kavita - Clg
14	14CS15	MAMTA RANI	SUBHASH CHAND	Mamta Rani - Clg
15	14CS16	MANDEEP	RAMESH KUMAR	Mandeep
16	14CS17	MANINDER	DHARAMVIR	Maninder
17	14CS18	NAVEEN VED	SUNIL KUMAR VED	Naveen Ved
18	14CS19	NAYAN MISHRA	SANJEEV MISHRA	Nayan Mishra
19	14CS20	NEERAJ YADAV	NITYANAND	Neeraj Yadav
20	14CS21	NITIN SAINI	YADRAM SAINI	Nitin Saini - Kamina
21	14CS22	PARMILA KUMARI	SURAJBHAN SINGH	Parmila - X
22	14CS23	PAWAN PARKASH	DAYANAND	Pawan Parkash - X
23	14CS24	PINKI KUMARI	NAUBHAR	Pinki - X
24	14CS25	PRADEEP SINGH	MADAN SINGH	Pradeep Singh - X
25	14CS26	PRESHIKA GOEL	KAMLESH GOEL	Preshika - X
26	14CS27	PRIYANKA	SURENDER SINGH	Priyanka - X
27	14CS28	RAHUL	SURENDER SINGH	Rahul - X
28	14CS29	RAVINA	SURENDER SINGH	Ravina - X
29	14CS30	RENU	SURENDER SINGH	Renu - X
30	14CS31	ROHAN	PRMOD	Rohan M. Gosh - X
31	14CS32	SAHIL KAUSHIK	SAHIL KUMAR	Sahil Kaushik - X
32	14CS33	SALONI BALA	RAJ KUMAR	Saloni Bala - Kamina
33	14CS34	SANDEEP SHEKHAWA	SANJAI KUMAR	Sandeep Shekhawa - Kamina
34	14CS35	SANJEET	SURENDER	Sanjeet - Kamina
35	14CS37	SANNI	BRAHAM PRAKASH	Sanni - Kamina
36	14CS38	SHAILESH KUMAR	PALA RAM	Shailesh Kumar - Kamina
37	14CS40	SHIV CHARAN	OMPAL SINGH	Shiv Charan - X
38	14CS41	SOMBIR	KRISHAN KUMAR	Sombir - Kamina
39	14CS42	SORURABH MECHOO	JAI SINGH MECHOO	Sourabh Mechoo



Tulsi

Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

40	14CS43	SUNIL KUMAR	DHARMBIR	
41	14CS44	SURESH KUMAR	VIKRAM SINGH	
42	14CS45	UMESH SHARMA <i>Raneri</i>	CHEET RAM SHARMA	<i>Suresh DITINA</i>
43	14CS46	VARSHA	MADAN LAL	<i>Umesh REWARI</i>
44	14CS48	VIVEK GOYAL	SANJAY GOYAL	<i>Varsha Buss</i>
45	14CS49	WAGISH YADAV	HARPAL SINGH	<i>Vivek</i>
46	14CS50	YOGENDER	PREM SINGH	
47	14CS51	SHIV KUMAR	RATIPAL	<i>Yogender KAVINE</i>
48	14CS52	DEEPAK YADAV	DHIRENDER KUMAR	<i>Shivkumar</i>
49	15CS53	MANJU KUMARI	ISHWAR SINGH	



M. S. Garg
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



RPS

GROUP OF INSTITUTIONS

(ISO 9001:2008 CERTIFIED INSTITUTIONS)

Industrial Visit - Feedback form

Date: 30-09-2016

PART A: Participants Information:

Roll No: 13CS29

Participant Name: Pooja m

Department: CSE

Company Visited: HCL TSS Mohindgarh

Name of the concern person: Harsh, Mauph

PART B: FEEDBACK

Please rate the following on a scale of 1-5, with 1 being the lowest rating and 5 the highest.

	1	2	3	4	5
Was the visit relevant?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
Was the subject covered adequately?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
Were you satisfied with the visit?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
Was the speaker enthusiastic and interested?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
Overall rating for the program:	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>

Any other suggestions and comments:

Excellent visit

*** THANK YOU ***


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



RPS

GROUP OF INSTITUTIONS

(ISO 9001:2008 CERTIFIED INSTITUTIONS)

Industrial Visit – Feedback form

Date: 01/10/2016

PART A: Participants Information:

Roll No: 13CC08

Participant Name: Arun Kumar Purohit

Department: C.S.E

Company Visited: HCT-TSS

Name of the concern person: Mosien, Harsh

PART B: FEEDBACK

Please rate the following on a scale of 1 – 5, with 1 being the lowest rating and 5 the highest.

	1	2	3	4	5
Was the visit relevant?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
Was the subject covered adequately?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
Were you satisfied with the visit?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
Was the speaker enthusiastic and interested?	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
Overall rating for the program:	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>

Any other suggestions and comments:

*** THANK YOU ***



Miyadan
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (Haryana)

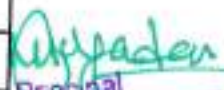


K. Jyotsna
Principal
R.P.S. College of Engg. & Tech
Balana, Mohindergam (HR.)

List of Students for Industrial Visit: Ducat India- Sec 63, Noida (08- April, 2022)

Sl. No.	Name	Class RollNo.	Course	Branch	Year of Passing	Mobile no. (Personal)	Mobile no. (Parents)	BusNo.
1	Ajay	20CS01	B Tech	CSE	2024	9053243822	9896370564	40
2	Ankit	20cs92	B Tech	CSE	2024	9812524954	8003970400	56
3	Ashish	20CS07	B Tech	CSE	2024	9416385978	9813185978	51
4	Atul	19cs07	B Tech	CSE	2023	9350632155	8930757155	14
5	Bharti	20CS09	B Tech	CSE	2024	9053235059	9812839542	32
6	Bhawana singh	20CS10	B Tech	CSE	2024	8081641944	7766916818	Hostel
7	Deepanshu	20CS12	B Tech	CSE	2024	7404540273	9896856346	40
8	Devnidhi	20cs14	B Tech	CSE	2024	8295587949	9671295229	55
9	Gaurav Yadav	20CS17	B Tech	CSE	2024	9306356724	8178331833	10
10	Gopesh	20cs18	B Tech	CSE	2024	7988521899	9416752951	39
11	Gyanchand Sharma	20cs19	B Tech	CSE	2024	9350308094	9466274596	13
12	HIMANSHU	20CS22	B Tech	CSE	2024	8307701090	9071713301	40
13	Hitesh	20CS24	B Tech	CSE	2024	8396968166	9812068535	46
14	Kajal	20cs26	B Tech	CSE	2024	9817339037	9050733923	58
15	Kalpana	20CS27	B Tech	CSE	2024	8685084010	9991159467	49
16	Kapil	19CS17	B Tech	CSE	2023	7015722372	9466779753	53
17	Kapil Kumar	20CS30	B Tech	CSE	2024	8059136207	9996931880	1
18	Karan Singh	20CS33	B Tech	CSE	2024	7082511938	9812350476	51
19	Madhu	20cs37	B Tech	CSE	2024	9350180155	9929985540, 8569900000	37
20	Mahak	20cs100	B Tech	CSE	2024	8307417884	9541981100	27
21	Manish	20cs89	B Tech	CSE	2024	9817762919	9671891679	57
22	Manisha	20cs41	B Tech	CSE	2024	7027427939	8053081201	36
23	Manisha	20CS40	B Tech	CSE	2024	9050930418	9671604416	27
24	Mehul	20CS43	B Tech	CSE	2024	9996894552	9416603172	51
25	Nandinee Sharma	20CS49	B Tech	CSE	2024	9812725385	8930036366	58
26	Neeru	20cs 50	B Tech	CSE	2024	9306729229	8307063320	54
27	Nitesh Goyal	20CS90	B Tech	CSE	2024	8930422238	7206502238	41
28	PANKAJ	20CS54	B Tech	CSE	2024	9354512148	9050721065	26
29	Pankaj	20cs53	B Tech	CSE	2024	9050209862	7015783381	26
30	Pankaj	20CS55	B Tech	CSE	2024	8708035580	8607345808	22




 Anshu Yadav
 Principal
 R.P.S. College of Engg. & Tech.
 Balana Mohindergarh (HR.)

31	Pankaj	20cs56	B Tech	CSE	2024	7206688 610	9466315 610	11
32	Parveen Kumar	20CS58	B Tech	CSE	2024	9728174 184	9817728 960	
33	Preeti	20CS60	B Tech	CSE	2024	9728934 010	9991344 010	49
34	Prince	19cs30	B Tech	CSE	2023	8059258 639	9812976 669	51
35	Priyanshu	20cs88	B Tech	CSE	2024	9817823 683	9729851 581	10
36	Ravi	19cs35	B Tech	CSE	2023	9996704 656	8708195 389	15
37	Renu	20cs65	B Tech	CSE	2024	9817505 280	9813024 606	49
38	Ritesh Yadav	20cs66	B Tech	CSE	2024	7988823 544	6005266 320	13
39	Ritik Dhillon	20es67	B Tech	CSE	2024	7056901 945	8595488 513	54
40	Sahil Rao	20CS70	B Tech	CSE	2024	9350543 569	9466876 912	43
41	Sonam	20cs73	B Tech	CSE	2024	8307417 884	8053640 948	58
42	Sunny	20CS76	B Tech	CSE	2024	8689050 787	9050789 825	33
43	TUSHAR	20CS78	B Tech	CSE	2024	7206192 113	9050009 603	38
44	Vaibhav Kaushik	29CS79	B Tech	CSE	2024	7206572 023	9466397 407	12

Faculty Details: 1. Mr Vatan Sehrawat: +91
8059211113

2. Ms. Reetu: +91 8950960659



V. Vatan
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



3.3.1 Extension activities are carried out in the neighborhood community, sensitizing students to social issues, for their holistic development, and impact thereof during the last five years:

Response:


R P S College of Engineering and Technology organizes various extension activities throughout the year in its campus and the neighborhood area as well. Since the institute is located in a rural and economically backward area, the extension of education and local development is one of the missions of the institute.

Adoption of Village: The institute is committed for rural development. Marching ahead on this mission, the institute adopted a nearby village *Dhaadot*. Various social service activities are carried out in this village by the institute. As a part of *Swachh Bharat Abhiyan*, the student volunteers actively participated in the cleanliness activities in the village. The students make the villagers aware towards personal hygiene. The students run campaign for making the residents aware for participate in voting in the elections. The institute offers special scholarship to the economically backward and other needy students of this village.

Establishment of Covid Care Center in the institute hostel: The institute left no stone unturned for helping the nation against the fight with Covid-19. The institute offered its hostel for making Covid care centre during the horrific pandemic. The institute also donated in the PM corona relief fund in addition to offering food and medicine and other supporting essentials to the Covid-patients. The local administration and the government thanked and appreciated the institute management for this noble cause by sending a special appreciation letter.

Installation of Pedal-sanitizer machine at Public Places: The institute installed Pedal-sanitizer machines at designated public places. These sanitizers were designed and made in the institute by the students only under the supervision of institute's project coordinator Mr. Pankaj Soni.

Donation of Ambulance for Covid-patients: The institute donated two ambulances to the Civil Hospital Kanina, and Civil Hospital Ateli Mahendergarh, for Covid-patients.


Principal
R.P.S. College of Engg. & Tech
Balana, Mohindergarh (H.R.)

Donation of Medi-robo at Covid Care Center: The institute also donated a Medi-robo (Medicine carrier Robot) at the Covid Care Center made in the village Patikara, Narnaul by the government.

Corona Testing and Vaccination Camp: The institute organized Corona testing and vaccination camps for its students, staff and the residents of nearby villages.

Extension of E-library services for Yadav Sabha: In order to help the students, who are preparing for the competitive examinations, the institute established fully automation facilitated E-library in the premises of Yadav Sabha (Dharamshala) Mahendergarh. This library is equipped with latest personal computers and E-classroom. All the expenses of the establishment of this library are borne by the institute. The librarian of the institute Mr. Rajesh Kumar provided (and providing) his consultancy services to the library free of cost whenever required.

Celebration of Important Days: The institute organizes various important days like World Environment Day, International Yoga Day, Women's Day, National Technology Day, etc.

Blood Donation Camps: The institute also organized blood donation camps from time to time where the students of the institute contributed openheartedly.

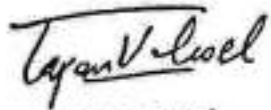


Khyasala
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (H.R.)

Global Talent Track appreciates

RPS Group of Institutions, Mohindergarh

for successful completion of the training program conducted in association with
Barclays Youth Employability Initiative and NASSCOM Foundation.



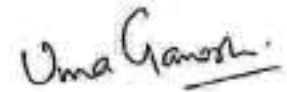
Tapan Goel
Executive Sponsor, Barclays YEI



Ashish Thakur
Executive Sponsor, Barclays YEI



Shrikant Sinha
CEO, Nasscom Foundation



Dr. Uma Ganesh
CEO, Global Talent Track



N.S.D.C.
National
Skill Development
Corporation

NASSCOM®
FOUNDATION



Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

MEMORANDUM OF UNDERSTANDING

BETWEEN

RPS Group of Institutions
www.rpsinstitutions.org

And

Swar Yantra Technologies Pvt. Ltd.
www.swaryantra.com

This Memorandum of Understanding (MoU) is entered into as of 6 December, 2018, by and between the RPS Group of Institutions and Swar Yantra Technologies Pvt. Ltd.

The partners have entered into this MoU because they:

Express the willingness of both parties to engage in an effort to improve employment opportunities for students of RPS Group of Institutions.

Swar Yantra Technologies has developed an innovative interviewing and assessment solution, which is being used by the organizations, which does not want to travel to multiple campuses but want to recruit candidates through campus placements.

Recognize the mutual interest in the fields of Training and Placement, Consultancy and dissemination of knowledge.

Recognize the importance of career counselling in shaping the career path of the candidates.

Recognize the importance of the Industry Partner within its field of expertise.

The parties hereby agree to establish collaboration according to terms and conditions set out in the articles following hereunder.

Scope of Collaboration

The general purpose of this MOU is to facilitate industry and institute based upon the principles of mutual benefit and may include the following general cooperation areas:

1. Joint industry-academia and research activities.
2. Specific activities under this MOU will be identified through consultation between the two parties. Swar Yantra Technologies agree to provide specific assistance to RPS Group of Institutions improving recruitment of their students with the use of their innovative solution. Swar Yantra Technologies will work with their clients to bring openings on its solution and all eligible students of RPS Group of Institutions will participate for job interviews on the platform from their campuses.



Swar Yantra Technologies Pvt. Ltd.

[Signature]

Director

[Signature]
R.P.S. College of Engg. & Tech
Balara Mohindergarh (H.R.)



3. As a preliminary activity, both Swar Yantra Technologies and RPS Group of Institutions will appoint a coordinator for effective communication that will happen throughout the session. Then RPS Group of Institutions will ensure all interested students download the android app and login using assigned RPS Group of Institutions code. Once login, students will complete their digital profiles and upload CV.
4. Time to time, Swar Yantra Technologies will bring campus recruitment opportunities on the solution and will communicate with RPS Group of Institutions coordinator and TPO. RPS Group of Institutions will ensure all eligible students participate in those interviews. Coordinator will share status report with Swar Yantra Technologies.
5. At times Swar Yantra Technologies may provide preparatory opening to students and RPS Group of Institutions will ensure all students will participate in those interviews. Result of these interviews will be shared with RPS Group of Institutions and TPO office will use it to give feedback to students. This feedback will be shared with Swar Yantra Technologies too.
6. RPS Group of Institutions agrees to work with and coordinate with Swar Yantra Technologies to improve and expand campus recruitments for their students. They also agree to allow Swar Yantra Technologies to interact and assess their students for campus recruitment related activities.

General Terms & Conditions

1. This MOU is not intended to, and does not create any right, benefit, or trust responsibility, substantive or procedural, enforceable at law or equity, by either party, its officers, employees, or agents against the other party, its officers, employees, or agents.
2. This MOU shall be operational upon signing and will have an initial duration of one year. All activities conducted before this date within the vision of the joint collaboration will be deemed to fall under this MOU.
3. This MoU is solely work for the development of students, faculty, industry executives and staff, community provides self employment, training and skill development.
4. In order to carry out and fulfill the aims of this agreement, each party shall appoint an appropriate person(s) to represent its organization and to coordinate the implementation of activities.
5. This whole engagement will be free of cost for RPS Group of Institutions and its students. Both the party cannot charge any kind of commercial for this service to second party.
6. Each party agrees that after execution of the MoU, shall not disclose any information in relation to these activities or the affairs of business or method of carrying on the business of the other without consent of both parties.
7. The Partnership covered by this MOU shall terminate upon completion of the agreed upon period. The agreement may also terminate with a written one-month notice from either side. In the event of non-compliance or breach by one of the parties of the obligations binding upon it, the other party may terminate the agreement with immediate effect.



Swar Yantra Technologies

(Signature)

Director

(Signature)
Principal
RPS College of Engg. & Tech
Balana Mohindergarh (HR.)

8. RPS Group of Institutions will allow Swar Yantra Technologies to use all reports, content for expanding services for benefit of students.
9. In the event any company not willing to visit RPS Group of Institutions for campus recruitment or no student is selected from RPS Group of Institutions by company, RPS Group of Institutions cannot hold Swar Yantra Technologies responsible for any liability what so ever.
10. All notice, demands and other communication under this agreement in connection herewith shall be written in English language and shall be sent to the last known address, email, or fax of the concerned party. Any notice shall be effective from the date on which it reaches the other party.
11. Nothing in this MOU obligates either party to commit or transfer any funds, assets, or other resources in support of projects or activities between the parties unless expressly stated in this agreement.
12. Both parties agree to submit outcomes of their joint collaboration, whilst safeguarding their own copyright and any patents that may produce by their collaboration.
13. The activities of this MOU must be carryout in accordance with appropriate laws and regulations existing in India.
14. RPS Group of Institutions will promote ethical practice among students and encourage them to conduct ethically during interview and assessments.
15. In the event of legal/health/family situations of selected candidates, where student cannot join organization, RPS Group of Institutions' WFO and HR coordinator will inform Swar Yantra Technologies giving all factual information.

The Agreement

1. At RPS Group of Institutions, Registrar/Prof. In-charge – CAOC will administer this MOU. At Swar Yantra Mr. Neeraj Upreti, CEO will administer this MOU.
2. The parties may enter into specific written agreements under authority of this MOU to clarify and define the nature, extent and terms of operation for the proposed collaborations, including intellectual property ownership and funding issues.



Swar Yantra Technologies Pvt. Ltd.

Neeraj

Director

Deepak

Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



अखिल भारतीय तकनीकी शिक्षा परिषद्
(सर्व संसदीय निकाय)
(मानव संसाधन विकास मंत्रालय, भारत सरकार)
नेशनल मंडेला मार्ग, वसन्त कुंज, नई दिल्ली-110070
दूरभाष: 011-26131495
ई-मेल: vcm@aicte-india.org

प्रो. एम.पी. पूनीया
उपाध्यक्ष
Prof. M.P. Poonia
Vice-Chairman

ALL INDIA COUNCIL FOR TECHNICAL EDUCATION
(A STATUTORY BODY OF THE GOVT. OF INDIA)
(Ministry of Human Resource Development, Govt. of India)
Nelson Mandela Marg, Vasant Kunj, New Delhi-110070
Phone: 011-26131495
E-mail: vcm@aicte-india.org

Date: 22nd June, 2021

AICTE/NEAT/TPO/2021-22

To
The Principal/Director/Vice-Chancellor
All AICTE Affiliated Institute/University

Dear Professor,

Greetings from All India Council of Technical Education..

Hope all are safe in this pandemic situation.

We are happy to inform you that NEAT Cell, AICTE, handles the three significant initiatives called National Educational Alliance for Technology (NEAT), AICTE Internship Portal, and Enhancement in Learning with Improvement in Skills (ELIS) portal. All these initiatives are for the betterment of Students in upskilling, reskilling, and enhancing their employability skills.

NEAT is a Public-Private partnership model between the Government of India (through its implementing agency AICTE) and the Education Technology Companies of India. AICTE is playing the role of a facilitator between Ed-Tech companies and students/youth thereby enhancing their employability skills, bridging their learning gaps (URL: <https://neat.aicte-india.org>)

Also, AICTE Internship Portal is providing various Internship opportunities for students. The registration is free of cost. Various Ministries, government department, MSME and corporates are posting their internship opportunities on this portal (URL: <https://internship.aicte-india.org>)

NEAT Cell also developed a portal called Enhancement in Learning with Improvement in Skills (ELIS) portal (<http://free.aicte-india.org>). Our Team regularly working on the identification of high-quality Ed-Tech courses which are free of cost. More than 1000 courses are available on this portal.

It is noticed that institutes and students are facing challenges in identifying suitable internship opportunities. As Internship is mandatory for every engineering graduate. In this regard, AICTE is extending its initiatives, resources, and facilities to support students. This will enhance the skills of students and make them industry-ready.

In this regard, we want to identify the Training & placement Officer (TPO) as a Single Point of Contact (SPoC) along with 5 Student placement coordinator from each Institute. So, it is requested to provide the contact details of your TPO and 5 Student placement coordinator in below given google form latest by 26th June 2021:

<https://forms.gle/gZivMqzvW8zMHcK59>

AICTE will also conduct interaction with TPOs for awareness of the NEAT scheme and AICTE Internship Portal in June and July 2021.

For any other clarification, feel free to contact the following region-wise officer:

Page 1 of 2



Kushtaan
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Sr. No.	Contact Person (Assistant Director, NEAT Cell)	Regional Office Covered	State Covered	Email ID
1	Shri N. Ramesh	SRO, SWRO, SWROCO, SCRO	Tamil Nadu, Puducherry, Andhra Pradesh, Telangana, Karnataka, Kerala and Lakshadweep,	ad1neat@aicte-india.org
2	Shri Vipin Kumar	CRO, WRO, ERO, EROCO	Madhya Pradesh, Gujarat and Chhattisgarh, Andaman and Nicobar, Sikkim, Orissa, Jharkhand, Assam, Manipur, Nagaland, Mizoram, Tripura, Meghalaya, Arunachal Pradesh, West Bengal, Goa, Maharashtra, Daman and Diu, Dadra and Nagar Haveli,	ad2neat@aicte-india.org
3	Shri Balvender Singh	NRO, NWRO	Uttar Pradesh, Uttarakhand, Bihar, Chandigarh, Haryana, Jammu & Kashmir, Ladakh, Delhi, Punjab, Rajasthan, Himachal Pradesh	ad3neat@aicte-india.org

Best Wishes

(Prof M. P. Poonia)
Vice Chairman

22/06/21 AICTE

Copy to

- Director Technical Education (DTEs)
- Principals of Polytechnics
- All AICTE's Regional Offices
- University Coordinators



Page 2 of 2

M. P. Poonia
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

MEMORANDUM OF UNDERSTANDING

Between
ELEATION
AND

[Enter your college Name]

The following terms of service [the "Agreement"] will be effective from [enter the date]

Between : ELEATION

Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan, Pune, Maharashtra – 411021

AND : [Enter your college name]

[Enter complete address of your college]

General Terms of services for ELEATION:

❖ For 2nd Year – Mechanical, Civil, Production and Automobile Engineering students

- ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of Design Engineers"
- ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial internship on CREO software with ELEATION.
- ELEATION will provide Certificate of Training on CREO software.
- ELEATION will provide Free licensed version software.
- ELEATION will provide Internship letter, letter of recommendation and experience letter.
- Based on Students interests ELEATION will conduct Paid Workshop (online/offline)

❖ For 3rd Year – Mechanical, Civil, Production and Automobile Engineering students

- ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of CAE (Simulation / Analysis) Engineers"
- ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial internship on ANSYS software with ELEATION.
- ELEATION will provide Certificate of Training on ANSYS software.
- ELEATION will provide Free licensed version software.
- ELEATION will provide Internship letter, letter of recommendation and experience letter.
- Based on Students interest ELEATION will conduct Paid Workshop (online/offline)

- ❖ For 4th Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELECTION will conduct On-Campus Placement process to recruit / hire students from your college, as CAE Engineers for ELECTION Services Pvt. Ltd.
 - ELECTION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of CAE (Simulation / Analysis) Engineers"
 - ELECTION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial internship on ANSYS software with ELECTION.
 - ELECTION will provide Certificate of Training on ANSYS software.
 - ELECTION will provide Free licensed version software.
 - ELECTION will provide Internship letter, letter of recommendation and experience letter.
 - Based on Students interest ELECTION will conduct Paid Workshop (online/offline)

- ❖ For Faculties of Mechanical, Civil, Production and Automobile Engineering.
 - ELECTION will conduct FREE Virtual Faculty Development Program on CAD (CREO) and CAE (ANSYS and HyperWorks Software) for all the faculties.
 - ELECTION will provide Certificate of Faculty Development Program
 - ELECTION will provide Certificate of Training
 - ELECTION will provide Free Licensed Version Software to all the Faculties.

General Terms of services for [Enter your college name]:

- College will provide faculty / Coordinator to organize expert lecture of 2nd, 3rd and 4th Year students
- College will provide faculty / Coordinator to organize internship drive for 2nd, 3rd and 4th Year students.
- College will provide faculty / Coordinator to organize on-campus Placement process for 4th Year students.

Notes:

- ✦ For Expert Lecture neither college nor ELECTION will charge any fees from Students.
- ✦ To organize expert lecture, Internship drive and on-campus placement drive, college will share concern faculty / coordinator Name, Email ID, Mobile number and designation with ELECTION via Email.
- ✦ Paid workshop will only be organized based on student's interest after the Guest lecture conducted by ELECTION.
- ✦ Fees of Paid workshop will be decided by ELECTION and College and then informed to students.
- ✦ Fees of Paid workshop will be collected either by College or ELECTION based on mutual understanding.
- ✦ For organizing paid workshop ELECTION will share 10% of total collected fees with college.
- ✦ For Placement in ELECTION Company as CAE Engineer neither ELECTION nor college will charge any fees from Students.
- ✦ The term of MOU is for 4 Years from the date of executing the MOU.
- ✦ After 4 Years College and ELECTION will sign new MOU.
- ✦ ELECTION will attend (if needed) any government body meetings in college (Physically / virtually), required for College level accreditation by Government bodies.
- ✦ To terminate this service of Agreement, College and/or ELECTION has to send official mail to concern person responsible for the MOU.
- ✦ College can use ELECTION logo for any (marketing) activities.
- ✦ While using ELECTION logo for any (marketing) activities, college has to inform ELECTION via send a mail to official email ID of ELECTION mentioned on this service agreement.

To,
ELEATION,
Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan,
Pune – Maharashtra
411021
For and on Behalf of ELEATION

Signature and Seal

Name: Apoorv Bapat
Designation: CEO and Founder
Mobile Number: 7720040021 / 7387403493
Official Email ID: apoorvbapat@eleation.com

To,
[Enter your college name]
[Enter complete address of college]

For and on Behalf of [Enter your college name].

Signature / Seal

Name:
Designation:
Mobile Number:
Official Email ID:





Invitation: Expert Lecture on CAE - RPS Group of Institutions @ Thu Jul 1, 2021 10am - 11am (IST) (placement@rpsinstitutions.org)

1 message

Apoorv Bapat <apoorvbapat@elevation.com>
Reply-To: Apoorv Bapat <apoorvbapat@elevation.com>
To: placement@rpsinstitutions.org, placementrps@gmail.com

Fri, Jun 18, 2021 at 11:04 AM

You have been invited to the following event.

Expert Lecture on CAE - RPS Group of Institutions

When Thu Jul 1, 2021 10am – 11am India Standard Time - Kolkata

[more details »](#)

Joining info Join with Google Meet
meet.google.com/ztz-mzuv-bkc

Join by phone
(US) +1 669-234-8598 (PIN: 576312524)

More phone numbers

Calendar placement@rpsinstitutions.org

Who

- Apoorv Bapat - organizer
- placementrps@gmail.com
- placement@rpsinstitutions.org



In ELEVATION's ExpertLecture on CAE, we will cover :

- v About ELEVATION.
- v What is CAE – Computer Aided Engineer?
- v What is FEM/FEA?
- v Industry need of CAE Engineering's
- v Future scope of CAE
- v Why to learn CAE software.

Going (placement@rpsinstitutions.org)? **Yes - Maybe - No** [more options »](#)

Invitation from Google Calendar

You are receiving this email at the account placement@rpsinstitutions.org because you are subscribed for invitations on calendar placement@rpsinstitutions.org.

To stop receiving these emails, please log in to <https://calendar.google.com/calendar/> and change your notification settings for this calendar.

Forwarding this invitation could allow any recipient to send a response to the organizer and be added to the guest list, or invite others regardless of their own invitation status, or to modify your RSVP. [Learn More.](#)

invite.ics

Ajay
Principal
RPS College of Engg. & Tech
Balana Muniberg (HR.)

ELEATION's Expert Lecture on CAE : Complete Process : RPS Group of Institutions

1 message

HR ELEATION <hr@elevation.com>
To: placementrps@gmail.com
Cc: placement@rpsinstitutions.org

Fri, Jun 18, 2021 at 11:07 AM

Dear Satyavir Sharma,

Greetings from ELEATION...!!!

Thanks for showing interest in ELEATION's Expert lecture on CAE (Computer Aided Engineering) by ELEATION.

In ELEATION's Expert Lecture on CAE, we will cover :

- ◆ About ELEATION.
- ◆ What is CAE – Computer Aided Engineer?
- ◆ What is FEM/FEA?
- ◆ Industry need of CAE Engineering's
- ◆ Future scope of CAE
- ◆ Why to learn CAE software.



As per the Google form submitted by you, we would like to confirm the Expert lecture schedule, Expert lecture for 2nd and 3rd Year students from Mechanical, Civil, Production and Automobile Engineering is schedule on :

Date : 01-07-2021

Time : 10:00 AM to 11:00 AM

Please share the below Google Meeting link with all the students of 2nd and 3rd Year students from Mechanical, Civil, Production and Automobile Engineering, so that they can attend the expert lecture.

meet.google.com/ztz-mzuv-bkc

Please share the attached PDF with all the students, containing details regarding:

- Profile of Expert lecturer – Mr. Apoorv Bapat.
- Process to download certificate of attendance.

Please share the below process with all the students to download certificate of attendance of expert lecture :

1. Open www.elevation.com
2. Click on signup (if you are new user) / login (if you are existing user) on ELEATION's website.

Ajayada
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergram (HR)

1. On ELEATION's Dashboard page – Click on College Test Button
2. Click on ELEATION's Training and Internship Button
3. Click on Register
4. Enter College Code : ELPL2007
5. Enter College Name, Degree, Branch, Semester – then click on Register
6. Once you complete the registration Click on "Click here to download the attendance certificate for attending online(live) expert lecture" button to download certificate of attendance.

If you need any update/information from us feel free to contact us.

Regards,

Apoorv Bapat

Founder and CEO

ELEATION


+91-7387403493


+91-7720040021

www.eleation.com


Share your reviews

2 attachments

 Expert Lecturer Profile.pdf
436K

 Process to Download Certificate of attendance.pdf
1041K




Principal
RPS College of Engg. & Tech
Balana Mohindergarh (HR.)

MOU Draft [MEMORANDUM OF UNDERSTANDING] : Between ELEATION & RPS Group of Institutions

1 message

HR ELEATION <hr@eleation.com>

Fri, Jun 18, 2021 at 11:08 AM

To: placementrps@gmail.com

Cc: placement@rpsinstitutions.org

Dear Satyavir Sharma,

Greetings from ELEATION...!!!

Thanks for showing interest in having MOU [MEMORANDUM OF UNDERSTANDING] with ELEATION.

Please find the attached word file containing the draft copy of MOU [MEMORANDUM OF UNDERSTANDING].

If you need any updates / changes, feel free to edit the document.

Please fill all the required details highlighted in red, in the attached word documents.

Reply this mail attaching the edited word document, once we receive your edited word document, then we will seal and sign the document and share the PDF copy with you via Email.

Then you can seal and sign it and share the PDF copy with us via Email.

If you need any update/information from us feel free to contact us



Regards,

Apoorv Bapat

Founder and CEO

ELEATION

+91-7387403493

+91-7720040021

www.eleation.com

Share your reviews

Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

MEMORANDUM OF UNDERSTANDING _ ELEATION.docx

74K

MEMORANDUM OF UNDERSTANDING

Between
ELEATION
AND

RPS Group of Institutions.

Draft NFA

01/07/2021

The following terms of service [the "Agreement"] will be effective from [enter the date]

Between: ELEATION

Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan, Pune, Maharashtra – 411021

Rao Pahlad Singh
AND : RPS Group of Institutions

At Balana, Satnali-Mahendergarh Road, District Mahendergarh (Haryana) PIN 123029

General Terms of services for ELEATION:

❖ For 2nd Year – Mechanical, Civil, Production and Automobile Engineering students

- ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of Design Engineers"
- ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial internship on CREO software with ELEATION.
- ELEATION will provide Certificate of Training on CREO software.
- ELEATION will provide Free licensed version software.
- ELEATION will provide Internship letter, letter of recommendation and experience letter.
- Based on Students interests ELEATION will conduct Paid Workshop (online/offline)

❖ For 3rd Year – Mechanical, Civil, Production and Automobile Engineering students

- ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of CAE (Simulation / Analysis) Engineers"
- ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial internship on ANSYS software with ELEATION.
- ELEATION will provide Certificate of Training on ANSYS software.
- ELEATION will provide Free licensed version software.
- ELEATION will provide Internship letter, letter of recommendation and experience letter.
- Based on Students interest ELEATION will conduct Paid Workshop (online/offline)

❖ For 4th Year – Mechanical, Civil, Production and Automobile Engineering students

- ELEATION will conduct On-Campus Placement process to recruit / hire students from your college, as CAE Engineers for ELEATION Services Pvt. Ltd.
- ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of CAE (Simulation / Analysis) Engineers"
- ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial internship on ANSYS software with ELEATION.
- ELEATION will provide Certificate of Training on ANSYS software.
- ELEATION will provide Free licensed version software.

Office Number 9, 3rd Floor, Pentium Residency,
Bhavdhan, Pune – Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email : apoorvbapat@eleation.com
www.eleation.com

M. P. G. S.
Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)

- ELEATION will provide Internship letter, letter of recommendation and experience letter.
- Based on Students interest ELEATION will conduct Paid Workshop (online/offline)

❖ For Faculties of Mechanical, Civil, Production and Automobile Engineering.

- ELEATION will conduct FREE Virtual Faculty Development Program on CAD (CREO) and CAE (ANSYS and HyperWorks Software) for all the faculties.
- ELEATION will provide Certificate of Faculty Development Program
- ELEATION will provide Certificate of Training
- ELEATION will provide Free Licensed Version Software to all the Faculties.

General Terms of services for RPS Group of Institutions:

- College will provide faculty / Coordinator to organize expert lecture of 2nd, 3rd and 4th Year students
- College will provide faculty / Coordinator to organize internship drive for 2nd, 3rd and 4th Year students.
- College will provide faculty / Coordinator to organize on-campus Placement process for 4th Year students.

Notes:

- For Expert Lecture neither college nor ELEATION will charge any fees from Students. ✓
- To organize expert lecture, internship drive and on-campus placement drive, college will share concern faculty / coordinator Name, Email ID, Mobile number and designation with ELEATION via Email. ✓
- Paid workshop will only be organized based on student's interest after the Guest lecture conducted by ELEATION. ✓
- Fees of Paid workshop will be decided by ELEATION and College and then informed to students. ✓
- Fees of Paid workshop will be collected either by College or ELEATION based on mutual understanding. ✓
- For organizing paid workshop ELEATION will share 10% of total collected fees with college. ✓
- For Placement in ELEATION Company as CAE Engineer neither ELEATION nor college will charge any fees from Students. ✓
- The term of MOU is for 4 Years from the date of executing the MOU. ✓
- After 4 Years College and ELEATION will sign new MOU. ✓
- ELEATION will attend (if needed) any government body meetings in college (Physically / virtually), required for College level accreditation by Government bodies. ✓
- To terminate this service of Agreement, College and/or ELEATION has to send official mail to concern person responsible for the MOU. ✓
- College can use ELEATION logo for any (marketing) activities. ✓
- While using ELEATION logo for any (marketing) activities, college has to inform ELEATION via send a mail to official email ID of ELEATION mentioned on this service agreement. ✓

To,
ELEATION,
Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan,
Pune – Maharashtra
411021
For and on Behalf of ELEATION



Signature and Seal

Name: Apoorv Bapat
Designation: CEO and Founder

Office Number 9, 3rd Floor, Pentium Residency,
Bhavdhan, Pune – Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email : apoorvbapat@eleation.com
www.eleation.com


Principal
R.P.S. College of Engg. & Tech
Balama Mohindergarh (HR.)

Mobile Number: 7720040021 / 7387403493
Official Email ID: apoorvbapat@eleation.com

To, R ---
RPS Group of Institutions
At Balana, Satnali-Mahendergarh Road, District Mahendergarh, HARYANA PIN 123029

For and on Behalf of RPS Group Of Institutions

Signature / Seal

Name: DR - Mahesh K. Yadav
Designation: Director
Mobile Number: 8053117441
Official Email ID: Principal@rpsinstitutions.org



Office Number 9, 3rd Floor, Pentium Residency,
Bhavdhan, Pune - Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email : apoorvbapat@eleation.com
www.eleation.com


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

MEMORANDUM OF UNDERSTANDING
Between
ELEATION
AND
RAO PAHLAD SINGH GROUP OF INSTITUTIONS.

The following terms of service [the "Agreement"] will be effective from July 01, 2021

Between: ELEATION

Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan, Pune, Maharashtra - 411021

AND : RAO PAHLAD SINGH GROUP OF INSTITUTIONS

At Balana, 8th Milestone, Satnoli-Mohendergarh Road, District Mohendergarh (HARYANA) PIN 123029

General Terms of services for ELEATION:

- ❖ For 2nd Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of Design Engineers"
 - ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial Internship on CREO software with ELEATION.
 - ELEATION will provide Certificate of Training on CREO software.
 - ELEATION will provide Free licensed version software.
 - ELEATION will provide Internship letter, letter of recommendation and experience letter.
 - Based on Students interests ELEATION will conduct Paid Workshop (online/offline)

- ❖ For 3rd Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of CAE (Simulation / Analysis) Engineers"
 - ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial Internship on ANSYS software with ELEATION.
 - ELEATION will provide Certificate of Training on ANSYS software.
 - ELEATION will provide Free licensed version software.
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- ❖ For 4th Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELEATION will conduct On-Campus Recruitment process to recruit / hire students from your college, as CAE Engineers for ELEATION Services Pvt. Ltd.
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 - ELEATION will provide Free licensed version software.

Office Number 9, 3rd Floor, Pentium Residency,
Bhavdhan, Pune - Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email : poonshapat@eleation.com
www.eleation.com

Kusyadau



Kusyadau
Principal
R.P.S. College of Engg. & Tech
Balana Mohendergarh (HR.)

- o ELEATION will provide Internship letter, letter of recommendation and experience letter.
- o Based on Students Interest ELEATION will conduct Paid Workshop (online/offline)
- o For Faculties of Mechanical, Civil, Production and Automobile Engineering.
 - o ELEATION will conduct FREE Virtual Faculty Development Program on CAD (CREO) and CAE (ANSYS and HyperWorks Software) for all the faculties.
 - o ELEATION will provide Certificate of Faculty Development Program
 - o ELEATION will provide Certificate of Training
 - o ELEATION will provide Free Licensed Version Software to all the Faculties.

General Terms of services for RAO PANIAD SINGH GROUP OF INSTITUTIONS:

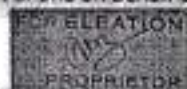
- > College will provide faculty / Coordinator to organize expert lecture of 2nd, 3rd and 4th Year students
- > College will provide faculty / Coordinator to organize internship drive for 2nd, 3rd and 4th Year students.
- > College will provide faculty / Coordinator to organize on-campus Placement process for 4th Year students.

Notes:

- 4 For Expert Lecture neither college nor ELEATION will charge any fees from Students.
- 4 To organize expert lecture, Internship drive and on-campus placement drive, college will share concern faculty / coordinator Name, Email ID, Mobile number and designation with ELEATION via Email.
- 4 Paid workshop will only be organized based on student's interest after the Guest lecture conducted by ELEATION.
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- 4 Fees of Paid workshop will be collected either by College or ELEATION based on mutual understanding.
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- 4 For Placement in ELEATION Company as CAE Engineer neither ELEATION nor college will charge any fees from Students.
- 4 The term of MOU is for 4 Years from the date of executing the MOU.
- 4 After 4 Years College and ELEATION will sign new MOU.
- 4 ELEATION will attend (if needed) any government body meetings in college (Physically / virtually), required for College level accreditation by Government bodies.
- 4 To terminate this service of Agreement, College and/or ELEATION has to send official mail to concern person responsible for the MOU.
- 4 College can use ELEATION logo for any (marketing) activities.
- 4 While using ELEATION logo for any (marketing) activities, college has to inform ELEATION via send a mail to official email ID of ELEATION mentioned on this service agreement.

To,
ELEATION,
Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan,
Pune - Maharashtra
411021

For and on Behalf of ELEATION



Signature and Seal

Name: Apoorv Bapat
Designation: CEO and Founder

Office Number 9, 3rd Floor, Pentium Residency,
Bhavdhan, Pune - Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email : apoorvbapat@eleation.com
www.eleation.com

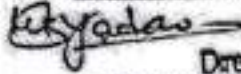



Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Mobile Number: 7720040021 / 7387403493
Official Email ID: apoorvbapat@election.com

To,
RAO PAHLAD SINGH GROUP OF INSTITUTIONS
At Balana, 8th Milestone, Satnali-Mohindergarh Road, District Mohindergarh (HARYANA) PIN 123022

For and on Behalf of Rao Pahlad Singh Group Of Institutions



Director

Signature / Seal R.P.S Group of Institutions
Balana, Mohindergarh

Name: Dr. Mahesh K Yadav (Haryana)

Designation: Director


Mobile Number: 8053117441

Official Email ID: principal@rpsinstitutions.org



Office Number 9, 3rd Floor, Pentium Residency,
Bhavdhan, Pune - Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email: apoorvbapat@election.com
www.election.com




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

29/06/2016

Memorandum of Understanding

THIS MEMORANDUM OF UNDERSTANDING made on the 29/06/2016, between "DUCAT" a unit of A.A.M. Infotech Private Limited a company duly registered under the Companies Act, 1956 and having its registered office at 1808/2 Old Dlf, Sector 14, Gurgaon, (hereinafter called "DUCAT" "The First Party")

AND

RPS Engineering College, Mahendergarh (hereinafter called the "Second Party")

WHEREAS the "First Party" has agreed to provide PLC training of B.Tech students of RPS Engineering College, Mahendergarh (Second Party) on the terms and conditions as agreed between the parties and set out hereunder,

Now it is hereby agreed by and accepted between the parties hereto as follows: -

"DUCAT Responsibilities"

- > That DUCAT will impart training to the students of RPS Engineering College, Mahendergarh, course- B.Tech on PLC-Scada & contents agreed by both the parties.
- > DUCAT will evaluate the input given to students through Module Based tests & results of test will be shared with concerned HOD and final evaluation of tests would be reflected on certificate to be issued by DUCAT finally at the time of convocation at the end of training.
- > Feedback of trainer will be taken by both ducate & college authorities on weekly basis

Branch Office :
1808/2, 2nd FLOOR,
SUNDER SINGH MARG
OLD DLF, NEAR GANPATI HONDA SHOWROOM,
SECTOR-14, GURGAON.
Ph : 0124-4219095, 96, 97, 98
M : 09873477222, 333
E : gurgaon@ducatindia.com

"Training Methodology"


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

- DUCAT will provide complete training at college campus following the time table given by college authorities comprising of both Classroom & Lab session. It will be a Practical Based Conceptual Training Program

"College Responsibilities"

- RPS Engineering College, Mahendergarh will provide sufficient infrastructure by way of lab, PCs, and will also lend support in smooth conduct of the training through its Faculty of Electronics & Communication and technical staff of ECE department; & in overall supervision of HOD & Training and Placement department
- RPS Engineering College, Mahendergarh will provide LCD /Projector for training purposes during this period.
- RPS Engineering College, Mahendergarh has also agreed to issue any computer set or required hardware (if any) to DUCAT team.
- RPS Engineering College will give a batch of at least 25 students for the training.

"Training and Training Modules"

- That the training has been decided on various module of PLC Scada on the specific contents agreed upon, and the training will be at College campus.
- That the duration of training will be around 90 hrs for each batch including theory as well as practical starting from Day i.e././....

"Fee"


- For the above training, it has been agreed that DUCAT will charge a fee Of Rs 3500/Student, mutually agreed by both the parties.
- The list of participating students would be given to DUCAT by RPS Engineering College, Mahendergarh, before the training starts.
- DUCAT has agreed to receive and RPS Engineering College, Mahendergarh has agreed to pay the 50% of total Amount after completion of 50% of the training & 50% after the completion of training. Cheque/DD has to be drawn in favor of A.A.M InfoTech Pvt. Ltd. Payable at Gurgaon. (This will include the Cheque/DD charges).

"Force Majuro"

Branch Office :

1808/2nd FLOOR
SUNDER SINGH MARG
OLD DLF, NEAR GANPATI HONDA SHOWROOM,
SECTOR-14, GURGAON.
Ph : 0124-4219095, 96, 97, 98
M : 09873477222, 333
E : gurgaon@ducatindia.com

NOIDA | GREATER NOIDA | GHAZIABAD | FARIDABAD | JAIPUR


Principal
R.P.S. College of Engg. & Tech
Balana Mohinderghar (HR.)

costs, charges or expenses incurred or suffered by the other party by reason of such failure or delay if such failure or delay is caused due to any force majeure condition, such as acts of God, Government laws and regulation, strike, Lockouts, war or any other causes beyond its control.

- That the DUCAT will not be responsible for non – selection of any of the student.
- That the DUCAT is responsible only for providing the requisite education and training as per the course contents agreed upon by the College but in no case be held responsible for the affiliation of the respective course or that of the college.

The above mentioned terms & conditioned have been agreed by both the parties and undersigned by the representatives of DUCAT & RPS Engineering College, Mohindergarh.

Chadha

DUCAT
Mr. Ankit Chadha

Mahesh K. Yadav
RPS Engineering College
Mr. Mahesh K. Yadav

For AAM INFOTECH (P) LTD.

Authorised Signatory



Branch Office :
1808/2, 2nd FLOOR,
SUNDER SINGH MARG
OLD DLF, NEAR GANPATI HONDA SHOWROOM,
SECTOR-14, GURGAON,
Ph : 0124-4219095, 96, 97, 98
M : 09873477222, 333
E : gurgaon@ducatindia.com

Mahesh K. Yadav
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

ASSOCIATE PARTNER

This is to certify that

**M/S Sahasra Sambhav Skill Development Pvt. Ltd.,
Noida**

Is associated with

RPS

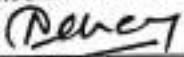
Group of Institutions, Mahendergarh

As associate partner for providing Quality Skill Development & Placement Services to Engineering/Diploma students (ECE/EEE/EN) on Core Electronics Manufacturing Segments like as PCB Design, PCB Manufacturing, PCB Assembly, LED Lighting, and Solar Technology & USB/SSD Manufacturing

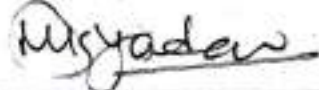
Date – 22/06/2017



For Sahasra Sambhav Skill Dev Pvt. Ltd.


Dr. Anshu Kumar
General Manager
Sahasra Sambhav


Skill India
शौचल भारत - कुशल भारत


Director
R.P.S. College of Engg. & Tech.
Balana (M.Garh)


Principal
R.P.S. College of Engg. & Tech.
Balana Mohindergarh (HR.)

MEMORANDUM OF UNDERSTANDING

This Memorandum of Understanding ("MOU") is made on Jan 24, 2019 and shall be effective from the said date ("EFFECTIVE DATE") BY AND BETWEEN

Triedge Solutions Pvt. Ltd, a corporation incorporated under the Companies Act, 1956 and having its registered office at 5/5 West Patel Nagar, New Delhi 110008 and Corporate Office at 403, 4th Floor Prem Sadan, 11 Rajendra Place, New Delhi 110008 hereinafter referred to as the "Service Provider" or "Triedge"

AND

RPS Group of Institutions having its registered office at Balana, Mahendragarh-Haryana hereinafter referred to as the "Institution"

The Service Provider and the Institution shall be known individually as "PARTY" and collectively as "PARTIES".

WHEREAS

The Service Provider is engaged in the business of providing Recruitment, Lateral Hiring, Campus Hiring, Staffing and Contract Management Services, Internships, Trainings, Resume Writing Services and other Career Related Services collectively known as "CAREER SERVICES"


2. The Institution is desirous of increasing career opportunities for its students and has agreed to sign this MOU so that the students of the Institution can avail of the Career Services provided by Triedge.

NOW IT IS HEREBY AGREED BY AND BETWEEN THE PARTIES HERETO AS FOLLOWS:

1. OBJECTIVES OF THE MOU

The objectives of this Memorandum of Understanding are:

- a. To enhance career opportunities for the students of the Institution.


Principal
R.P.S. College of Engg. & Tech
Balana, Mohindergarh (HR.)
Director
R.P.S. Group of Institutions
Balana, Mohindergarh
(Haryana)


Principal
R.P.S. College of Engg. & Tech
Balana, Mohindergarh (HR.)

- b. To enable Triedge to recommend the Institution and its students to its corporate clients for Internships and final placements.
- c. To promote interaction and provide a formal basis for interaction between Triedge and the Institution.


2. Service Provider's Obligations

- a. The Service Provider shall allow access to career services and opportunities to those students of the Institution who register on its website www.triedge.in ("Registered Students") and agree to abide with the Terms and Conditions.
- b. The Registered Students of the Institution will have access to the following sections of the Triedge website:
 - I. Profile Page & Dashboard
 - II. Internship Opportunities
 - III. Job Opportunities
 - IV. Career Related Article Library
 - V. Free Trainings
- c. Triedge will host internship and placement opportunities posted by its Clients across functions and sectors including HR, Sales & Marketing, Finance, Analytics, Operations, Digital Marketing, Telecom, Electronics, Construction, Healthcare, Sports, Fitness and Leisure, IT-ITES, Retail, Apparel, Logistic, Media, BFSI, Handicrafts, Beauty and Wellness, Tourism and Hospitality etc.



3. Institution's Obligations

- a. The Institution's Placement Cell or Team will register on www.triedge.in so that internship and job opportunities can be shared with the Placement Cell of the Institution.
- b. The Institution's Placement Cell or Team will periodically circulate through email and social media career opportunities and services hosted on www.triedge.in with their students.


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Director
R.P.S. Group of Institutions
Balana, Mohindergarh
(Haryana)


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

- c. The Institution will provide a link of website www.triedge.in on its official Website and / or Placement Cell Website.
- d. The Institution will encourage its students to register on www.triedge.in so that the students can apply for positions posted on it.
- e. The Institution will nominate 2 students who will be the point of contact for Triedge.

4. Financial Obligation

This MOU will not result in any financial obligation and neither Party will be required to make any payment to the other Party for the services mentioned in this MOU.

5. Publicity

Each Party may use the name and logo of the other party as a placement or recruitment or internship or training partner in the public domain on their websites, brochures, presentations and other marketing mediums or materials.

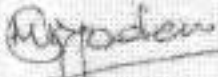
6. Term of MOU

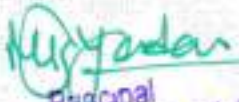
- a. This MOU will be valid for a period of two year from the Effective Date. The MOU can be renewed for further term(s) upon mutual agreement between the Parties.
- b. The MOU may be terminated, with or without cause, by either Party by giving a notice of one month to the other Party



1. Other Terms

- a. It is agreed that notwithstanding anything to the contrary contained herein, the Service Provider or its Clients or any Corporate who posts career services or opportunities on www.triedge.in shall have no obligation whatsoever to hire any particular candidate or student referred by the Institution.


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)
Director
R.P.S. Group of Institutions
Balana, Mohindergarh
(Haryana)


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

- b. It is also agreed that the Institution and the Service Provider will provide all its services on "best efforts basis" only.
- c. The terms of the MOU may be changed by the Parties through mutual consent. Any change in the terms and conditions or amendment in the terms of the MOU will be in writing.

BY SIGNING BELOW, the parties, acting through their duly authorised officers, has caused this Memorandum of Understanding to be executed, effective as of the day and year first above written

For and on behalf of RPS Group of Institutions

Authorized Signatory

Signature M. K. Yadav Principal
RPS College of Engg. & Tech
Balana Mohindergarh (HR.)

Name Dr. Mahesh Kumar Yadav

Designation Director Director
RPS Group of Institutions
Balana, Mohindergarh
(Haryana)

Date 24-01-2019

For and on behalf of Triedge Solutions Pvt Ltd.

Authorized Signatory

Signature

Name

Designation

Date



M. K. Yadav
Principal
RPS College of Engg. & Tech
Balana Mohindergarh (HR.)

Memorandum of Understanding

(MOU)

For

Academic & Training Alliance

Between

Sofcon India Pvt. Ltd.

And

**RAO PAHLAD SINGH GROUP OF
INSTITUTIONS, BALANA,
MOHINDERGARH (HARYANA)**



M. Yadav
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

This MEMORANDUM OF UNDERSTANDING is entered into this - 27/07/ 2012

BETWEEN

Sofcon India Pvt Ltd

Domain Background: Automation Training Company

Registered/ Head : 705, 7th Floor, Pearls Omaxe, Netaji Subhash Place, Pitampura, Delhi-110034

AND

RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH (HARYANA) - set up in 2008 as an educational institute by RPS Education Society, Mohindergarh. registered through Registrar, Firms and Societies, Chandigarh. The Institutions are approved by AICTE, New Delhi and affiliated to MD University, Rohtak.

RECITALS:

1. AND WHEREAS both *Sofcon India Pvt. Ltd. (Company/Organization)* and **RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH (HARYANA)** share common goals and are desirous to establish, a cooperative arrangement towards - strengthening hands-on Training (through curricula, faculty, infrastructure, improvements) in line with the diverse industry's requirements of relevant skill-sets in Electricals /Electronics/Instrumentation/Communication/CS Engineering disciplines at different levels.

2. NOW THE PARTIES HEREBY ACKNOWLEDGE AND DECLARE as follows:

The **RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH (HARYANA)** and the Company & Organization Name **Sofcon India Pvt. Ltd.**, (hereinafter referred to as "the Parties") agree to serve as a link between Industry and Education for ensuring relevant and quality learning through the following:

3.1 **RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH (HARYANA)** has agreed to provide lab infrastructure covering training space, lighting, air-conditioning, furniture, computer machines (20 numbers), UPS supply etc. required for training at college campus.

3.2 **Sofcon India** has agreed to conduct Training program for 2nd, 3rd and final year students from Electronics & Communication Engineering /Computer Science & Engineering Branches of **RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH (HARYANA)** campus as per following:

(RAJKUMAR)
BRANCH IN CHARGE
SOFCON INDIA PVT. LTD.



Director
R.P.S. College of Engg. & Tech.
Balana (M/Garh)


Principal
R.P.S. College of Engg. & Tech.
Balana Mohindergarh (H)



Semester	Duration	Who should attend	Course	Fee Per Participant INR
After 4 th Sem	50 Hrs.	ECE	PLC & SCADA	5000/-
After 6 th Sem.	60 HRS.	EC	PLC, SCADA, Motors & Drives	6000/-
After 4 th or 6 th Sem	60 Hrs	ECE & CSE	Embedded C, 8051 Micro controllers, Robotics, Assembly Language, H/W Design	5000/-

3.3. RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH(HARYANA) will provide 100 numbers of students of II, III , Final year from Electronics & Communication Engineering /Computer Science & Engineering branches. Training will be of 04 Hrs . duration per class. Sofcon can also conduct this training program on Saturdays & Sundays. Fee collection from the students will be the responsibility of RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH (HARYANA) . Boarding/Lodging of faculty members during training will be in RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH (HARYANA) SCOPE.

3.4. Both the parties will also identify the college faculty for training through various initiatives, including faculty development program by re-skilling the faculty in the relevant disciplines.

3.5. Both the parties will promote student & faculty interface with the industry by way of training/workshops, seminars, projects/Internships etc.

3.6. RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH(HARYANA) will not hire Faculties /Automation/Embedded Systems Engineers employed by Sofcon India Pvt Ltd.

3.7. Both the parties will encourage knowledge based enterprises by fostering better linkages between, Industry and Academia, by collaborating with RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH(HARYANA) Development Cells.

3.8. Sofcon India shall submit all the supporting documents to RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH (HARYANA) at the end of training period supported by the attendance document of the Candidates which shall be duly verified by RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH



[Handwritten signature]

(RAJKUMAR)
BRANCH IN CHARGE
SOFCON INDIA PVT. LTD.

[Handwritten signature]
Principal
R.P.S. College of Engg. & Tech
Balana Mohinder Garh (H.R.)
R.P.S. College of Engg
Balana (M/Gar)

(HARYANA) College. Payment will be made within 10 days of the receipt of the documents.

3.9. The association will also contribute towards exchange of information and research to enhance the awareness of varied industries/domains amongst academia.

4.0. This Memorandum shall commence from the date of its signing and shall continue for a period of three (3) years from the date thereof and be renewed for successive periods unless either Party notifies in writing to the other Party of its intention to terminate this MOU ninety days in advance.

4.1. This Memorandum is not a legally binding contract and under no circumstance does this Memorandum subject either of the parties to liability for breach, whether material or minor, of contract or any other liability under national or international law or any other applicable law.

The Parties may establish a "Joint Working Group" to manage and execute the cooperative activities mentioned in this MOU.

1. The Parties will endeavor to ensure that the Working Group is composed of the representatives of the Sofcon India and RPS GROUP OF INSTITUTIONS, BALANA, MOHINDERGARH (HARYANA).
2. Each Party will nominate appropriate personnel to discuss and promote detailed cooperation activities and modalities for the implementation of this MOU. When necessary and as mutually agreed, the parties may hold working group meetings. One Party shall notify the other Party of any modification in writing in case of change in the assigned personnel.



Authorised Designatory
Name Raj Kumar Balian
Designation: Branch In-Charge
Company: Sofcon India Pvt Ltd

(RAJKUMAR)
BRANCH IN CHARGE
SOFCON INDIA PVT. LTD.

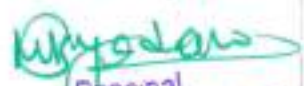


27.7.2012

Authorised Designatory
Name: Prof. Mahesh K. Yadav
Designation : Director
RPS Group of Institutions, Balana



Director
R.P.S. College of Engg. & Tech
Balana (M/Garh)



Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (Hr.)



DRAGONCHAIN

Memorandum of Understanding
Between

Rao Pahlad Singh Group of Institutions
Balana, Dist: Mahendragarh, Haryana-123029

Represented by: **Dr. Mahesh K Yadav**

Designation: Director

Address: Balana, Dist: Mahendragarh, Haryana-123029

and

India Block Chain Alliance, IBA /TPCRA World

Represented by: **Mr. Raj A. Kapoor**

Founder

India Block Chain Alliance, New Delhi



Towards

Global Block Chain Centre of Excellence,

Rao Pahlad Singh Group of Institutions

Powered by

India Blockchain Alliance, TPCRA World and Dragonchain,
USA

M. Yadav

M. Yadav
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



This Memorandum of Understanding ("MOU") is executed as of date: _____ ("Effective Date") between

Party 1 -Rao Pahlad Singh Group of Institutions refer as RPS GOI

RPS GOI, Balana a private group of institutions offering education in Engineering, Science, Arts Management & Polytechnic was formed with a goal to find solutions to the greatest technological and social problems of the 21st century. The students of RPS GOI are trained to become future leaders who will have the capability to lead giant organizations in the emerging corporate landscape. RPS GOI is dedicated to provide students with real world and practical academic exposure that will transform them into successful professionals.

Address - Balana, Dist: Mahendragarh, Haryana-123029, India



Party 2 - Indian Blockchain Alliance, IBA/ TPCRA World

TPCRA World Along with IBA promotes all emerging technologies like Blockchain, AI, IoT, AR-VR, Robotics and other latest technologies by having collaborations across the Globe. The working model is wherein targeted specialist and expert Global companies are engaged to develop projects and contents to be delivered in Education Institutions, Industry or Government depending on the Service extended

The India Blockchain Alliance, IBA was established in 2010, with the purpose of mutual assistance in the field of business development, networking, cooperation and a joint approach to defending the interests of the members of the alliance. It also seeks to raise awareness of the importance of the blockchain technology among the professional and lay public, and, therefore, organizes various events and training courses. It also cooperates with the government authorities in the field of the relevant legislation.

The India Blockchain Alliance is a key player in the process of creating a setting that will transform India into a global blockchain destination. The members will work harmoniously and in unison for the benefit of the individual and collective business development of blockchain companies.

Today, (IBA/TPCRA World) is the most influential voice in the blockchain industry. It is a not-for-profit organization that promotes evidence-based adoption of Blockchain and Distributed Ledger Technologies (DLT) across the public and private sectors.

[Signature]
Principal
R.P.S College of Engg. & Tech
Balana Mahendragarh (H.R.)



PREAMBLE

Whereas, RPS Group of Institutions referred as RPS GOI, at its various engineering and sciences departments is envisioned with responsibility of training technical and scientific manpower in various front-line areas of importance for the Nation and is also contributing to the rapidly growing scientific and technological knowledge and professional excellence in Science & Technology by undertaking industrial & applied research and consultancy.

WHEREAS, Indian Blockchain Alliance hereby referred as IBA/TPCRA World, is engaged in training, research and development blockchain and emerging technologies, research, design and development and consultancy in the field of Blockchain, Fintech, DeFi and multiple emerging technologies and related fields.

WHEREAS, both RPS GOI and IBA/TPCRA World, now



- Recognizing the importance of research and development in the areas of blockchain and multiple emerging technologies, as well as imparting industrial training to the engineering/technology/sciences students and professionals.
- Appreciating the need for creation of large reservoir of highly qualified manpower in all fields related to blockchain and multiple emerging technologies.
- Desiring to club their efforts by pooling their expertise and resources
- Networking with collaborations in the emerging area of Blockchain Technology
- Generating outcomes in terms of better opportunities to the beneficiaries in terms of projects, Internship, consultancy

INTEND to form a nucleus for promoting excellent quality manpower in the fields of engineering, technology and sciences with special emphasis on blockchain and multiple emerging technologies.

NOW, THEREFORE, in consideration of the mutual promises made herein and of good and valuable consideration, the receipt and sufficiency of which both RPS GOI and IBA/TPCRA World hereby acknowledge, RPS GOI and IBA/TPCRA World hereby agree to sign a memorandum of understanding (MOU).

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Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



DRAGONCHAIN

ARTICLE-I: SCOPE OF THE MOU

This MOU details the modalities and general conditions regarding collaboration between RPS GOI and IBA/TPCRA World for enhancing the availability of highly qualified manpower in the areas of blockchain and multiple emerging technologies without any prejudice to prevailing rules and regulations in RPS GOI and IBA/TPCRA World without any disregard to any mechanism evolved and approved by the competent authorities under Govt. of India in so far as such mechanism applies to RPS GOI and IBA/TPCRA World. The areas of cooperation can be extended through mutual consent.

ARTICLE-II: SCOPE AND TERMS OF INTERACTIONS

Both RPS GOI and IBA/TPCRA World shall encourage interactions between the Engineers, Scientists, Research fellows, faculty members and students of both the organizations through setting up a Centre of Excellence with the skills hub where government and industry will secure blockchain expertise and all their resource requirements. The Center of Excellence at SAGE College, Bhopal cofounded by RPS GOI and IBA/TPCRA World and Dragon Chain which would be called

Global Blockchain Centre of Excellence,
RPS Group of Institutions
Powered by

India Blockchain Alliance, TPCRA World and Dragonchain,
USA



is developed and will be enhanced with collaborators in global blockchain industry organization, Queensland Government, Blockchain Collective, Local Australian companies and evolving partnerships of either parties to deliver the goals. The activities carried out in the CoE will be

- Education/ training / certification
- Integrated programs with International Universities
- Internships
- Strategic mentoring
- Business networking
- Government partnership projects
- Joint Research Funding Opportunities
- Industry events

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Mujyaden

Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (H.P.)



- Blockchain Employment Placements
- Blockchain Consulting
- Joint Consultancies

The RPS GOI and IBA/TPCRA World partners will also be able to connect, collaborate with the alliance partners jointly in these activities

Besides the above the following activities are also proposed:

- Organization of joint conferences and seminars;
- Practical training of RPS GOI students, professionals
- Joint guidance of student projects in blockchain and multiple emerging technologies and other areas of national interest at RPS GOI by IBA/TPCRA World on mutually agreeable terms.
- IBA/TPCRA World may depute its personnel as visiting faculty at College to teach any of the regular Course or specialized topics when requested.
- IBA/TPCRA World may assist in recommending an expert faculty to deliver courses/workshops/trainings to the students/staff of RPS GOI.
- Gateway towards the learning opportunities, internships and advance education to the universities who also become part of the alliance.
- IBA/TPCRA World may showcase its business activities at the seminar/workshop/conference, etc. at RPS GOI.
- In any of the projects mentioned, wherever financial aspects are involved, amount, payment conditions, etc. would be spelt out clearly before starting the activity.

ARTICLE-III: SHARING OF FACILITIES

- RPS GOI and IBA/TPCRA World shall make provisions to share their respective important Infrastructure facilities in order to promote academic and research interaction in the areas of cooperation.
- IBA/TPCRA World and RPS GOI will be sharing software and other materials and components developed in-house in the areas of cooperation, if permissible within the rules governing the two institutions. However, responsibility for safety of software and other materials during the exchange will rest on respective Head of academic department/section of the College.

ARTICLE-IV: CO-ORDINATION OF THE PROGRAMME INCLUDING FINANCIAL ARRANGEMENTS

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Principal
R.P.S. College of Engg. & Tech
Baroda, Mahendergarh (H.R.)



- A. The collaborative programme between RPS GOI and IBA/TPCRA World shall be executed by an Executive committee appointed by Directors/Dean of both the Organizations /Institutes.
- B. Financial arrangements for each specific collaboration wherever applicable will be decided on a case-to-case basis and brought on record in each case after due approval from heads of both the institutions.

ARTICLE-V: EFFECTIVE DATE AND DURATION OF MOU

- A. This MOU shall be effective from the date of its approval by competent authorities at both ends.
- B. The duration of the MOU shall be for a period of 5 years from the effective date.
- C. During its tenancy, the MOU may be extended or terminated by a prior notice of not less than six months by either party. However, termination of the MOU will not in any manner affect the interests of the students/faculty/scientists who have been admitted to pursue a programme under the MOU.
- D. Any clause or article of the MOU may be modified or amended by mutual agreement of IBA/TPCRA World and RPS GOI.

ARTICLE-VI: Intellectual Property Right

Rights regarding publications, patents, royalty, ownership of software/design/product developed etc. under the scope of this MOU, shall be decided by the two parties by mutual consent.



ARTICLE-VII: CONFIDENTIALITY

During the tenure of the MOU both RPS GOI and IBA/TPCRA World will maintain strict confidentiality and prevent disclosure of all the information and data exchanged under the scope of this MOU for any purpose other than in accordance with this MOU.

Both RPS GOI and IBA/TPCRA World shall bind their respective personnel who come into possession or knowledge of any confidential information not to disclose the same to third parties without written approval of the disclosing party or use such confidential information for any use other than intended under this agreement or projects.

[Handwritten signature]
Principal
RPS College of Engg. & Tech.
Balana Mahendergarh (H.F.)



Further both RPS GOI and IBA/TPCRA World shall put in place adequate and reasonable measures to keep and store confidential information secure so as to prevent any unauthorized use.

CONFIDENTIAL INFORMATION shall mean any proprietary information, data or facts belonging to PARTIES collectively or severally, disclosed by the disclosing party under this agreement or any RPS GOI subsequent agreement, whether in writing, verbal or electronically, irrespective of the medium in which such information is stored, which is marked confidential or with any other words having similar meaning by the disclosing party, or specifically agreed to be kept confidential by the parties, or declared or identified so by the disclosing party before such disclosure or during the discussions. However confidential information shall not include any data or information which:

- A. is or becomes publicly available through no fault of the receiving party, is already in the rightful possession of the receiving party prior to its receipt of such data or information;
- B. is independently developed by the receiving party without reference to the confidential information of the disclosing party I
- C. is rightfully obtained by the receiving party from a third party or is in the public domain
- D. is disclosed with the written consent of the party whose information it is, or
- E. is disclosed pursuant to court order or other legal compulsion, after providing prior notice to the disclosing party.

ARTICLE-VIII : AMENDMENTS

Any amendment and/or addenda to the AGREEMENT shall be in writing and signed by the PARTIES hereto and shall only after such execution be deemed to form part of the AGREEMENT and have the effect of modifying the AGREEMENT to the extent required by such amendment or agenda.

ARTICLE-IX: RESOLUTION OF DISPUTES

- A. This agreement shall be taking effect and be construed in accordance with the Laws of India and subject to the jurisdiction of the courts at Haryana.
- B. The dispute or difference whatsoever arises between PARTIES in relation to or in connection with this AGREEMENT both the parties shall first try to resolve the dispute/difference amicably between themselves, failing which the matter shall be referred to and settled through arbitration. The arbitration proceedings shall be held



DRAGONCHAIN

in accordance with the provision of Indian Arbitration and Reconciliation ACT, 1996. The venue of arbitration shall be New Delhi and Language of arbitration shall be in English.

ARTICLE-X: MISCELLANEOUS

- A. The headings and RPS GOI-headings are inserted for convenience only and shall not affect the construction of this Agreement.
- B. Both RPS GOI and IBA/TPCRA World shall not, during the term of this Agreement directly or indirectly, solicit or offer employment or engagement to any of the personnel of other party without the prior consent in writing of that other party.
- C. No failure to exercise and no delay in exercising, on the part of a Party, and right, remedy, power or privilege hereunder shall operate as a waiver thereof, nor shall any single or partial exercise of any right, remedy, power or privilege hereunder preclude any other or further exercise thereof or the exercise of any other right, remedy, power or privilege. The rights, remedies, power and privileges herein provided are cumulative and not exclusive of any right, remedies, powers and privileges provided by law.
- D. After this Agreement has been signed, all preceding understandings/negotiations and correspondence pertaining to it shall become null and void.

Annexure A

FEE:USD 399 Per Student (Not Mandatory To Take)



QUARTER 1

1. Faculty Development program (Paid Program for upgrading the nominated Faculties, the backbones of Institution)
2. Launch free IBA Dragonchain programs (FREE for all Faculties and all Students, 100% entire college students can get certified both Tech and Non-Tech)
3. Announce a hackathon (FREE participation for all Tech & Non-Tech Students)
4. International Webinar (One FREE webinar per Quarter, rest if any needed then Paid)

QUARTER 2

1. Launch blockchain foundation programs (Paid as per individual costing; Also Paid RPS GOI decided rates for the entire College on RPS GOI subscription model available)
2. Launch specialization & short term programs (Paid as per individual costing; Also Paid RPS GOI decided rates for the entire College on RPS GOI subscription model available)
3. Announce a hackathon/competition (FREE participation for all Tech & Non-Tech Students)



4. International Webinar (One FREE webinar per Quarter, rest if any needed then Paid)

QUARTER 3

1. Organize International Conference (Paid for some expenses as applicable on actuals depending on how and what scale the College wants it)
2. Arrange Internship Opportunities (Free as Applicable and qualifying eligibility & Linked to Quarter 2 point 1 and point 2)
3. Live Project Initiation (Free as Applicable and qualifying eligibility & Linked to Quarter 2 point 1 and point 2)
4. International Webinar (One FREE webinar per Quarter, rest if any needed then Paid)

QUARTER 4

1. Options open for international pathways (Paid options available as pathway programs and linked to Quarter 2 point 1 and point 2)
2. Arrange internship opportunities (Free as Applicable and qualifying eligibility & Linked to Quarter 2 point 1 and point 2)
3. Announce a hackathon/competition (FREE participation for all Tech & Non-Tech Students)
4. International Webinar (One FREE webinar per Quarter, rest if any needed then Paid)

Annexure B

In order to deepen the understanding of Blockchain Technology, RPS GOI Bhopal, MP and TPCRA World & IBAs pleased to enter upon an MoU to promote Blockchain Technology through the following:

1. Branding by both the party.
2. International Exposure to our students.
3. These certifications are open for all i.e. off campus and on campus students.
4. Following are the free certification for all the students, Free Dragon Chain USA Courses:

- I. The Untapped Power of Blockchain
- II. The Dragonchain Ecosystem
- III. Dragonchain Architecture
- IV. Provisioning a Dragonchain
- V. How to Deploy an Unmanaged L2 Node
- VI. Certified Dragonchain Practitioner Exam
- VII. Smart Contracts: Currency Creation



[Signature]

[Signature]
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (H.R.)



DRAGONIVHO

VIII. Developer: Smart Contracts

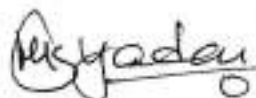
Note: Techies Will Do All & For Non Techies 1, 2& 7

WITNESS WHEREOF PARTIES HERE TO HAVE ENTERED INTO THIS AGREEMENT EFFECTIVE AS ON THE DATE AND YEAR FIRST WRITTEN ABOVE.

IBA/TPCRA World

RPS GOI , Balana

Mr Ritesh Kumar Srivastava
Director, TPCRA World
director@tpcraworld.com
Date : 01st Feb, 2022


01.02.2022
Dr. Mahesh K. Yadav
Director
director@rpsinstitutions.org
Date: 01st Feb, 2022




Witness 1

Witness 2

Name
Signature

Name
Signature


Principal
R.P.S College of Engg. & Tech
Balana Mohindergam (HR.)

MEMORANDUM OF UNDERSTANDING
Between
ELEATION
AND
RAO PAHLAD SINGH GROUP OF INSTITUTIONS.

The following terms of service [the "Agreement"] will be effective from July 01, 2021

Between: **ELEATION**

Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan, Pune, Maharashtra – 411021

AND : **RAO PAHLAD SINGH GROUP OF INSTITUTIONS**

At Balana, 8th Milestone, Satnali-Mahendergarh Road, District Mahendergarh (HARYANA) PIN 123029

General Terms of services for ELEATION:

- ❖ For 2nd Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of Design Engineers"
 - ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial Internship on CREO software with ELEATION.
 - ELEATION will provide Certificate of Training on CREO software.
 - ELEATION will provide Free licensed version software.
 - ELEATION will provide Internship letter, letter of recommendation and experience letter.
 - Based on Students interests ELEATION will conduct Paid Workshop (online/offline)

- ❖ For 3rd Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of CAE (Simulation / Analysis) Engineers"
 - ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial Internship on ANSYS software with ELEATION.
 - ELEATION will provide Certificate of Training on ANSYS software.
 - ELEATION will provide Free licensed version software.
 - ELEATION will provide Internship letter, letter of recommendation and experience letter.
 - Based on Students interest ELEATION will conduct Paid Workshop (online/offline)

- ❖ For 4th Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELEATION will conduct On-Campus Placement process to recruit / hire students from your college, as CAE Engineers for ELEATION Services Pvt. Ltd.
 - ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of CAE (Simulation / Analysis) Engineers"
 - ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial Internship on ANSYS software with ELEATION.
 - ELEATION will provide Certificate of Training on ANSYS software.
 - ELEATION will provide Free licensed version software.

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Bhavdhan, Pune – Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email : apoorvbapat@eleation.com
www.eleation.com



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R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

- ELEATION will provide Internship letter, letter of recommendation and experience letter.
- Based on Students interest ELEATION will conduct Paid Workshop (online/offline)
- ❖ For Faculties of Mechanical, Civil, Production and Automobile Engineering.
 - ELEATION will conduct FREE Virtual Faculty Development Program on CAD (CREO) and CAE (ANSYS and HyperWorks Software) for all the faculties.
 - ELEATION will provide Certificate of Faculty Development Program
 - ELEATION will provide Certificate of Training
 - ELEATION will provide Free Licensed Version Software to all the Faculties.

General Terms of services for RAO PAHLAD SINGH GROUP OF INSTITUTIONS:

- ✓ College will provide faculty / Coordinator to organize expert lecture of 2nd, 3rd and 4th Year students
- ✓ College will provide faculty / Coordinator to organize internship drive for 2nd, 3rd and 4th Year students.
- ✓ College will provide faculty / Coordinator to organize on-campus Placement process for 4th Year students.

Notes :

- ✚ For Expert Lecture neither college nor ELEATION will charge any fees from Students.
- ✚ To organize expert lecture, internship drive and on-campus placement drive, college will share concern faculty / coordinator Name, Email ID, Mobile number and designation with ELEATION via Email.
- ✚ Paid workshop will only be organized based on student's interest after the Guest lecture conducted by ELEATION.
- ✚ Fees of Paid workshop will be decided by ELEATION and College and then informed to students.
- ✚ Fees of Paid workshop will be collected either by College or ELEATION based on mutual understanding.
- ✚ For organizing paid workshop ELEATION will share 10% of total collected fees with college.
- ✚ For Placement in ELEATION Company as CAE Engineer neither ELEATION nor college will charge any fees from Students.
- ✚ The term of MOU is for 4 Years from the date of executing the MOU.
- ✚ After 4 Years College and ELEATION will sign new MOU.
- ✚ ELEATION will attend (if needed) any government body meetings in college (Physically / virtually), required for College level accreditation by Government bodies.
- ✚ To terminate this service of Agreement, College and/or ELEATION has to send official mail to concern person responsible for the MOU.
- ✚ College can use ELEATION logo for any (marketing) activities.
- ✚ While using ELEATION logo for any (marketing) activities, college has to inform ELEATION via send a mail to official email ID of ELEATION mentioned on this service agreement.

To,
ELEATION,
Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan,
Pune – Maharashtra
411021
For and on Behalf of ELEATION

Signature and Seal

Name: Apoorv Bapat
Designation: CEO and Founder



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Bhavdhan, Pune – Maharashtra - 411021
Mob: 7720040021 / 7387403493
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Apoorv Bapat



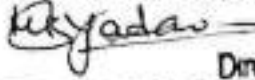
Apoorv Bapat
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Mobile Number: 7720040021 / 7387403493
Official Email ID: apoorvbapat@eleation.com

To,
RAO PAHLAD SINGH GROUP OF INSTITUTIONS
At Balana, 8th Milestone, Satnali-Mohendergarh Road, District Mahendergarh (HARYANA) PIN 123029

For and on Behalf of Rao Pahlad Singh Group Of Institutions


Director
Signature / Seal R.P.S Group of Institutions
Balana, Mohindergarh
Name: Dr. Mahesh K Yadav (Haryana)
Designation: Director
Mobile Number: 8053117441
Official Email ID: principal@rpsinstitutions.org



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Balana Mohindergarh (HR.)



इंजीनियरिंग के तीन विद्यार्थियों ने आपदा को चुनौती मानते अवसर में बदला

कोरोना वाई तक दवा और खाता पहुंचाने के लिए बनाया मेडि रोबो

सुरेंद्र बल्लभ

महेंद्रगढ़। इंजीनियरिंग के तीन स्टूडेंट्स ने आपदा को चुनौती के तौर पर लेंते हुए इसे अवसर में बदला। कोरोना में मरीजों के जरिये सहायता की सेवा को बढ़ाने में अपना सहयोग किया। आरपीएस के इंजीनियरिंग स्टूडेंट्स हितेश, अमितेश, प्रदीप ने अपने आइडिया को मूर्त रूप देकर 60 से हट टच सैनिटाइजेशन मशीन बनाई। इन मशीनों को सार्वजनिक कार्यालयों, अस्पताल से लेकर प्रकृत चौपालों पर लगाया गया। जिससे एक लाख से अधिक लोगों को फायदा पहुंचा। इन तीन स्टूडेंट ने प्रशासन के पैलेंट को स्वीकार करते हुए मेडि रोबो बनाया। जो संक्रमण का खतरा कम करके कोविड अस्पताल में मरीजों तक दवा, भोजन पहुंचाने का जरिया बना।

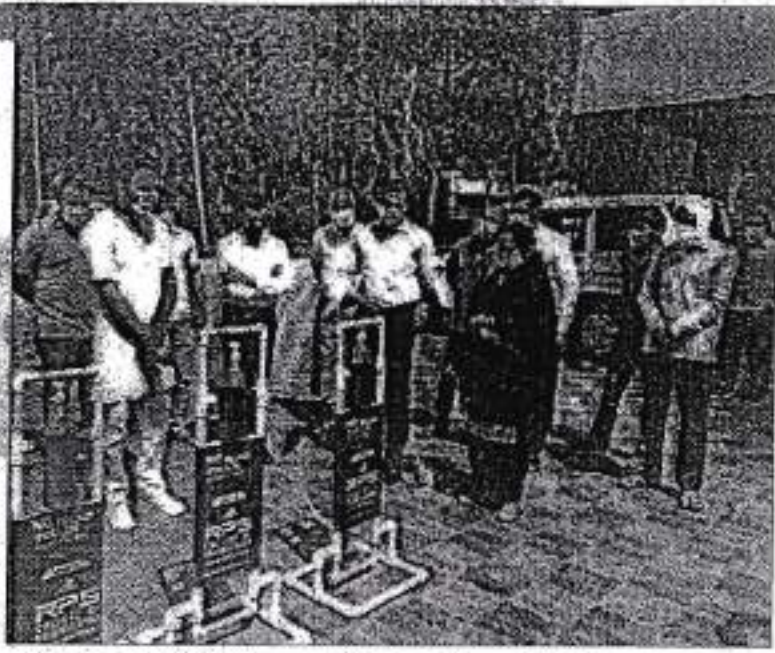
आरपीएस इंजीनियरिंग कॉलेज के विद्यार्थियों ने सॉफ्टवेयर के समय प्रशासन से विशेष अनुमति लेकर अपने तीन आइडिया के जरिये मांगवता भी लेख की। इन तीनों आइडिया को मूर्त रूप देकर मशीनें में बदला। आरपीएस सोसायटी ने इन मशीनों को अस्पतालों तक पहुंचाना। महेंद्रगढ़ में सभी अपने घरों में फैल होने को मजबूर है। उस समय इलेक्ट्रिकल एंड फार्मुलिकेशन

का रोबो बनाने का ये 3 विद्यार्थी बनने से ला सकते थे। इसमें फैलने लगे थे। जो मोबाइल से कनेक्ट हो जाते थे। इन कैमरे के जरिये दूर बैठ कर व्यक्ति होने को इलेक्ट्रिकल कनेक्ट करता था। करीब 150 सेरिंग टूट कर टूटकर, काम करना बंद कर दिया। इन विद्यार्थियों ने इसे ठीक करने के लिए एक मशीन बनाई। जो रोबो रोने के लिए काम करती है। जो दूर से सैनिटाइज हो कर सकता है। महेंद्रगढ़ और पर कोविड सेंटर को भी दवा पहुंचाने में देखा होने का कारण लेकर मात्र 35 हजार रुपये में कोविड सेंटर प्रशासन को दिया। इन 2020 में यह रोबो अस्पताल में काम करने लगा था। आरपीएस इंजीनियरिंग कॉलेज में हितेश, अमितेश ने कहा कोविड के सुमीकर पर समय में सहाय के सोल्यूशन में देना इन मशीनों को बनाने के लिए कुछ करने की जरूरत थी थी। वहीं इसमें हितेश मजदू को कोविड सेंटर तक नहीं को। इसी स्टूडेंट्स प्रोफेसर दिन रात रोबो में पढ़ते। इन आइडिया को मशीनी में बदलने में अस्पताल सुनिता की भी विशेष भूमिका रही।

7 किलो वजन ले जा सकता है रोबो

डिफर्टमेंट के प्रोफेसर चक्रवर्ती ने फाइनाल ईयर के स्टूडेंट हितेश, महेश, अमितेश को अपने आइडिया पर काम करने के लिए प्रेरित किया। इन तीनों स्टूडेंट ने सैनिटाइजेशन टनल बनाई। जिसके सबसे पहले संस्थान के दरवाजे पर लगाया। इस टनल से निकलने वाला व्यक्ति सैनिटाइज हो जाया था। टनल को अधिक स्थानों पर पहुंचाना मुश्किल था। ऐसे में इन स्टूडेंट ने दूसरे पैलेंट के तौर पर जो हट टच सैनिटाइजेशन मशीन बनाई। इस मशीन को घर से दवाकार अपने हाथों का सैनिटाइज किया जा सकता था। इस एक मशीन को बनाने पर करीब 900

रुपये खर्च आया। बेहद किफायती ऐसी 60 मशीन महान रो मशीनें में महेंद्रगढ़, नारनौल, कर्नाम, अटोली में सार्वजनिक स्थानों, अस्पतालों, बाजारों में चौक चौकों पर लगाई गईं। कोविड सेंटर में मरीजों तक खाद, दवाइयों सहित सस्तर का सामान पहुंचाना बेहद मुश्किल साबित हो रहा था। कोविड सेंटर में जाने से कमियों को संक्रमण का आत्यधिक खतरा था। महेंद्रगढ़ एसडीएम विजय कुमार ने इन स्टूडेंट के दोनो आइडिया पर बनी मशीनों को देखकर उन्हें कोविड सेंटर में दवा, खाता पहुंचाने के लिए कोविड मशीन तैयार करने के लिए चुनौती दी।



महेंद्रगढ़ अस्पताल में ऑटोमेटिक सैनिटाइजर मशीन के संस्कारन की जानकारी देते मशीन लयान।



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CONGRATULATIONS!!!

आरपीएस कालेज महेन्द्रगढ़ ने पाया प्रदर्शनी में पहला स्थान

विश्वविद्यालय

विश्वविद्यालय ने पहली बार अपने दरवाजे हट आम और छात्रों के लिए खोले: कुलपति

केंद्र प्रमुख विवेक चंद, मंत्री एन सी एन में
विश्वविद्यालय के विद्यार्थियों ने
आरपीएस कालेज महेन्द्रगढ़ में
आयोजित प्रदर्शनी में पहला स्थान
जितने का श्रेय विद्यार्थियों के
सहयोग और प्रमुखों के मार्गदर्शनात्मक
सहायता के बिना नहीं हो पाता।
प्रदर्शनी में विद्यार्थियों ने अपने
सामग्री, प्रोजेक्ट्स, प्रयोगों, प्रदर्शनों
के माध्यम से अपने ज्ञान और कौशल
को प्रदर्शित किया।



अनेक सादरता हुआ प्रदर्शन
विद्यार्थियों ने अपने प्रदर्शनों के माध्यम से
अपने ज्ञान और कौशल को प्रदर्शित किया।
प्रदर्शनी में विद्यार्थियों ने अपने
सामग्री, प्रोजेक्ट्स, प्रयोगों, प्रदर्शनों
के माध्यम से अपने ज्ञान और कौशल
को प्रदर्शित किया।



प्रदर्शनी में
विद्यार्थियों ने
अनेक सादरता
हुआ प्रदर्शन
विद्यार्थियों ने
अपने प्रदर्शनों
के माध्यम से
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कौशल को प्रदर्शित
किया।

विश्वविद्यालय ने पहली बार अपने दरवाजे हट आम और छात्रों के लिए खोले: कुलपति
विश्वविद्यालय के विद्यार्थियों ने अपने प्रदर्शनों के माध्यम से अपने ज्ञान और कौशल को प्रदर्शित किया। प्रदर्शनी में विद्यार्थियों ने अपने सामग्री, प्रोजेक्ट्स, प्रयोगों, प्रदर्शनों के माध्यम से अपने ज्ञान और कौशल को प्रदर्शित किया।

विद्यार्थियों ने अपने प्रदर्शनों के माध्यम से अपने ज्ञान और कौशल को प्रदर्शित किया। प्रदर्शनी में विद्यार्थियों ने अपने सामग्री, प्रोजेक्ट्स, प्रयोगों, प्रदर्शनों के माध्यम से अपने ज्ञान और कौशल को प्रदर्शित किया।

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Published on dated 01/03/2019

चालक को झपकी आई तो कार स्वतः गति कम कर किनारे ही जाएगी खड़ी

आरपीएस इंजीनियरिंग कालेज के मोहित ने बनाया 'स्मार्ट ड्राइविंग कार' का आविष्कार

स्मार्ट ड्राइविंग कार

आरपीएस इंजीनियरिंग कालेज के मोहित ने बनाया 'स्मार्ट ड्राइविंग कार' का आविष्कार। यह कार चालक को झपकी आने पर स्वतः गति कम कर किनारे ही जाएगी खड़ी।

मोहित ने बनाया 'स्मार्ट ड्राइविंग कार' का आविष्कार

आरपीएस इंजीनियरिंग कालेज के मोहित ने बनाया 'स्मार्ट ड्राइविंग कार' का आविष्कार। यह कार चालक को झपकी आने पर स्वतः गति कम कर किनारे ही जाएगी खड़ी।

जेरपुर में छह मार्च को ओलंपियाड के विजेताओं को वि

Published on dated 05/03/2019



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Balana Mohindergarh (HR.)

करियर कायद्याल में विद्यार्थियों को बताई ब्रांड वैल्यू की महत्ता

करियर कायद्याल में विद्यार्थियों को ब्रांड वैल्यू की महत्ता के बारे में बताया गया है। ब्रांड वैल्यू का मतलब है कि एक ब्रांड का नाम कितना मजबूत है और कितना लोग उसे पहचानते हैं। ब्रांड वैल्यू को बढ़ाने के लिए ब्रांड के लोगो, पैकेजिंग, प्रचार-प्रसार, और ग्राहकों के अनुभवों को ध्यान में रखना पड़ता है। ब्रांड वैल्यू को बढ़ाने से ब्रांड के लोगो और पैकेजिंग को पहचानना आसान हो जाता है। ब्रांड वैल्यू को बढ़ाने से ब्रांड के लोगो और पैकेजिंग को पहचानना आसान हो जाता है।

Published in Dainik Bhaskar on dated 03/5/2019.

[Signature]
03/5/19



[Signature]
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Balana Mohindergarh (HR.)

आरपीएस इंजीनियरिंग कॉलेज में 'समन्वय-2021' में विद्यार्थियों ने दिखाई प्रतिभा

भास्कर न्यून महेंद्रा

आरपीएस इंजीनियरिंग कॉलेज बलाना में दो दिवसीय समन्वय-2021 का शुभारंभ हुआ जिसमें प्रो. सुरेश कुमार शर्मा, विद्यार्थी डॉ. देवेन्द्र शर्मा, प्रो. अचल शर्मा, डॉ. जय कठुवाल तथा केंद्र के सहायक डॉन एक शनिवार को सैलेंट एंटरप्रेन में ही समन्वय के माध्यम से प्रारंभिक कार्यक्रम का शुभारंभ किया।



इस दौरान सहपाठी सुदीप ने बताया इस प्रकार के कार्यक्रमों से विद्यार्थियों में एक बेहतर कौशल, संचार कौशल, कॉलेज के विभागाध्यक्ष प्रो. कमलेश शर्मा ने बताया कि समन्वय-2021 दो दिवसीय कार्यक्रम है। कार्यक्रम का शुभारंभ प्रो. राजेश सिंह शर्मा ने बताया कि इससे विद्यार्थियों में आत्म-निर्भरता, आत्मविश्वास, संघर्ष भाव का विकास होगा।

इस दो दिवसीय कार्यक्रम में इस बार विभिन्न भागों में राष्ट्रीय स्तर पर प्रतियोगिताओं का आयोजन किया जा रहा है।

आरपीएस इंजीनियरिंग कॉलेज में क्रिकेट मैच का शुभारंभ करते अभिषेक शर्मा, प्रतियोगिताएं होंगी। जिसमें प्रथम व द्वितीय वर्ष के छात्र-छात्राएं भाग ले रहे हैं। कार्यक्रम के पहले दिन सभी प्रतियोगिताओं के सेमिफाइनल मुकाबले करवाए गए।

क्रिकेट में परफेक्ट इलेवन ने 50 रन से रेवाड़ी रॉयल्स को हराकर फाइनल में जाकर बनाई तथा कंप्यूटर लॉगिंस ने देवी दादरी को हराकर फाइनल में जगह बनाई।

सभी प्रतियोगिताओं के फाइनल मुकाबले कल होंगे। इसके अलावा

समन्वय-2021 में मनोरंजन खेल जैसे तीन टॉग रेस, जलेबी रेस, तंबोला, निबु रेस, मुजिकल चेयर, टॉग ऑफ वार आदि का भी आयोजन किया गया तथा कॉलेज के प्रो. संदीप शर्मा के नेतृत्व में अभिषेक शर्मा, सुदीप शर्मा, विभागाध्यक्ष प्रो. राजेश सिंह शर्मा, प्रो. सुमित सेने, प्रो. संदीप शर्मा, डॉ. रितु मोहन तथा अभिषेक शर्मा के विश्वक संचालक नियमित



Myaden
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



RPS
COLLEGE OF ENGG. & TECH

Satnali Road, Balana,
Mahendergarh

SAMANVYA
Winter Festival

2nd Day
Glimpse...



आरपीएस इंजीनियरिंग कॉलेज में 'समन्वय-2021' संपन्न, स्टूडेंट्स ने विभिन्न स्पर्धाओं में दिखाई प्रतिभा

महेंद्रगढ़ | आरपीएस इंजीनियरिंग कॉलेज बलाना में दो दिवसीय 'समन्वय 2021' का शुक्रवार को समापन हुआ। जिसमें कॉलेज के सभागार में डॉयरेक्टर डॉ. महेश कुमार यादव, रजिस्ट्रार डॉ. देवेन्द्र यादव, उप-प्राचार्य डॉ. जे के गोठवाल तथा डीन एकेडमिक प्रो. राजेन्द्र सिंह यादव ने विजेताओं को सम्मानित किया। डॉ. महेश कुमार यादव ने बताया कि ऐसे कार्यक्रमों से विद्यार्थियों में एक प्रतिस्पर्धा की भावना पैदा होती है। कार्यक्रम के समन्वयक प्रो. कर्मवीर श्योरण ने बताया कि इस दो दिवसीय कार्यक्रम में सांस्कृतिक, तकनीकी एवं खेल संबंधी 15 प्रतियोगिताएं हुईं। जिसमें इंजीनियरिंग और मैनेजमेंट विभाग के 300 से अधिक छात्र-छात्राओं ने हिस्सा लिया।

टेबल टेनिस में वेस्ट डॉक्टर का खिताब सुराजु बोटिक सीएसई प्रथम वर्ष, वेस्ट सिंगर कर्ण



सिंह, वेस्ट क्विज नीरज, वेस्ट सोल्टी रणु प्रिति, काजल, ममता सीएसई प्रथम वर्ष, मेहंदी प्रतियोगिता में मोनिका, वेस्ट स्पंकर में मोहित ईसीई द्वितीय वर्ष तथा वेस्ट आर्टिस्ट में विचित्र कुमार ने काजी मारी। क्रिकेट में परफेक्ट इलवन टीम ने 24 रन से क्विटर लायंस को पराजित किया। किरन देव बोटिक मेकेनिकल प्रथम वर्ष ने 23 रन देकर दो विकेट

लिए तथा मेन ऑफ द मैच घोषित किए गए। वालीबॉल फाइनल में बलाना प्लास्टर ने सतनाली लायंस को 29-27, 19-25 तथा 25-18 से हराया। एथलेटिक्स में मनोप बोटिक सीएसई प्रथम वर्ष ने 100 मीटर और 400 मीटर रेस में प्रथम स्थान प्राप्त किया। क्विज में हितेश तथा रितिक सिजयल्लो बोटिक सीएसई प्रथम वर्ष की टीम विजेता रही। बैडमिंटन में लड़कों के वर्ग में प्रवीण कुमार बोटिक सीएसई प्रथम वर्ष तथा लड़कियों के वर्ग में भावना सिंह बोटिक सीएसई प्रथम वर्ष ने प्रथम स्थान हासिल किया। संयोजक प्रो. सुधीर पवार, प्रो. प्रिथी दुटलानी, प्रो. अनिल वाघवा, प्रो. सुनील सेनी, प्रो. संदीप कुमार, प्रो. अंकुरा उदयदा, प्रो. सत्यनारायण शर्मा, प्रो. राजीव यादव, प्रो. नेत्रपाल, प्रो. दिनेश यादव, डॉ. जेतु मोहन तथा सम्स्त स्टाफ उपस्थित रहा।



M. Yadav
Principal
R.P.S. College of Engg. & Tech
Balana Mohendergarh (HR)

आरपीएस इंजीनियरिंग कॉलेज में हुआ विद्यार्थी केरियर कार्यशाला का आयोजन

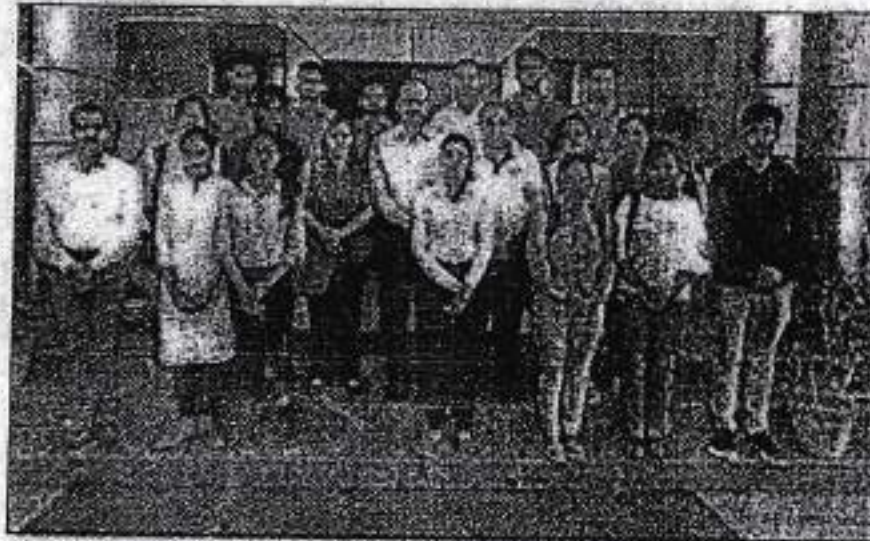
कार्यशाला बच्चों के सर्वांगीण विकास के लिए बहुत जरूरी: डा. देवेन्द्र सिंह



द्वितीय तथा तृतीय वर्ष के इंजीनियरिंग के सभी विभागों के बच्चों ने लिया हिस्सा

हरिभूमि व्यूज >>> महेंद्रगढ़

आरपीएस इंजीनियरिंग कालेज बलाना के सभागार में गुरुवार को कंपस से कारपोरेट केरियर कार्यशाला का आयोजन ट्रेनिंग एंड प्लेसमेंट विभाग के तत्वाधान में करवाया गया। जिसमें कालेज के द्वितीय तथा तृतीय वर्ष के इंजीनियरिंग के सभी विभागों के बच्चों ने हिस्सा लिया। कार्यशाला के दौरान मंच का संचालन डा. त्रिलोचन ने किया। कार्यशाला के उद्घाटन के अवसर पर कालेज के रजिस्ट्रार डा. देवेन्द्र सिंह यादव, कालेज डीन प्रो. राजेन्द्र सिंह यादव व दिल्ली की एक कंपनी के एचआर विभाग के मुखिया दीपक भराव व पीपल एंटरप्राइज नई दिल्ली की डायरेक्टर पूनम वर्मा मौजूद थे। कॉलेज के रजिस्ट्रार डा. देवेन्द्र सिंह यादव ने अपने संबोधन में केरियर कार्यशाला की महत्ता पर



महेंद्रगढ़। आरपीएस कालेज में आयोजित कार्यशाला में भाग लेने आए कंपनी के अधिकारी स्टाफ के साथ। फोटो: हरिभूमि

बतल दिया व कहा कि इस तरह की कार्यशाला इंजीनियरिंग के बच्चों के सर्वांगीण विकास और उनकी ब्रांड वैल्यू के लिए बहुत जरूरी है। उन्होंने भविष्य में इस तरह कि कार्यशाला

करवाने का आश्वासन दिया, ताकि आरपीएस इंजीनियरिंग कालेज के बच्चे ज्यादा से ज्यादा और अच्छी प्लेसमेंट ले सकें। कार्यशाला के अंत में दीपक भराव तथा पूनम वर्मा ने

मॉक इंटरव्यू का आयोजन

ट्रेनिंग एंड प्लेसमेंट विभाग के अधिकारी विकास शर्मा ने बताया कि कार्यशाला के प्रथम भाग में दीपक भराव के द्वारा कंपस के कारपोरेट विभाग पर विस्तार से एक क्विज का रूप में सवाल पूछे गए। क्विज के माध्यम से इंजीनियरिंग के लिए विभिन्न मोकों का जल्द केरियर के लिए विभिन्न विभागों पर ध्यान देना चाहिए। फिर प्रश्न उत्तर सत्र किया गया। कार्यशाला के दूसरे भाग में मॉक इंटरव्यू का आयोजन किया गया जिसमें इंजीनियरिंग के बच्चों ने सफलतापूर्वक अतिरिक्त रूप से बतल चर्चा किया।

इंजीनियरिंग कॉलेज के प्रतिभागियों के उच्चतम भविष्य की कामना की तथा कालेज मैनेजमेंट का आभार व्यक्त किया। इस कार्यशाला के आयोजन के मौके पर कालेज डायरेक्टर डा. महेश कुमार यादव, समन्वयक प्रो. सत्यवीर शर्मा, विभागाध्यक्ष प्रो. कर्मवीर श्योराण, डा. गुनदीप, डा. राजीव, प्रदीप कुमार व नीरज आदि मौजूद थे।

Signature
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

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TRAINING | DEVELOPMENT | PLACEMENT

www.cetpainfotech.com



CETPA received "Best Education and Training Company" award by Saha An Khan.



CETPA received "Top IT Training Company" award by Chetan Bhagat for quality training.



CETPA was dignified with "Best Industry" award by Shashi Thoorar

Principals
Principal

R.P.S. College of Engg. & Tech
Bahara, Mohindergarh (HR.)

CETPA Infotech Pvt. Ltd.

Development - Training - Consultancy

"We believe in quality because knowledge Matters"

MEMORANDUM OF UNDERSTANDING

This Memorandum of Understanding (hereinafter called as the 'MOU') is made on 21st day of September Two Thousand Twenty- Two (21/09/2022).

BETWEEN

Rao Pahlad Singh Group of Institutions having its College Premises Balana, Satnali Road Mahendergarh, Haryana 123029 hereinafter referred to as "RPSGOI" of the First Party represented by Dr. Mahesh K Yadav- Director, RPS GOI.

AND

CETPA InfoTech Private Limited (CIA No. U72100UR2005PTC031052) having its registered office at D-58, Sector 2, Noida 201301, U.P., India Uttar Pradesh 201301 hereinafter referred to as "CETPA" of the Second Party represented by Mr. Vikas Kalra.

WHEREAS:


First party is a Higher Educational Institution named

Rao Pahlad Singh Group of Institutions:



- First Party & Second Party believe that collaboration and co-operation between themselves will promote more effective use of each of their resources, and provide each of them with enhanced opportunities.
- The Parties intent to cooperate and focus their efforts on cooperation within area of Skill Based Training, Education and Research.
- Both Parties, being legal entities in themselves desire to sign this MOU for advancing their mutual interest;
- Cetpa InfoTech Private Limited, the Second Party is engaged in Skill Development, Education and R&D Services in the fields of – Electronics & Communication, Computer Science & Engineering and Management and related fields of engineering and professional education.
- CETPA InfoTech Pvt Ltd, the Second Party is promoted by CETPA Training.
- Cetpa InfoTech Pvt Ltd. is giving Contribution in Skill India Initiative from Its National presence of 4 branches Noida, Lucknow, Roorkee and Dehradun.
- CETPA InfoTech India is the First Training Company to be affiliated with below Globally Accepted affiliations.
- ❖ NSDC (Ministry of Skill Development & Entrepreneurship, Government of India)




Principal
R.P.S. College of Engg. & Tech.
Balana Mohendergarh (Haryana)
Director
R.P.S. Group of Institutions
Balana, Mohinda

- ❖ DDU-GKY (IT Sector Skills Training)

NOW THEREFORE, IN CONSIDERATION OF THE MUTUAL PROMISES SET FORTH IN THIS MOU, THE PARTIES HERETO AGREE AS FOLLOWS:

OBJECTIVES OF THE COLLABORATION:

- To have CETPA as a Training Partner for Management, B.Tech. & Diploma Electronics & Communication and B.Tech. Computer Science & Engineering Programs at RPSGOI.
- To provide 30-40 hrs training to students of RPSGOI at College premises.
- Make the student aware of the latest tools and techniques in order to keep them industry ready at the end of their course.
- To build/improve the confidence level of the student to face the challenges of realtime.

ACTIVITIES & RESPONSIBILITIES OF RPS Group of Institutions:

- College shall include CETPA as its Official Training Partner via College Website & Other Medias.
- College shall provide the infrastructure facilities to CETPA as per requirement for conducting training programs.
- College will provide Faculty Mentors / Lab Instructors (if required) during the training programs.

ACTIVITIES & RESPONSIBILITIES OF CETPA:



- CETPA shall be responsible for conducting Workshop, Training Programs, for the students of Discussed courses from 1st Yr., 2nd Yr, 3rd Yr. & Final Year.
- CETPA will provide all kind of Study Material, Software and courseware for the above mentioned programs from Time to Time as per the requirement.
- CETPA will provide Quality Trainers & Professionals to students of Integral University during the above mentioned programs.
- CETPA shall issue Authorized & Globally Accepted Training Cobranded Certificates of RPSGOI & CETPA (Powered by TCS) to participants when they will successfully complete their Training Programs.



Rajgopal
Director

RPS Group of Institutions
Balana, Mohindergarh
(Haryana)

Rajgopal
Principal

RPS College of Engg. & Tech
Balana Mohindergarh (HR.)

TERM OF THE AGREEMENT:

This agreement shall be initially valid for a period of 1 year commencing from the date of the agreement that is 21st day of September Two thousand twenty two (21/09/2022) . The term May be extended for further period by mutual consent in writing by the parties.

The parties hereto have set & subscribed their respective hands and seal on the day, month & year herein above mentioned.

AMENDMENT:

Any addition, deletion and/or alternation to this agreement may be effected with a written agreement by both parties to this agreement by mutual consent concerning the amendments. A document containing the additions, deletions and/or alternations, signed by both parties hereto shall form an annexure to and be deemed to be a part of this agreement.

FIRSTPARTY

SECONDPARTY

AGREED:

For Rao Pahlad Singh Group of Institutions


For CETPA InfotechPrivate Limited



Authorized Signatory


Authorized Signatory

Rao Pahlad Singh Group of Institutions	CETPA InfoTech Private Limited
Add: Balana, Satnali Road, Mahendergarh, Haryana 123029	Add: D-58 Sector- 2 Noida Uttar Pradesh 201301
Contact: +91 8053117441	Contact Details: +91 9212468020
Email: director@rpsinstitutions.org	E-Mails: vikaskalra@cetpainfotech.com
Web: www.rpsinstitutions.org	Web: www.cetpainfotech.com


21.09.2022
Dr. Mahesh K. Yadav
(Director)

Rao Pahlad Singh Group of Institutions


Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)


Mr. Vikas Kalra
(Director)
CETPA InfoTech Pvt. Ltd.

3-4-2
CIVIL

CADDESK Rewari (Mrs. Manisha Yadav)

Date:- 22/04/2022

Registered Office- Cad Desk Rewari, SCO 234 Basement,
Sector 5 Market, Near MI Care, Opposite BMG Mall, Rewari,
Haryana-1234-01

Sub: In Campus Training Program on "AutoCAD CIVIL/Arch. & AutoCAD Mechanical" software by CADDESK

Ref: With reference to the above proposal you are hereby authorized to start AutoCAD CIVIL/Arch. & AutoCAD Mechanical training program for CIVIL engineering & Mechanical engineering Students AutoCAD CIVIL/Arch. & AutoCAD Mechanical Software the fees charged shall be as under:

S.NO.	Software (course)	Fee structure (per student)
1	AutoCAD CIVIL/Arch.	3000/-
2	AutoCAD Mechanical	3000/-



Terms of appointment:

1. The student will undergo this training program for developing their skills on AutoCAD CIVIL/Arch. AutoCAD Mechanical
2. The fee decided as above may be charged from the student by any means and no other hidden charges shall be payable.
3. Training shall be conducted at College Campus with mutual understanding.
4. Training programs you will conduct that is compulsory for all Engineering students, other branches students may also join on an optional & interest basis as per batch time in college hours. They have to undertake that program.
5. CADDESK will provide certificate after course completion to the students doing these training.
6. Total Duration of each software shall be 40 hours (2hrs / day) or as per college schedule.
7. Term of payment- Company will get 50% of the total payment before starting the training
8. Payment will be made in favor of CAD DESK Rewari

Manisha Yadav
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)


9. All the concerning Department will keep copy of MOU for the reference,
10. CADDESK will be allowed to conduct technical presentations periodically in the interest of students for their learning of CAD/CAM/CAE software.

This appointment letter is issued for a period of one year from the date of appointment. The term can be reviewed at the time of new training session, at the time of renewal subject to provide satisfactory services to the students.


Thanking You

Yours Faithfully

RPS, Group of Institutions
Balana, Mahendragarh, Haryana


Principal




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



www.caddeskindia.com

“ India's Leading CAD / CAM / CAE Training Company having 170+ Branches Across India ”

TRAINING **PROPOSAL**

To
The Director
RPS Group Of Institutions, Balana
Mahendragarh, Haryana



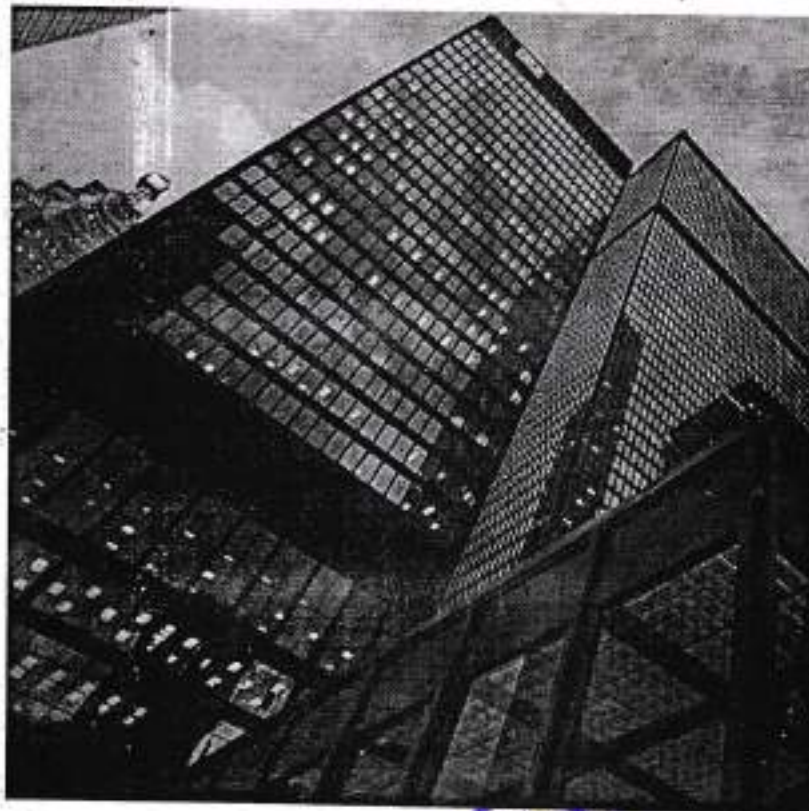
From:
CAD DESK

Branch Office- Cad Desk Rewari, SCO 234 Basement, Sector 5
Market, Near MI Care, Opposite BMG Mall, Rewari, Haryana-1234-01
+91 7027272083

RPS College of Engg. & Tech.
Balana - Mahendragarh

Head Office- First Floor, Pink Tower, Behind SAHARA, Chamber, Lalkothi, Jaipur - +91-7378123123

India's Most Prominent and Trusted Brand in CAD Trainings



CAD DESK is the leading software training institute in India, which offers vast range of courses in the fields of CAD, CAM and CAE. More than 5 lakh students believe in CAD DESK and satisfied with their career growth with CAD DESK.

CAD DESK is the Authorized Training Partner of Autodesk, PTC, Bentley Systems and Dassault Systems. And in a very short span of time, CAD DESK has expanded its network across India and now proudly owns more than 1500 centers throughout the country.

Quality education is our motto and we focus on the overall development of every student and that's why our highly experienced or expert instructors not only deliver the theoretical contents but also put a great emphasis on quality and practical knowledge of each software courses. After completion of the courses, students get a certificate which are completely secure and authorized, and helps them in escalating their career and provides great recognition in the industries.

ABOUT COMPANY



CAD DESK- A unit of Parshi Training & Technical Services Pvt. Ltd. is well-known software training Organization for Engineers, for providing quality education in various field of Engineering (CIVIL, Mechanical and Electrical). We provide professional training in AutoCAD, Revit, Staadpro, E-Tabs, Solidworks, CATIA, Creo, NX-CAD, Ansys AutoCAD Electrical, Automation etc. Currently, these are the largest Job-Oriented courses. With reference to the same, we wish to start training in these field at your college campus. Students from your college may be well placed in Industries, but by getting professional training in these courses, they will definitely get an edge.

We have a long experience in the field of CAD/CAM/CAE as well as in Consultancy. CADDESK is running In campus Training Program at multiple Colleges. We possess 170+ centers in 26 states of India with Head Office Jaipur. We have trained more than 50,000 technocrats/Non-Engineering students in the last 10 years with 100+ College/Corporate Training.

We have a professional team of engineers and technology professionals working with our company through this team we are managing software training in multiple colleges as well as corporate sectors in Himachal Pradesh, Haryana, Punjab, Rajasthan, Gujarat, Andhra Pradesh, Tamilnadu, Karnataka, Bihar, Maharashtra etc. This gave us an encouragement to grow even higher with a faster pace.

These programs are designed after market survey to cover the technologically advanced concepts along with basics to apply fit in the hectic semester schedule and at the nominal cost as well. For the benefit of student fraternity, an Industrial exposures is provided by Technical team. CADDESK provides life time support to the students.


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Balana Mphindergarh (HR.)

THANK YOU



PROPOSED

TRAINING PROGRAM

Quotation for In campus Training

Software/Technology	Branch	Duration	Fees (Rs.) per Student
AutoCAD CIVIL/Arch.	CIVIL Engineering	40 hours	₹ 3000/-
AutoCAD Mechanical	Mechanical Engineering	40 hours	₹ 3000/-

This fee structure is applicable for 30+ Students,

Facilities required at College...

- Seminar Room/Class Room equipped with Projector.
- Microphone & Speaker
- Computer with relevant software.
- Timing of the Class will be decided after proper discussion with college administration.

Other FacilitiesCADDESK will provide

- Technical experts for completion of training.
- Live project to student.
- Reference material and technical know-how.
- Certification.
- Follow-up sessions during the academic Sessions
- All Courses shall be offer in approx. 50% of Market Price.



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Training Features

BENEFITS

STUDNETS



Well Experienced Trainer

Specialized faculties for Every Software
Certified from Software Companies



Study Material

In-house Developed
Books are original for step by step learning
Multi-Color books with Illustrative Examples
Best exercise books for practical Learning



Online Student Portal

Course Details
Certificate Display
E-Books
Placement Notification/JOB Alerts
Digital Safe for Documentation
Regular JOB Updates



Projects/Assignments

Live Projects
Project Based Learning
Project submission after course completion
Practical site/Industry Visit



Quality Training

Course Curriculum as per Industry specification.
Course adhere to day wise schedule.
Uniform Quality across India
Regular Feedback for Training improvement



Lifetime Support


Lifetime Updates/ Revision Facilities
Transfer Facilities across India



We consider it a valuable association for us PTTs Pvt. Ltd. has always been prompt in customer satisfaction and we will like to maintain the same in future.

The proposal has been prepared as per the requirement judged by us. Any modification can be made with mutual concern. You are welcome for any information and queries regarding this proposal.

Our Credentials

 Bentley
STAAD.Pro

SIEMENS


CATIA

CERTIPORT
AUTHORIZED TESTING CENTER


 AUTODESK


SolidWorks

ANSYS

 Microsoft




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TRAINING-PLACEMENT-SOFTWARE-CONSULTANCY



RAO PAHLAD SINGH COLLEGE OF ENGG. & TECH.

Approved by AICTE / Govt. of India & Affiliated to I.G.U., Meerpur

Balana, Mohinderghar, Haryana - 123029

Telephone: 01285-241431 Fax: 241434

E-mail: rpsbalana@gmail.com, Website: www.rpsinstitutions.org

A Report
on

*ELEVATION'S HyperWorks Basic to
Professional Training Program*
Organized by

Department of Civil Engineering,
RPS CET, Balana
Mahendergarh, Haryana
at
The Seminar Hall
(RPSGOI)



On **01 JULY, 2021**
From 10:00 am to 01:00 pm


Principal
R.P.S. College of Engg. & Tech
Balana Mohinderghar (HR.)

A webinar was organized by the Department of civil engineering for its students on 01 July, 2021 from 10:00 am to 01:00 pm in Seminar Hall, RPSGOI Mahendergarh.

Department of Civil Engineering Successfully conducted a Webinar Titled "*ELEVATION'S HyperWorks Basic to Professional Training Program*" which contains training on Altair's Hypermesh, Optistruct & Hyperview Softwares on 01-July-2021.

Purpose: The purpose of the programme was to make the students aware regarding present technology and software in the construction, designing & planning field.

Participants: 43 participants registered and got approval from the Civil Department for participating in the programme. The participants included both - the students as well as teachers.

Mode: The programme was organized through online mode.



M. J. Adas
Principal
R.P.S. College of Engg. & Tech
Balana Mohinder Garh (HR.)


Speaker/Conductor: The Webinar was delivered by **Mr, Apoorv Bapat, Authorised Trainer, Structural Consultant, Founder, ELEATION, Pune.**

Outcome: The students participated actively in the session. They come to know the purpose, need and fruitfulness of the software used in civil engineering. After ending the session, they submitted their feedback orally.

Report is submitted for kind consideration please.

For and on behalf of Civil Department
Rao Pahlad Singh Group of Institutions
Balana, Mahenderharh, Haryana




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergam (HR.)

MEMORANDUM OF UNDERSTANDING
Between
ELEATION
AND
RAO PAHLAD SINGH GROUP OF INSTITUTIONS.

The following terms of service (the "Agreement") will be effective from July 01, 2021

Between: ELEATION

Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan, Pune, Maharashtra – 411021

AND: RAO PAHLAD SINGH GROUP OF INSTITUTIONS

At Balana, 8th Milestone, Satnall-Mahendergarh Road, District Mahendergarh (HARYANA) PIN 123029

General Terms of services for ELEATION:

- ◆ For 2nd Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of Design Engineers"
 - ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial Internship on CREO software with ELEATION.
 - ELEATION will provide Certificate of Training on CREO software.
 - ELEATION will provide Free licensed version software.
 - ELEATION will provide Internship letter, letter of recommendation and experience letter.
 - Based on Students Interests ELEATION will conduct Paid Workshop (online/offline)

- ◆ For 3rd Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of CAE (Simulation / Analysis) Engineers"
 - ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial internship on ANSYS software with ELEATION.
 - ELEATION will provide Certificate of Training on ANSYS software.
 - ELEATION will provide Free licensed version software.
 - ELEATION will provide Internship letter, letter of recommendation and experience letter.
 - Based on Students Interest ELEATION will conduct Paid Workshop (online/offline)

- ◆ For 4th Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELEATION will conduct On-Campus Placement process to recruit / hire students from your college, as CAE Engineers for ELEATION Services Pvt. Ltd.
 - ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of CAE (Simulation / Analysis) Engineers"
 - ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial Internship on ANSYS software with ELEATION.
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Bhavdhan, Pune – Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email : ppoorvbanaji@eleation.com
www.eleation.com

Poorv Banaji



Poorv Banaji
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

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- ❖ For Faculties of Mechanical, Civil, Production and Automobile Engineering.
 - ELEATION will conduct FREE Virtual Faculty Development Program on CAD (CREO) and CAE (ANSYS and HyperWorks Software) for all the faculties.
 - ELEATION will provide Certificate of Faculty Development Program
 - ELEATION will provide Certificate of Training
 - ELEATION will provide Free Licensed Version Software to all the Faculties.

General Terms of services for RAO PAHLAD SINGH GROUP OF INSTITUTIONS:

- College will provide faculty / Coordinator to organize expert lecture of 2nd, 3rd and 4th Year students
- College will provide faculty / Coordinator to organize Internship drive for 2nd, 3rd and 4th Year students.
- College will provide faculty / Coordinator to organize on-campus Placement process for 4th Year students.

Notes:

- For Expert Lecture neither college nor ELEATION will charge any fees from Students.
- To organize expert lecture, Internship drive and on-campus placement drive, college will share concern faculty / coordinator Name, Email ID, Mobile number and designation with ELEATION via Email.
- Paid workshop will only be organized based on student's interest after the Guest lecture conducted by ELEATION.
- Fees of Paid workshop will be decided by ELEATION and College and then Informed to students.
- Fees of Paid workshop will be collected either by College or ELEATION based on mutual understanding.
- For organizing paid workshop ELEATION will share 10% of total collected fees with college.
- For Placement in ELEATION Company as CAE Engineer neither ELEATION nor college will charge any fees from Students.
- The term of MOU is for 4 Years from the date of executing the MOU.
- After 4 Years College and ELEATION will sign new MOU.
- ELEATION will attend (if needed) any government body meetings in college (Physically / virtually), required for College level accreditation by Government bodies.
- To terminate this service of Agreement, College and/or ELEATION has to send official mail to concern person responsible for the MOU.
- College can use ELEATION logo for any (marketing) activities.
- While using ELEATION logo for any (marketing) activities, college has to Inform ELEATION via send a mail to official email ID of ELEATION mentioned on this service agreement.

To,
ELEATION,
Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan,
Pune - Maharashtra
411021

For and on Behalf of ELEATION



Signature and Seal

Name: Apoorv Bapat
Designation: CEO and Founder

Office Number 9, 3rd Floor, Pentium Residency,
Bhavdhan, Pune - Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email: apoorvbapat@eleation.com
www.eleation.com

Handwritten signature



Handwritten signature
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Mobile Number: 7720040021 / 7387403493
Official Email ID: apoorvbapat@eleation.com

To,
RAO PAHLAD SINGH GROUP OF INSTITUTIONS
At Balana, 8th Milestone, Satnali-Mohindergarh Road, District Mohindergarh (HARYANA) PIN 123029

For and on Behalf of Rao Pahlad Singh Group Of Institutions

K. Yadav

Director

Signature / Seal R.P.S Group of Institutions
Balana, Mohindergarh
(Haryana)

Name: Dr. Mahesh K Yadav

Designation: Director

Mobile Number: 8053117441

Official Email ID: principal@rpsinstitutions.org



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Bhavdhan, Pune - Maharashtra - 411021
Mob: 7720040021 / 7387403493
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K. Yadav
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R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR)



Certificate of Training

ELEATION'S HyperWorks

BASIC TO PROFESSIONAL TRAINING PROGRAM

Course Duration 60 Days Center Online

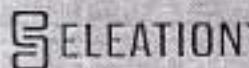
This is to Certify that

ANKIT

has Successfully Completed ELEATION'S HyperWorks Basic to Professional Training Program, which contains training on Altair's Hypermesh, Optistruct & Hyperview Software's. Also Successfully Completed & Submitted the practice models, assignments & tutorials.

Congratulations, you have scored 400 / 400.

Signed by



Training Certificate No. ESA_HW_105741

Date 1st Jan 2022

support@eleation.com, hr@eleation.com
www.eleation.com

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Balana Mohindergam (HR.)



Certificate of Training

ELEATION'S ANSYS

BASIC TO PROFESSIONAL TRAINING PROGRAM

Course Duration 60 Days Center Online

This is to Certify that

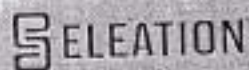
ANKIT

has Successfully Completed ELEATION'S ANSYS Basic to Professional Training Program, which contains training on ANSYS-Workbench Mechanical, Design Modeler, Fluent Software's.

Also Successfully Completed & Submitted the practice models, assignments & tutorials.

Congratulations, you have scored 325 / 325.

Signed by



Training Certificate No. ESA_AN_105741

Date 1st Jan 2022

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www.eleation.com

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Certificate of Training

ELEATION'S ANSYS

BASIC TO PROFESSIONAL TRAINING PROGRAM

Course Duration 60 Days Center Offline

This is to Certify that

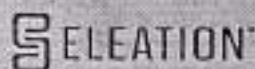
NIRAJ KUMAR

has Successfully Completed **ELEATION'S ANSYS Basic to Professional Training Program**, which contains training on ANSYS-Workbench Mechanical, Design Modeler, Fluent Software's.

Also Successfully Completed & Submitted the practice models, assignments & tutorials.

Congratulations, you have scored 253 / 325.

Signed by



Training Certificate No. ESA AN 86809

Date 1st Jun 2021

support@eleation.com, hr@eleation.com
www.eleation.com

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TRAINING & PLACEMENT RPS GROUP OF INSTITUTIONS

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he Day.....

S Group of Institutions, Balana takes this opportunity to invite you to participate in the Campus Placement
r : CAE Project Engineer with CTC : INR 4.2 Lakhs per annum.

online test on : Date : 01-12-2021

ELPL125

All students visit below YouTube link containing Pre-placement talk video, in which company has explained the
: <https://youtube.com/z-APXVeyvjs>

acement online test there are total 50 questions, out of which 20 questions are from pre-placement talk video.
to watch the complete video.

can follow the process mentioned in the below link to register for Pre-Placement Online Test :
election.com/on-campus_placement_2022/student/How_to_register_for_Pre-placement_online_test.pdf

can follow the process mentioned in the below link to attend Pre-Placement online test :

election.com/on-campus_placement_2022/student/How_to_Give_Pre-placement_online_test.pdf

ement online test duration is 60 minutes, Students can give Pre-Placement online anytime from 10 AM to 5 PM


links :

ON Company : https://election.com/on-campus_placement_2022/student/Company_profile.pdf

on-campus Placement Complete Process : https://election.com/on-campus_placement_2022/student/Complete

https://election.com/on-campus_placement_2022/student/What_is_CAE.pdf

https://election.com/on-campus_placement_2022/student/Job_description.pdf


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and Answers : [https://elevation.com//on-campus_placement_2022/student/General Questions & Answers](https://elevation.com//on-campus_placement_2022/student/General_Questions_&_Answers)

and HyperWorks Training Program : [https://elevation.com//on-campus_placement_2022/student/about ANSYS HyperWorks Training program.pdf](https://elevation.com//on-campus_placement_2022/student/about_ANSYS_HyperWorks_Training_program.pdf)

ANSYS and HyperWorks Training Program : [https://elevation.com//on-campus_placement_2022/student/How to start ANSYS & HyperWorks Training.pdf](https://elevation.com//on-campus_placement_2022/student/How_to_start_ANSYS_&_HyperWorks_Training.pdf)

for Final On-Campus Placement process : [https://elevation.com//on-campus_placement_2022/student/How to register for Final Placement process.pdf](https://elevation.com//on-campus_placement_2022/student/How_to_register_for_Final_Placement_process.pdf)

Give a call if you have any query

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Balana Mohindergarh (HR.)

Sr. No.	Name	College Name	Year	Branch	Pre-Placement test Score	ANSYS Training Program	HyperWorks Training Program	No. of Sessions completed in ANSYS Training Program	No. of Sessions completed in HyperWorks Training Program	HyperWorks Training certificate downloaded	HyperWorks Internship letter downloaded	ANSYS Training Certificate Downloaded	ANSYS Internship letter downloaded	Solution Report or 100 marks submitted
1	ANKIT	RAO FAHLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	100	selected for free training program	selected for free training program	Completed the Training Program	Completed the Training Program	Downloaded the Training Certificate	0	Downloaded the Training Certificate	0	No
2	May Kumar	RAO FAHLAD SINGH GROUP OF INSTITUTIONS	4th Year	Civil	100	selected for free training program	selected for free training program	Completed the Training Program	1	0	0	Downloaded the Training Certificate	0	No
3	paakj kumar	RAO FAHLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	100	selected for free training program	selected for free training program	1	1	0	0	0	0	No
4	ISHSH	RAO FAHLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	98	selected for free training program	selected for free training program	1	1	0	0	0	0	No
5	KESHAV KUMAR	RAO FAHLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	96	selected for free training program	selected for free training program	5	1	0	0	0	0	No



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Principal
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Balana Mohindergarh (HR.)

S. No.	Name	College Name	Year	Branch	Pre-Placement Test Score	AESTS Training Program	HyperMark Training Program
1	Wing Kumar	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Civil	100	selected for free training program	selected for free training program
2	Sanjay Kumar	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	100	selected for free training program	selected for free training program
3	ANKIT	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	100	selected for free training program	selected for free training program
4	ANISH	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	88	selected for free training program	selected for free training program
5	ADITHYAN KUMAR	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	80	selected for free training program	selected for free training program
6	Shravan Gupta	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	84	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
7	Harsh	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	80	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
8	Adar	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	80	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
9	Harshdeep	RAO PARLAD SINGH GROUP OF INSTITUTIONS	3rd Year	Mechanical	80	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
10	Ansh Kumar	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	86	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
11	Tejaswar	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	86	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
12	Aditya	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	88	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
13	Tejaswini Kumar	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Civil	84	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
14	Pranav	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Civil	84	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
15	Parul	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Civil	84	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
16	Sourav	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Civil	76	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
17	Arshvi	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Civil	70	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
18	Arshvi Arshvi	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Civil	66	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
19	Sachin Kumar	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	54	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION
20	Rishabh	RAO PARLAD SINGH GROUP OF INSTITUTIONS	4th Year	Mechanical	0	Can Pay the Course fees and Join Training and Internship Program of ELECTION	Can Pay the Course fees and Join Training and Internship Program of ELECTION


 Principal
 R.P.S. College of Engg. & Tech
 Balana Mohindergam (HR.)

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Mob: 7720040021 / 7387403493
Email : apoorvbapat@eleation.com
www.eleation.com

Ajaypatil



Ajaypatil
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

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- o Based on Students interest ELEATION will conduct Paid Workshop (online/offline)
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- College will provide faculty / Coordinator to organize expert lecture of 2nd, 3rd and 4th Year students
- College will provide faculty / Coordinator to organize internship drive for 2nd, 3rd and 4th Year students.
- College will provide faculty / Coordinator to organize on-campus Placement process for 4th Year students.

Notes :

- ↓ For Expert Lecture neither college nor ELEATION will charge any fees from Students.
- ↓ To organize expert lecture, internship drive and on-campus placement drive, college will share concern faculty / coordinator Name, Email ID, Mobile number and designation with ELEATION via Email.
- ↓ Paid workshop will only be organized based on student's interest after the Guest lecture conducted by ELEATION.
- ↓ Fees of Paid workshop will be decided by ELEATION and College and then informed to students.
- ↓ Fees of Paid workshop will be collected either by College or ELEATION based on mutual understanding.
- ↓ For organizing paid workshop ELEATION will share 10% of total collected fees with college.
- ↓ For Placement in ELEATION Company as CAE Engineer neither ELEATION nor college will charge any fees from Students.
- ↓ The term of MOU is for 4 Years from the date of executing the MOU.
- ↓ After 4 Years College and ELEATION will sign new MOU.
- ↓ ELEATION will attend (if needed) any government body meetings in college (Physically / virtually), required for College level accreditation by Government bodies.
- ↓ To terminate this service of Agreement, College and/or ELEATION has to send official mail to concern person responsible for the MOU.
- ↓ College can use ELEATION logo for any (marketing) activities.
- ↓ While using ELEATION logo for any (marketing) activities, college has to inform ELEATION via send a mail to official email ID of ELEATION mentioned on this service agreement.

To,
ELEATION,
Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan,
Pune – Maharashtra
411021
For and on Behalf of ELEATION



Signature and Seal

Name: Apoorv Bapat
Designation: CEO and Founder

Office Number 9, 3rd Floor, Pentium Residency,
Bhavdhan, Pune – Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email : apoorvbapat@eleation.com
www.eleation.com

Apoorv Bapat



M. S. Yadav
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Mobile Number: 7720040021 / 7387403493
Official Email ID: apoorvbapat@eleation.com

To,
RAO PAHLAD SINGH GROUP OF INSTITUTIONS
At Balana, 8th Milestone, Satnali-Mohendergarh Road, District Mahendergarh (HARYANA) PIN 123029

For and on Behalf of Rao Pahlad Singh Group Of Institutions

Mahesh K Yadav

Director

Signature / Seal

R.P.S Group of Institutions
Balana, Mohindergarh

Name: Dr. Mahesh K Yadav (Haryana)

Designation: Director

Mobile Number: 8053117441

Official Email ID: principal@rpsinstitutions.org






Mahesh K Yadav

Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

3 attachments

-  **General Questions and Answers.pdf**
521K
-  **How to Register and Attend the ELEATION's Internship Online test.pdf**
1349K
-  **How to Start Virtual (online) Training and Internship Program.pdf**
1640K

Training & Placement at RPSGOI <placement@rpsinstitutions.org>

Sat, Jun 19, 2021 at 2:07 PM

To: Rajendra S Yadav <hod_mech@rpsinstitutions.org>, Rajendra Singh <hod_civil@rpsinstitutions.org>

Cc: Chairman RPS <chairman@rpsinstitutions.org>, Mahesh Yadav <director@rpsinstitutions.org>, Devendra Yadav <registrar@rpsinstitutions.org>

Dear Sir, In addition to the Attachments of Trailing Mail Please share the other 02 Attachments with the students. Rest all the procedure remains same.

Thanks & Regards. ✍

Satyavir Sharma

Assistant Registrar/Head-T&P and CDC(I/C)
RPS Group of Institutions | At: BALANA, Dist.: Mahendergarh, Haryana, INDIA

Email: placement@rpsinstitutions.orgWebsite: www.rpsinstitutions.org

Phone: 01285-241431/

<https://www.linkedin.com/in/satyavir-sharma>[Quoted in original message]

2 attachments

-  **Expert Lecturer Profile.pdf**
436K
-  **Process to Download Certificate of attendance.pdf**
1041K


Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)

Training & Placement at RPSGOI <placement@rpsinstitutions.org>

Sat, Jun 19, 2021 at 2:20 PM

Cc: Rajendra S Yadav <hod_mech@rpsinstitutions.org>, Rajendra Singh <hod_civil@rpsinstitutions.org>, Mahesh Yadav <director@rpsinstitutions.org>, Devendra Yadav <registrar@rpsinstitutions.org>, Chairman RPS <chairman@rpsinstitutions.org>

Dear students,
Greetings of the Day!

Expert Session on CAE (Computer Aided Engineering) by Mr. Apporav Bapat CEO of ELEATION for 2nd/3rd Year Students of Mech & Civil Engineering Students.

During this session, the following topics will be covered:-

- ❖ About ELEATION.
- ❖ What is CAE – Computer Aided Engineer?
- ❖ What is FEM/FEA?
- ❖ Industry need of CAE Engineering's
- ❖ Future scope of CAE
- ❖ Why to learn CAE software.

Date : 01-07-2021

Time : 10:00 AM to 11:00 AM



Please share the below Google Meeting link with all the students of 2nd and 3rd Year students from Mechanical, Civil, Production and Automobile Engineering, so that they can attend the expert lecture.

For that, please find the Google Meet Link to ensure the maximum Attendance . :

meet.google.com/ztz-mzuv-bkc

Please share the attached PDF, containing details regarding:

- Profile of Expert lecturer – Mr. Apoorv Bapat.
- Process to download certificate of attendance.


Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (H.R.)


Please follow the below process to download certificate of attendance of expert lecture :


1. Open www.elevation.com
2. Click on signup (if you are a new user) / login (if you are an existing user) on ELEVATION's website.
3. On ELEVATION's Dashboard page – Click on College Test Button
4. Click on ELEVATION's Training and Internship Button
5. Click on Register
6. Enter College Code : ELPL2007
7. Enter College Name, Degree, Branch, Semester – then click on Register
8. Once you complete the registration Click on "Click here to download the attendance certificate for attending online(live) expert lecture" button to download certificate of attendance.

Please ensure the Maximum Participation, Also to forward this email message to your classmates (ONLY RPS COLLEGE STUDENTS) whose Email Id is not registered with us.

[Quoted text hidden]

2 attachments

 Process to Download Certificate of attendance.pdf
1041K

 Expert Lecturer Profile.pdf
436K



SANDEEP YADAV <hod_civil@rpsinstitutions.org>
To: Gajanand Sharma <hod_mech@rpsinstitutions.org>

Fri, Feb 11, 2022 at 10:58 AM

----- Forwarded message -----

From: Training & Placement at RPSGOI <placement@rpsinstitutions.org>

Date: Sat, Jun 19, 2021 at 2:20 PM

Subject: Expert Lecture on CAE for 2nd/3rd Year Students of Mech & Civil Engineering Students: Complete Process : RPS Group of Institutions

To:


[Quoted text hidden]


[Quoted text hidden]


R.P.S. College of Engg. & Tech.
Balana Mohindergarh (HR.)

Mr. Sandeep Yadav
Assistant Professor & Head
Department of Civil Engineering
RPSGOI, Balana

2 attachments

 Process to Download Certificate of attendance.pdf
1041K

 Expert Lecturer Profile.pdf
436K




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

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**MEMORANDUM OF UNDERSTANDING
FOR
INSTITUTIONAL COLLABORATION**

BETWEEN

RPS GROUP OF INSTITUTIONS

AND

**CSIR-CENTRAL ELECTRONICS ENGINEERING RESEARCH
INSTITUTE (CSIR-CEERI)**



M. K. Singh
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



**MEMORANDUM OF UNDERSTANDING FOR INSTITUTIONAL
COLLABORATION**

BETWEEN

RPS GROUP OF INSTITUTIONS


AND

**CSIR-CENTRAL ELECTRONICS ENGINEERING RESEARCH
INSTITUTE (CSIR-CEERI)**



This **Memorandum of Understanding** (hereinafter referred to as "**MoU**") entered into on this **20th day of July 2021** by and between:

RPS Group of Institutions (hereinafter referred to as "**RPS-GOI**") is a premier institute in South Haryana, with its main campus in Balana, Satnali Road, Mahendragarh-123029 (Haryana). The Institute, which was founded in 2008, provides B.Tech. courses in Computer Science & Engineering, Mechanical Engineering, Information Technology, and Electronics & Communication Engineering. RPS Institute of Management, which offers MBA, BBA, and BCA degrees, was founded in 2010. Both institutes were merged and renamed RPS Group of Institutions in 2011. (Engineering & Management). The B.Tech. programme in Civil Engineering was launched in 2011. The institute began offering an MTech. programme in Computer Science & Engineering in 2012. In 2013, the institute launched the Electrical Engineering B.Tech. programme, as well as MTech. programmes in Electronics and Communication Engineering and Mechanical Engineering. RPS Polytechnic College was established in 2015, offering Engineering Diploma in Mechanical and Civil branches. RPS Group currently offers B.Tech. programmes in CSE, ECE, ME, Civil, and EE branches, as well as MTech. programmes in CSE, ECE, and ME, as well as full-time MBA, BBA, and BCA programmes, and a Polytechnic Diploma in Engineering in Civil and Mechanical Engg.


Principal
R.P.S. College of Engg. & Tech
Balana Mahendergarh (HR.)

AND

CSIR-Central Electronics Engineering Research Institute, (hereinafter referred to as "CSIR-CEERI") established in 1953, is a constituent establishment of the **Council of Scientific and Industrial Research (CSIR), New Delhi**, having its campus and administrative office in Pilani – 333 031, Rajasthan, India. It is devoted to R&D activities in the following areas: (1) Advanced Electronic Systems: Image processing and DSP, Internet of Things (IoT), Embedded System Design, Electronic Instrumentation, Industrial Control & Automation, Power Electronics, Robotics, VLSI Design (Digital, Analog, Mixed Signal), etc.; (2) Advanced Semiconductor Electronics: MEMS, Micro-sensors, Opto-electronic Technologies, Photonic Devices and Sub-systems, Nano-electronics, LTCC and Advanced Packaging technologies, etc.; (3) Microwave Tubes: Klystron, Magnetron, Travelling Wave Tubes, Gyrotron, Plasma Tubes, Tera Hertz devices etc. CSIR-CEERI also has Centers at Chennai, Delhi and Jaipur.

Collectively hereinafter referred to as institutions

This MoU is based on the principal of reciprocity and expresses the interest of both institutions in exchanging scholars, students, academics information and materials in the belief that the research and educational process at both institutions will be enhanced and that mutual understanding between their respective scholars and students will be increased by the establishment of such exchange programs as per CSIR Guidelines.

1. The institutions agree to encourage the development of the following exchange programs based on their respective academic and educational needs:

- Submission of joint research project proposals to funding agencies
- Joint collaboration with international institutes/Universities
- Exchange of scientific staff
- Exchange of students (undergraduate and / or graduate)
- Joint supervision of B. Tech, MTech., M.S. and Ph.D. students
- Exchange of academic information and materials
- Organization of joint research courses
- Organization of joint conferences
- Organization of other academic exchanges agreeable to both institutions
- Use of laboratory facilities on mutually agreed terms and conditions


Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Areas to start this collaboration are listed in Annexure 1. Both the institutions can revisit this list after mutual consultation. The above activities shall be undertaken as per CSIR guidelines.

2. The parties recognize that the implementation of any exchange program will depend upon the academic interests and expertise of individual staff members and upon the availability of financial resources. Accordingly, the implementation of each exchange program based on this agreement shall be separately examined and determined by both institutions. The institutions shall enter into separate agreements regarding the individual exchange programs.
3. Faculty/ Scientists of either of the institute initiating collaborative work will take care of the usage of their institute resources and conduction of activities as per institute norms. Dr. Mahesh Kumar Yadav, Professor, Department of Electronics Engineering, and Director **RPS-GOI**, shall be the Coordinator of the CSIR-CEERI &RPS-GOI, Collaboration and will coordinate with a scientist from CSIR-CEERI for the implementation of this initiative.
4. Each institution will adhere to the intellectual laws of India. Intellectual property developed during the visit of an exchange student/researcher/faculty/staff will be governed by the rules of the host institute unless otherwise specified. The two institutions shall jointly own results of clearly defined collaborative projects and exchange programs. This joint ownership also entitles each party to explore commercialization. However, transfer of jointly developed technology and associated sharing of revenue shall be governed by a separate agreement. The cost of IP filing will be equally shared by both Institutions.

Furthermore, if one institution receives any information from the partner under a clearly defined non-disclosure agreement, necessary and reasonable care will be taken to protect the intellectual property received.

5. This MoU is not intended to be a legally binding document. It is meant to describe the nature and to suggest the guidelines of the cooperation described above. Nothing therefore shall diminish the full autonomy of either institution, nor will any constraints be imposed by either upon the other in carrying out the agreement. Any disputes shall be resolved through mutual discussion between the highest officials of the respective institutions.


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

6. Any addition, deletion and /or alteration to this MoU may be effected by writing. A document containing the additions, deletions and /or alterations, and signed by all Parties hereto, shall form an annexure to and be deemed to be a part of this MoU.

7. The agreement shall become effective on the day representatives of both institutions affix their signatures and seals, will be in force for a period of 5 years, and is subject to revision or modification by mutual agreement. It is also understood that either institution may terminate the agreement at any time, although it is assumed that such action would only be taken after mutual consultation at least six months in advance in order to avoid any possible inconvenience to the other institution.



[Handwritten Signature]
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Annexure 1

MoU between RPS Group of Institution, Mahendragarh and CSIR-CEERI

Areas from RPS-GOI (but not limited to)	Areas from CSIR-CEERI (but not limited to)
<ol style="list-style-type: none">1. VLSI Design and CAD2. Machine Learning3. Sensor Design4. Imaging and Multimedia5. IoT and Smart Embedded systems	<ol style="list-style-type: none">1. ASIC Design, Post silicon validation, Embedded Systems and Real Time Embedded and IoT Applications2. Semiconductor processing technologies3. MEMS and Microfluidics based Sensor's design, fabrication and characterization4. Nano-sensors, Nano-devices and Advanced Packaging5. GaN-based Optoelectronic Devices and Photonics Crystal based Structures and Devices6. RF MEMS based Switches, Filters and Devices7. Computer Vision, Machine Learning and Artificial Intelligence Algorithms8. Signal Processing9. Instrumentation & Optimization Techniques10. IoT Technology and systems11. Cyber Physical Systems12. Power Electronics13. Microwave Devices

CSIR-CEERI, has expertise in semiconductor processes, device design and fabrication with state-of-the-art facilities and is planning to offer short duration training on same under Semiconductor High-Impact Learning Programme (SHILP) initiative. In UG/ PG/ PhD programs RPS-GOI offers Electronics courses with semiconductor, CMOS, VLSI Design and related fields as their constituents. Students from RPS-GOI, shall visit CSIR-CEERI to get a practical understanding of Semiconductor Design & Fabrication processes. This may be included, as part of their curriculum where students from each affiliated college shall get an opportunity to visit and execute semiconductor labs related training at CSIR-CEERI, as per CSIR Guidelines **on chargeable basis**. CSIR-CEERI shall demonstrate following to the students:

- Demonstration of Semiconductor Unit processes
- Unit process integration, to realize a devices/ device structure
- Unit Process Characterizations and
- Device characterization

CSIR-CEERI would offer a bouquet of programs with duration varying from one week to one month for UG and PG students of affiliated/ constituent institutes of RPS-GOI. A calendar of the courses and programs would be made available to the institutes. RPS-GOI, will proliferate it and motivate the target students to take maximum advantage of these facilities.

UG, PG and PhD students enrolled at RPS-GOI would be exposed to the facilities at CSIR-CEERI, in order to take suitable topics of their curriculum/ research where they can harness the facilities of CSIR-CEERI.

Under various schemes, RPS-GOI and CSIR-CEERI would coordinate joint Faculty Development Programs for the engineering teachers.


Principal
R.P.S. College of Engg. & Tech. of 7
Balana Mchindergarh (HR.)



AatmaNirbharBharat Abhiyan



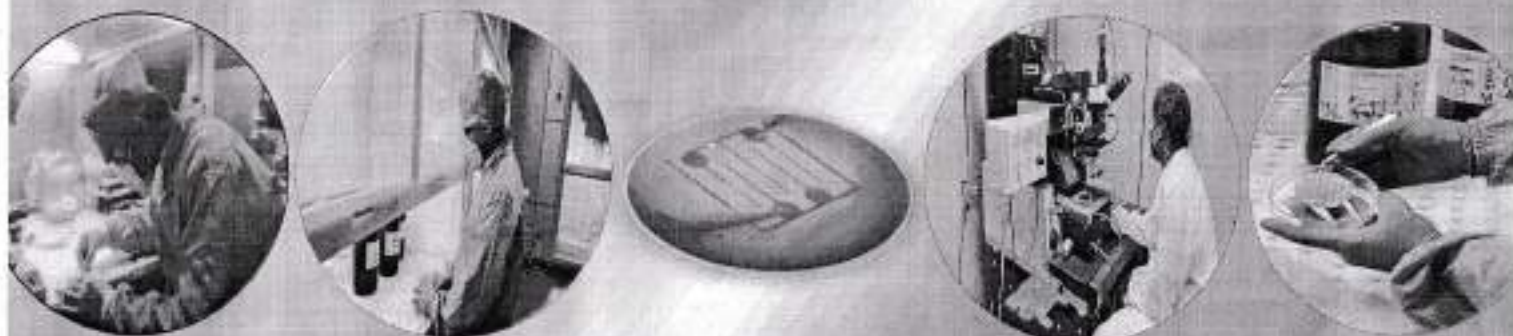
SHILP

Semiconductor High-Impact Learning Programme

Aims to Create Semiconductor Engineers

CSIR-CEERI, welcomes graduate students to enter into the world of semiconductors for a self-reliant India

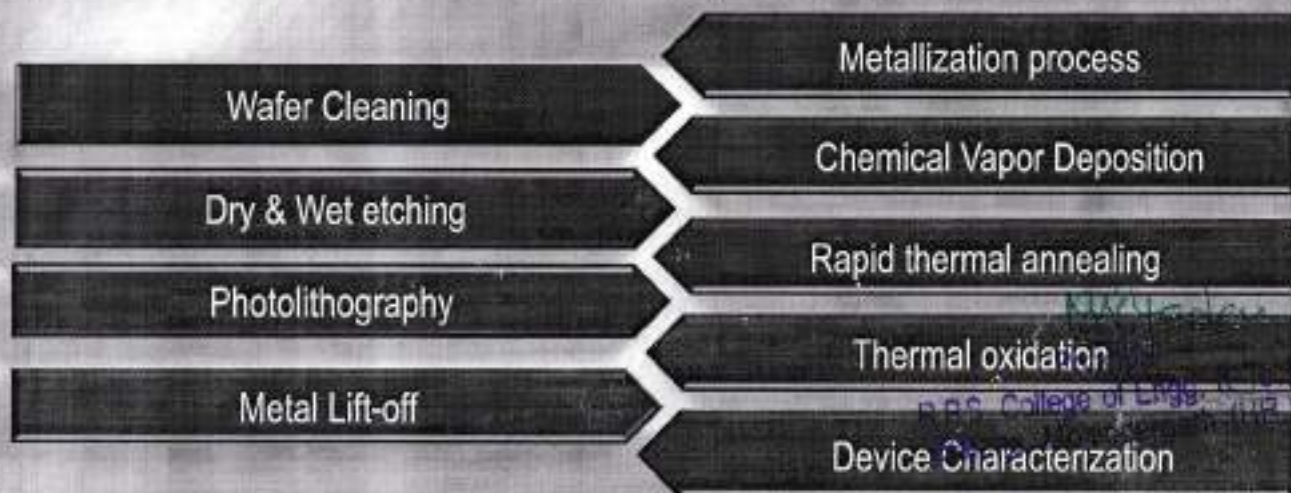
High-Impact learning program on semiconductor processing, device fabrication and characterization



Two-week program to be conducted throughout the year with primary focus on B. Tech/M. Tech students



Practical sessions on



Skill Development Unit



Semiconductor High-Impact Learning Program Aims to Create Semiconductor Engineers

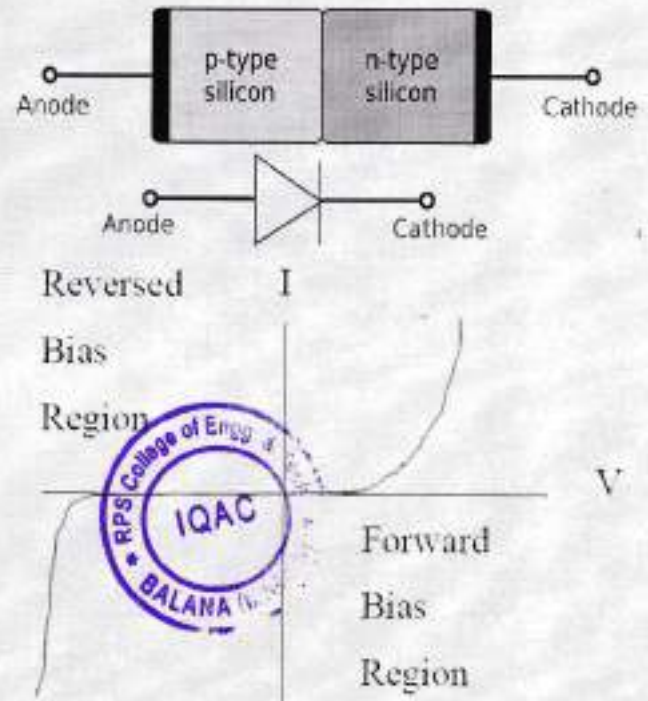
CSIR-CEERI welcomes Graduate students to enter into the world of semiconductors for self-reliant India.

Semiconductor High Impact Learning Program (SHILP)

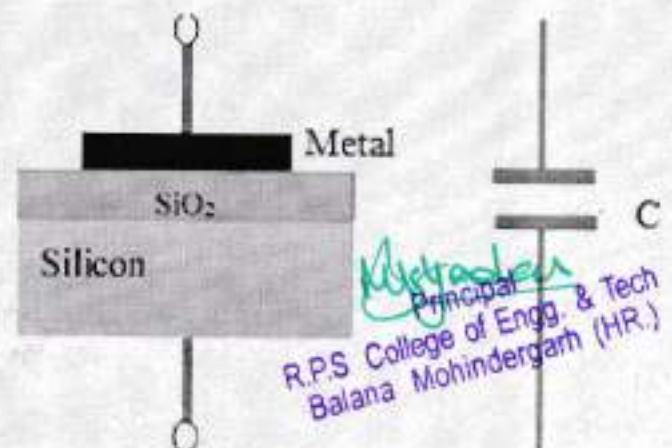
Introduction: As per present global market requirements of human resources, the technical skills and hands-on experience are necessities to implementation of theoretical studies of science and engineering to the real world. Practical exposure along with the theory gives a better opportunity for higher growth of carrier with new directions and a better understanding of that subject. CSIR-Central Electronics Engineering Research Institute is a pioneer government institute, which works in a wide area of electronics. This institute has a dedicated fabrication line of semiconductor devices, where end-to-end devices can be developed with help of highly sophisticated and costly process facilities/equipment. CSIR - CEERI launched Semiconductor High Impact Learning Program (SHILP) for undergraduate students. This is a hands-on training program for the practical exposure of semiconductor device fabrication process steps. The program duration is two weeks. During this, the complete proto-type devices like the P-N Junction diode and MOS capacitor fabrication and characterization will be carried out by an expert technical team.

Program Objective: Fabrication of P-N junction diode and MOS capacitor structure on Silicon, with Hands on training.

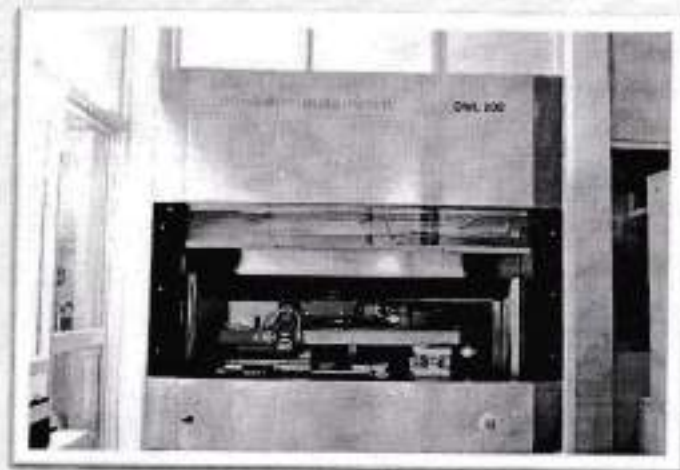
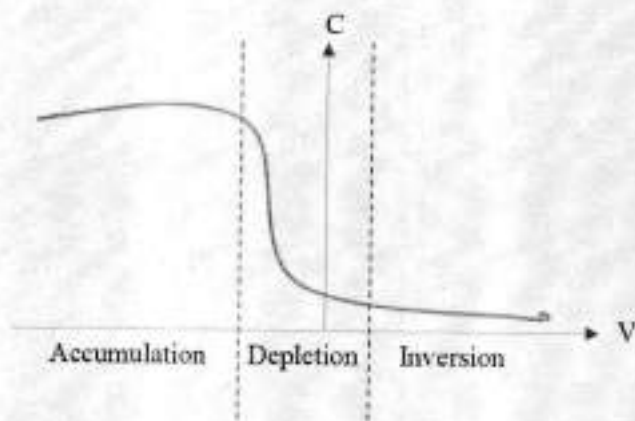
P-N Junction: A p-n junction is an interface between two semiconductor material types, namely the p-type and the n-type, inside a bulk semiconductor. The "p" side contains an excess of holes, while the "n" side contains an excess of electrons in the outer shells of the electrically neutral atoms. This allows electrical current to pass through the junction only in one direction. The p-n junction is created by doping technique in the bulk semiconductor substrate. These junctions are fundamental to the performance of function such as rectification and switching in electronic circuits, light emission in LEDs, energy conversion in a solar cell.



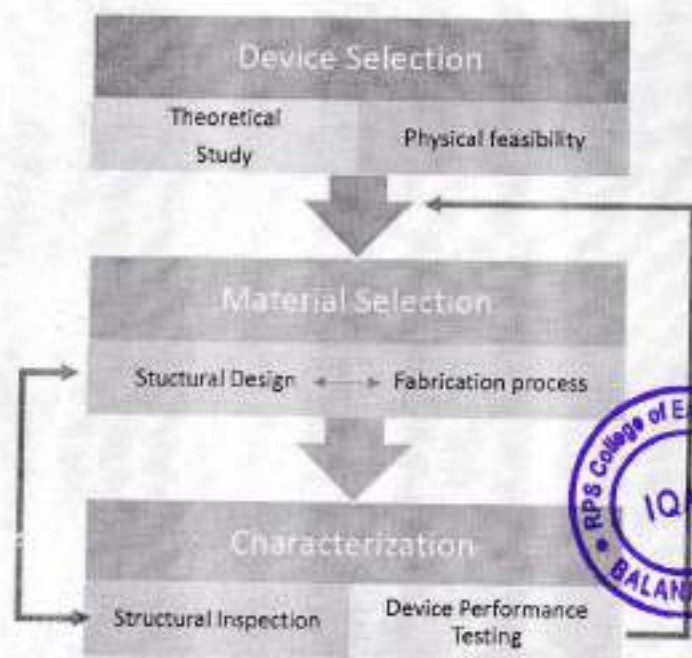
MOS Capacitor: MOS stands for **meta-oxide-semiconductor**. An MOS capacitor is made of a **semiconductor body** or substrate, an **insulator film**, such as SiO₂, and a **metal electrode** called a gate. The MOS capacitor is not a widely used device in itself. However, it is part of the MOS transistor. An MOS transistor is an MOS capacitor with PN junctions at two ends. The capacitance of the MOS capacitor depends upon the voltage applied on the gate terminal. Usually, the body is grounded when the gate voltage is applied.



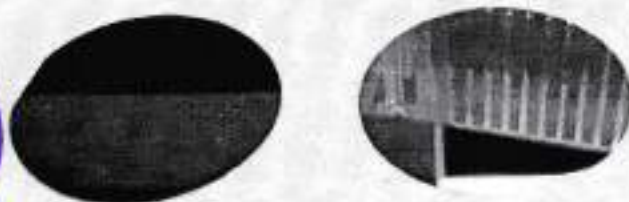
K. V. Prasad
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



Devices Fabrication Flow:



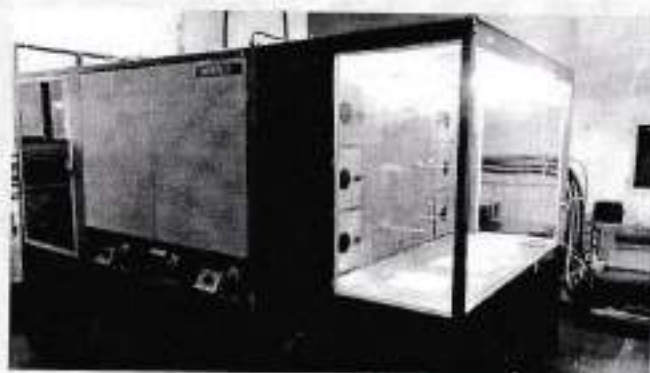
- 2.. **Silicon Wafer:** A wafer is a thin slice of semiconductor material, such as a silicon crystal, used in the fabrication of integrated circuits and other microdevices. Usually, this is also known as a substrate in the semiconductor devices fabrication line. 2 inches, 250-280 μm thick, 1-10 $\Omega\text{-cm}$, Single side polished, <100>, a single crystal silicon wafer is required under this program-SHILP.



3. **Glassware and Substrate handling tools:** Specialized tool is required to carrying and holding the wafers during the fabrication process, as glass beaker, Teflon beaker, wafer carrier boat, special tweezers, boat holding hook, filter papers, lint-free paper/cloth, Desiccator, etc.

Material and facilities required:

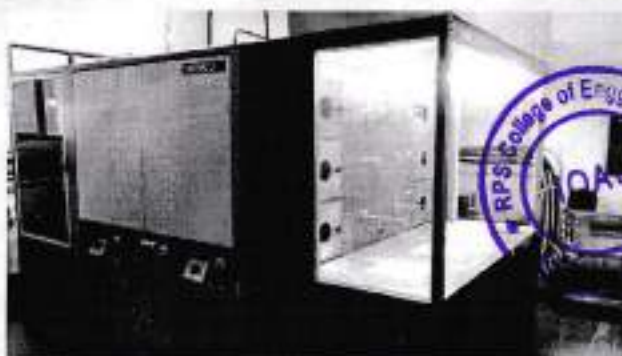
1. **Mask Making Facility and Photo Mask:** A photomask is a "master template" of a semiconductor device fabrication, which is a glass plate with a combination of opaque and transparencies, that allows the light in a defined pattern. They are commonly used in the photolithography process during device fabrication flow. The design and fabrication of a mask is the most expensive step in device fabrication. In the Mask making facility, the unpatterned, photoresist & chrome coated glass plate is exposed using a laser as per the computer designed pattern. therefore, this facility is also known as Laser Pattern Generator. CSIR-CERRI, Pilani has "Heidelberg Instrument's DWL 200" LPG system since 2004. 3 X3 x 0.06 in³ Patterned Mask are required in SHILP.



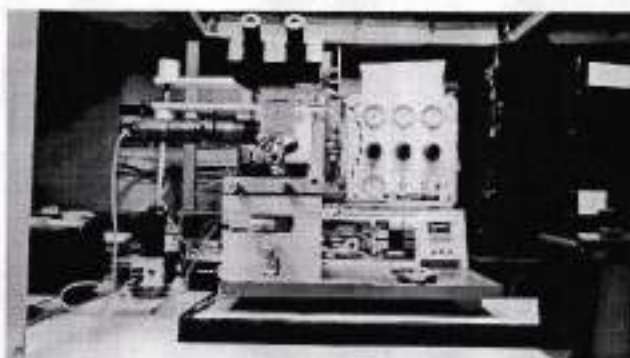
4. **Chemistry facility:** chemistry is most frequently used place in the fabrication process, where all types of cleaning such as glassware cleaning, wafer cleaning, mask cleaning, and wet etching processes are carried out.

5. **Oxidation facility:** In semiconductor device fabrication, thermal oxidation is a way to grow a thin layer of oxide on the silicon surface. A layer of silicon dioxide (SiO_2) on a chip is multipurpose, as masking, isolation, passivation, Gate oxide in MOS, and insulation. Oxidation is the preliminary base process in Si-Semiconductor device fabrication. The oxidation facility is used to growth of Silicon di-oxide (SiO_2) on silicon wafers using Dry or Wet or a combination of both techniques.

6. **Diffusion facility:** Diffusion is also one of the critical processes in devices fab line by which the electrical properties of the substrate can be altered as per application. This facility is used for P/N type doping into a silicon substrate. CEERI has Thermo Furnaces for thermal oxidation and diffusion processes.

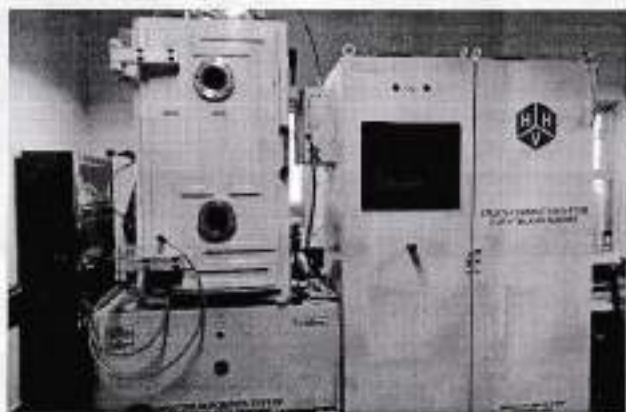


7. **Photolithography facility:** Lithography is the process of transferring the patterns of geometric shapes on a mask to a thin layer of photosensitive material (called photoresist), which cover the surface of the substrate. Mainly this process is done by the exposure of the resist through the mask, using UV source.

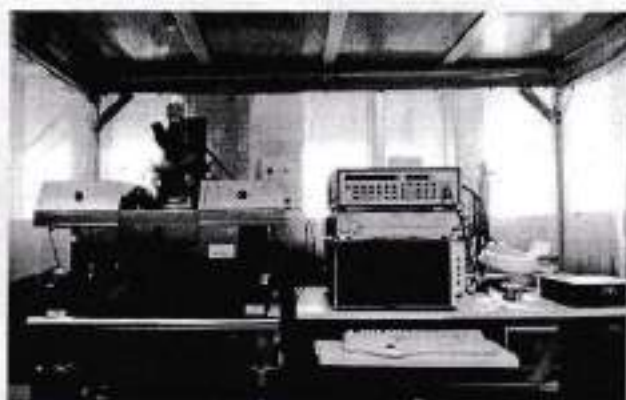


8. **Metallization facility:** metallic layers that are used to make the interconnections between the various fabricated components. There are several

methods for the preparation of thin films and multilayer, such as Physical Vapour Deposition, Chemical vapour deposition, Electroplating.



9. **Characterization facility:** Characterization is a literary device that is used step-by-step to highlight and explain the details about a character of the object. Usually, two types of characterization are performed in semiconductor device fabrication, i.) process characterization, Like; Microscopy, Spectroscopy, and Macroscopic techniques, which help to increase the different degrees of understanding of materials properties and behaviors ii.) Device characterization, Mainly; I-V, C-V in case of a diode and MOS structure analysis.



The two-week SHILP program includes the day-wise lectures on various facilities and complete fabrication & characterization of PN Junction Diode and MOS capacitor.

Contact Address
 Head, Skill Development Unit
 CSIR - Central Electronics Engineering
 Research Institute (CSIR-CEERI)
 Pilani - 333 031, Rajasthan, India
 Email: headsdu@ceeri.res.in

RPS College of Engg. & Tech. Balana, Mohindergarh (HR.)
Principal



CSIR - Central Electronics Engineering Research Institute
Pilani, Rajasthan, India



Serving the country since 1953 through

- Technology Development
- Sponsored/Contract R&D
- Consultancy
- Skill Development

IN THE AREAS OF

Cyber-Physical Systems

- Intelligent Systems
- Societal Electronics

Microwave Devices

- Vacuum Electron Devices Design
- Vacuum Electron Devices Development

Smart Sensors

- Semiconductor Device Fabrication
- Semiconductor Device Design
- Microsystem Packaging

Some of the Devices and Technologies Developed

- Accelerometer, Diamond Detectors, Sensor Interface Circuits, Gas Sensor Platform, Low Temperature Co-fired Ceramic Technology based Circuits, MEMS Hotplate, Silicon Carbide Schottky Diode Detectors, MEMS Ultrasonic Transducers, MEMS Acoustic Sensors, Selective Ion Sensors, Biosensors, ISFET based PH Sensor, Hybrid Microcircuits (HMCs) for SROSS and INSAT series of Satellites, Re-configurable System Design, Application Specific Instruction-set Processor Design, 16/32-bit Microprocessor Design, P-MOSFET Gamma-ray Dosimeter, Piezoresistive Pressure Sensor, Capacitive Pressure Sensor, InP-InGaAs based PIN Photo Detectors, 980nm Pump Laser Diode, C-band High-power GaAs MESFETs and Amplifiers
- 140 W Ku-band Space TWT, 2.6 MW Magnetron for LINAC, Mercury-free VUV/UV Plasma Source, Pseudospark Switches, Cathode System (MTRDC), Software Packages, Related Infrastructure & Technologies, High-power Microwave Window Technology, Long-life Dispenser Cathodes, 40 kV 3 kA Thyatron, 25 kV 1 kA Thyatron, Design and Technology Development for Gyrotron Devices, 6 MW Pulse 24 kW Average Power S-Band Klystron, 5 MW Pulsed S-band Klystron, 6 GHz 20 W Helix TWT, 60 W Space TWT, S-band 30 W Helix TWT, Broadband 40 W Mini Helix TWT, C-band 75 kW CC-TWT, 3 MW Pulsed S-Band Magnetron, 2 MW S-band Tunable Pulsed Magnetron, S-band 1 MW Magnetron, S-band 500 kW Magnetron, S-band 400 W Carcinotron
- Ksheer Tester, Ksheer Scanner, Grid-compatible Inverters, 5 kW Solar-power Drive for Pumps, RO Water Plant Automation, Specialised Power Supplies and Pulse Power Systems for High Power Microwave Tubes, Sensor Networks, Wired and Wireless Communication Network for Underground Mines, Electronic Tongue, Electronic Nose, NIR-based Instrumentation for Chemometrics, Electronic Instrumentation for Fresh Water Aqua-culture and RO Systems, Machine Vision Systems for Bakeries and Steel Mills, Machine Vision Systems for On-line Sorting and Grading of Fruit, Monitoring and Control System for Paper and Pulp Industry, Process Control Instrumentation for Sugar Industry, Withering Control for Tea Processing, Converters/PWM Actuators, High-power ac and dc Drives

Academic Programmes Offered

- The Institute offers graduate and research programmes under the aegis of AIIR in Advanced Electronic Systems, Semiconductor Electronics, and High Power Microwave Devices and Systems Engineering.
- Skill Development Programmes for Students and Working Professionals
- ME/M Tech project work and doctoral thesis work for highly motivated university students in all the above areas of electronics

For Further Details, Please Contact

Director, CSIR - Central Electronics Engineering Research Institute, Pilani (Rajasthan) 333 031
Tel: 91+1596-242111 Fax: 91+1596-242393 E-mail: director@ceeri.res.in www.ceeri.res.in

Principal
B.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



RAO PAHLAD SINGH COLLEGE OF ENGG. & TECH.

Approved by AICTE / Govt. of India & Affiliated to U.P.U., Meerut

Balana, Mohindergarh, Haryana - 123029

Telephone: 01293-241431 Fax: 241434


Email: rpsbalana@gmail.com, Website: www.rpsinstitutions.org

Department of Electrical and Electronics Engineering

ECE 3RD YEAR

S.NO	RollNo	Name	FatherName
1	19EC01	AMAR	RAKESH
2	19EC02	ANKITA	ASHOK KUMAR
3	19EC03	BIJENDER	RAMESH KUMAR
4	19EC04	DINKAR	SHRI BHAGWAN
5	19EC05	GUNJAN	ASHOK KUMAR
6	19EC07	MANJEET	RAMNIWAS
7	19EC08	MOHIT	SUNIL KUMAR SHARMA
8	19EC09	NIKHIL YADAV	RAJKUMAR YADAV
9	19EC10	PARMOD	RAJESH KUMAR




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



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Balana, Mohindergarh, Haryana - 123029

Telephone: 01285-241431 Fax: 241434

E-mail: rpsbalana@gmail.com, Website: www.rpsinstitutions.org

Department of Electrical and Electronics Engineering

S.NO	RollNo	Name	FatherName
1	20EC02	ANIL KUMAR	SAJJAN SINGH
2	20EC03	ANKIT LAMBA	BALWAN SINGH
3	20EC04	AYUSH	PRAMOD
4	20EC05	DEVENDER SINGH	SANDEEP SINGH
5	20EC07	JITENDER SHARM	PARVINDER KUMAR
6	20EC10	ROHIT SHANKHL	KARAN SINGH
7	20EC11	SAGAR	RAJENDER KUMAR
8	20EC12	SAHIL	PRADEEP KUMAR
9	20EC13	YASH RAJ	MOHAN SINGH
10	20EC14	YOGESH	DHARMENDER
11	20EC15	UJJAWAL	SUBHASH CHAND



K. Yadav
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



M. Gupta
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (H.R.)

MEMORANDUM OF UNDERSTANDING (MoU)

BETWEEN

RPS Group of Institutions

&

Zapbuild Technologies Pvt. Ltd.

FOR

SKILL DEVELOPMENT, OUTCOME BASED TRAININGS,
PLACEMENT, R&D SERVICES AND RELATED SERVICES



[Handwritten Signature]
RPS College of Engg. & Tech.
Balasore, Odisha (India)

Training /Research & Placement Programs:

For The Training / Research & Placement Programs, Zapbuild would like to start our journey with your organization by taking first batch of 40 – 50 candidates after the process mentioned below. (As we believe some students must be having their own plans or considering some other exception.)

Candidate Enrollment Process:

Technical Test will be conducted first (Basic C & C++), to check where every individual stands technically.

1. Candidate, who will clear the technical test with **70% marks**, will be enrolled in Stipend Program. (Stipend: Rs 6000/-PM)
2. Candidate, who will clear the technical test with **60 to 70% marks**, will be enrolled in Free Program.
3. Candidate, who will clear the technical test with **below 60% marks**, will be enrolled with some minimal charges. (Fee: 16000/- for complete 6 months program)


Further, there will be a face to face interaction round with individual candidate to take the clear picture about their technical interest and future plan, to suggest them a platform complementing their potential.

Candidate Agreement: After the enrollment process, there will be an agreement signed by the candidate, which will include six months grooming period plus one year of employment with the organization.

Technical Grooming Program will be of 6 months: Kindly find the other attachment for the technical program schedule.

To evaluate the performance:

- Practical Assignments will be given after every topic covered, Weekly Test, Monthly Mock test.
- Same sheet will be shared to the respective college coordinator to keep them in loop throughout the process.
- While learning, candidate will work on test project and after completing the test project, candidate will get the experience to work on live project of Zapbuild.


Principal
R.P.S. College of Engg. & Tech.
Bbiara - Mohundergarh (H.R.)

Final Selection after 6 months grooming program:

- After the successful completion of these 6 months period, Zapbuild will be willing to absorb at least 50% of the total number with respect to their performance throughout. Strictly on the bases of parameter defined.
- Considering their performance in the monthly test and on live project there will be one last interview round with the CTO to get them on board with our development team.

The following parties have executed this MOU as of the dates set forth below.

Signature  

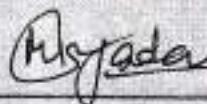
Name: Chavita Sharma

Designation: Training and Development Officer

For: Zapbuild Technologies Pvt

Mohali- Punjab, India

Signature

Name:  06/01/2017

Designation: 


For: RPS Group of Institutions

Mahendragh- Haryana, India




Principal
RPS College of Engg. & Tech
Balana Mohindergarh (HR.)



Technomatics Solutions Pvt. Ltd.

• Training • Placement • IT Solution

Memorandum of Understanding

[Signature]
May 2017

THIS MEMORANDUM OF UNDERSTANDING made on the 29th March 2017, between "Technomatics Solutions Private Limited" Authorized Huawei Network Academy Partner, registered under the Companies Act, 2013 and having its Corp office at 4th floor, JMD Megapolis, Sector-48, Sohna Road, Gurgaon-122001 (hereinafter called "TECHNOMATICS" ("The First Party"), and RPS Group Of Institution ,Satnali road Mahendragarh - 123029 (Haryana) India" hereinafter called "RPS" the "Second Party")

WHEREAS the "Second Party" has agreed to implement Huawei Trainings in College For B.Tech students. Which will be conducted by First party on the terms and conditions as agreed between the parties and set out here under.

"HIT"

Huawei Certified Industrial Graduate or popularly known as HIT is a premier course which provides the cutting edge ICT training to college students to bridge the College-Industry gap and help to make students employable

HIT is a standard 6 weeks program which includes theory class & lab practice as stipulated in the detailed pamphlet as attached with this MoU. However, this program will be adjusted to local needs as such that theory and lab training is not less than 60 hours.



Huawei Certified Industrial Graduate, popularly known as HICIG is a premier course which provides the cutting edge ICT training to college students to bridge the College-Industry gap and help to make students employable

HICIG comprises of a standard program which includes theory class & lab training. However, this program will be adjusted as per the local needs such that the theory , online and lab training is not less than 185hrs, and students will also get Industry Experience of minimum 100hrs.off campus.

Now it is hereby agreed upon and accepted between the parties as follows: -

"Technomatics Responsibilities"

[Signature]
Principal

1. That Technomatics is an authorized delivery partner of Huawei. Technomatics will arrange all training to the students of, course- B.Tech at Colleges campus .conducted by Technomatics.

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

[Signature]
Principal

For TECHNOMATICS SOLUTIONS PRIVATE LIMITED
[Signature]

Authorized Signatory

Unit No. 419-424, 4th Floor, JMD Megapolis, Sohna Road, Sector-48, Gurgaon, Haryana-122001

Tel. : +91-124-6660777, Mob. : +91-9990036582, 9560896582

E-mail : manishg@technomaticssolutions.in, support@technomaticssolutions.in, Web. : www.technomaticssolutions.in

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

3. Technomatics will develop centre of excellence at the college campus in phased manner. To start with the relevant software, remote access to software and access to hardware will be installed in the lab.
4. Technomatics / Huawei will evaluate and give inputs to students through weekly tests and final evaluation as part of their standard process.
5. Technomatics will provide training certificate to all the students
6. Technomatics will provide printed study material to all the students.

After clearing the exam, all students will get HIT, HCIG Certificate from Huawei.

The course will be commencing from June/July 2017 or any other suitable date suggested by RPS Group of Institution.

7. All the classes will be conducted on every day or according to college in college campus.
8. Technomatics will provide Focus lab after registration of 40 students either in HIT or HCIG.

“RPS” Responsibilities:

1. The boarding and lodging expenses of visiting Technomatics staff eg. Trainer like Accommodation, fooding, would be borne by RPS .
2. Class room, projector, internet, market, board, mike etc. would be provided by RPS.

“Placement Assistance”

1. As all students will undergo HIT/HCIG training programme, Technomatics will arrange/pursue a campus selection of these students.
2. All students will get a chance to appear in the placement of Huawei.
3. In addition to that, Technomatics will try to bring partners of Huawei for selection of the students, after completing training course.

1. HCIG: Technomatics will provide complete Training of 185 hrs. at college campus or in Huawei campus for comprising of both Classroom and Lab Session. After the completion of 185 hrs. Classroom training, Technomatics will provide off campus Industrial Experience of 100 hrs to each of the participating student.

For TECHNOMATICS SOLUTIONS PVT.LTD.

M. Goyal
 Authorised Signatory



M. Goyal
 Principal
 R.P.S. College of Engg. & Tech.
 Balana, Mohindergarh

M. Goyal
 Principal
 R.P.S. College of Engg. & Tech.
 Balana, Mohindergarh (HR.)

“Fee”

The fee for the proposed module will be as below

Course	Fee (in Rs.)	Fee for RPS students	Duration	Note
HIT	10000+S.TAX	8000+S.Tax	60 Hours	Fee will be directly paid to First Party
HCIG	27000+S.TAX	22000+S.Tax	285 hours	

1. Huawei Authorized Network Academy (powered by Technomatics) logo will be provided to RPS Group Of Institution to use on Banner, Brochure & Prospectus etc. However, same should be pre-approved from Technomatics in written

2. RPS will provide 60 students (30 for HIT in June 2017 & 30 for HCIG) within 8 months from signing date of MOU .
3. As discussed “RPS” will be working as Huawei Authorized Network Academy partner.
4. If students are 30 classes will be in college & if students are less than 30 then classes will be in Gurgaon only.



“Force Majeure”

1. Technomatics will not be responsible for any failure or delay on its part in performing any of its obligation or any loss, damages, costs, charges or expenses incurred or suffered by the other party by reason of such failure or delay if such failure or delay is caused due to any force majeure condition, such as acts of God, Government laws and regulation, strike, Lockouts, war or any other causes beyond its control.

For TECHNOMATICS SOLUTIONS PVT.LTD.

(Signature)

Authorized Signatory

(Signature)
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (Haryana)

(Signature)
Principal
R.P.S. College of Engg. & Tech
Balana, Mohindergarh (HP.)

"Huawei Authorised Network Academy"

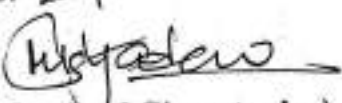
RPS Group Of Institution will function as **Huawei Authorized Network Academy** (powered by Technomatics)

The above mentioned terms & conditions have been agreed by both the parties and signed by the representatives.

For TECHNOMATICS SOLUTIONS PVT.LTD.
10/17
(Authorized Signatory)

Technomatics Solutions Private Limited
(Sign & Stamp)

Director/Manager:

Date: 29-5-2017

(Authorized Signatory)

Place: *Mohindergarh*

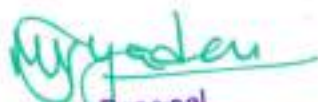


RPS Group Of Institution
(Sign & Stamp)

Head of the Institution/ Director:
Date: 29/5/17

Place: *Mohindergarh*

Principal
R.P.S College of Engg. & Tech
Balana, Mohindergarh (HR.)


Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)

CADD Centre Training Services

Opp. Milk Plant, Near Bus Stand, Narnaul - 123 001. INDIA
Phone : 9355886888. E-mail : hr.narnaul@caddcentre.ws

CADD CENTRE

CADD CENTRE

Driving Digital Designs!

30 YEARS OF SKILLING THE WORLD

MEMORANDUM OF UNDERSTANDING

This Memorandum of Understanding (MOU) entered on the 23th April 2018 *March*

By and Between

CADD Centre Training Services Pvt. Ltd, having its Corporate office at No. 91, Dr. Radhakrishnan Salai, Gee Gee Crystal, 8th Floor, Office No. 8C & 8D, Mylapore, Chennai - 600004 (hereinafter referred as "CADD Centre for the sake of brevity) and represented by its Franchisee Partner CADD CENTRE NARNAUL (Diwan Tower, Opp. Diwan Petrol Pump, Mahavir Chowk, Narnaul)

And

RPS College of Engineering & Technology, having its CAMPUS at Balana, Mahendergarhand represented by the Director- Mr. Mahesh Yadav (which expression shall mean and include its successors in office and assigns)

Mahesh Yadav
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Franchisee : L K Computer Education

Administrative Office : 8th Floor, GEE GEE Crystal, Office No. 8 C & 8 D,
Door No. 91, Dr. Radhakrishnan Salai,
Mylapore, Chennai - 600 004. INDIA.
Ph. : 044 - 4596 6100 Fax : 044 - 2847 3505
www.caddcentre.ws

OBJECTIVES of the COLLABORATION:

- Y To provide employable skills to the students of **RPS College of Engineering & Technology**.
- Y Make the student aware of the latest tools and techniques in order to keep them industry ready at the end of their course.
- Y Offer the course at an affordable price.
- Y Increase the employability of the student and maximize on the placement opportunities available.
- Y To build/improve the confidence level of the student to face the challenges of real time.



M. Yadav
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

This Memorandum of Understanding is to conduct Step – By – Step, Systematic, and Employable Skills Development Program for the students of **RPS College of Engineering & Technology** towards achieving the objective of maximizing the employable opportunities.

This Memorandum of Understanding states the terms and conditions under which the Trainings shall be conducted by CADD Centre through its franchisee partner at the premises of **RPS College of Engineering & Technology** and lists herein the respective responsibilities of both parties.

PREAMBLE:

To get a student employable and placed in an organization; over and above the subject knowledge he / she is expected to have the following:

- Strong Fundamental Engineering Knowledge
- Engineering related Multiple Technical Skills
- Communication & other Soft Skills

On one hand, thousands of unemployed Engineering graduates are not finding suitable jobs, while on the other hand, Industry requires millions of young minds at all levels but are unable to find the right candidate. This is because of the skill gap that exists between the student and industry requirements. This skill gap is sought to be minimized for the students of **RPS College of Engineering & Technology** by facilitating them to acquire the appropriate and relevant skills at the college premises itself through this program.

While Subject Knowledge would be provided by **RPS College of Engineering & Technology**, CADD Centre will equip the students with required industry specific CAD, CAM, CAE and Project Management skills.

Through this collaboration, CADD Centre through its Business Partner will prepare the students of **RPS College of Engineering & Technology** to be ready for the industry by the time they enter the final semester and facilitate many of them to secure dream jobs. For this the students have to be nurtured and trained in different areas from the very beginning. Keeping in mind the academic program and the progressive skill development cycle in mind, the programs are spread across their semesters.


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

CADD Centre through its Business Partner will provide:

- Comprehensive CADD Centre reference and work books (wherever applicable) to all students for each course as part of the course.
- Qualified trainers for the course.
- Periodical assessment of the progress of students for their further improvements.
- 'Certificate of Completion' to every student who successfully completes the training program every semester which will carry the logo of CADD Centre.
- "Certificate of Association" to the college.
- A "link to RPS College of Engineering & Technology website" from CADD Centre website www.caddcentre.com.
- Permit RPS College of Engineering & Technology to use CADD Centre logo as the Skill Development Partner.

RPS College of Engineering & Technology Shall Provide:

- The required number of computer systems for the course in the lab and other required infrastructure for the practice.
- The Class rooms with LCD projector for the theory classes.
- The Schedule with the classes for this training.
- The supports to ensure, all students who have signed up for the class, attend the training programs scheduled for them.
- Disciplinary support for the smooth conduct and timely completion of the entire course.
- Provide all support to CADD Centre to enroll students in the courses offered by CADD Centre at the College premises.

PARTICIPANTS:

The participants would be the Students of *College Name* from specified branches mentioned in ANNEXURE 1.



Ayyadav
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergam (HR.)

COURSE CONTENTS:

CADD Centre & its Business Partner in consultation with **RPS College of Engineering & Technology** shall finalize the courses and fees for the skills development program. The recommended course details are provided in the ANNEXURE – 1. These will be reviewed prior to every course and suitable changes, if required, will be incorporated. As the requirement of each course is different, courses and fees would be worked out separately for each course.

TIME SCHEDULE

The program(s) will be conducted during timings provided by **RPS College of Engineering & Technology**. The students will be divided into batches, depending on the total strength. The program(s) will be conducted according to the Time Table drawn up with the mutual consent of CADD Centre and **RPS College of Engineering & Technology**. Utmost care will be taken to frame the time table in such a way that it does not interfere with college activities enabling the student to complete his training ahead of the final exams. CADD Centre will not conduct any classes during the time of exams. In case of any change in training schedule the same will be intimated to the Program Coordinator of **RPS College of Engineering & Technology**. Similarly, if **RPS College of Engineering & Technology** wants a change in training schedule the same may be communicated to the Program Coordinator of CADD Centre. In either of the cases, a revised training schedule has to be made and the Program Coordinators of both CADD Centre & **RPS College of Engineering & Technology** and the respective students must be informed about the change in training schedule by means of suitable media (emails/posters/circulars/notice board displays).




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

COMMENCEMENT OF COURSE

The Training will commence from April ¹² 2018 to April ¹⁴ 2018 as discussed with the Candidates & HOD of RPS College of Engineering & Technology. (We can extend training to 4th day also if students needs, but without any extra cost.)

COURSE FEES & PAYMENT PATTERN

The course fee per student for each course offered is decided and mutually agreed upon by both the parties. The course fee and the payment pattern are available in the ANNEXURE – 1.

COURSE COMPLETION:

While CADD Centre through its franchisee will endeavor to complete the course as per the schedule mutually agreed upon and mentioned in Annexure 1. CADD Centre will not be responsible and accountable for delay in completing the course due to reasons which are beyond the control of CADD Centre and CADD Centre's Franchisee Partner. Reasons beyond the control of CADD Centre and CADD Centre's Franchisee Partner include – acts of Nature (including fire, flood, earthquake, storm, hurricane or other natural disaster), war, invasion, act of foreign enemies, hostilities (regardless of whether war is declared), civil war, rebellion, revolution, insurrection, military or usurped power or confiscation, terrorist activities, nationalization, government sanction, blockage, embargo, labor dispute, strike, lockout or interruption or failure of electricity or telephone service, failure and non – availability of Computer Systems, non – availability of Classrooms), law and order problems, students unrest/strike/boycott, unscheduled changes in college curriculum and other unforeseen circumstances.

- Courses details for individual package will be completed as mentioned in ANNEXURE - 1.




Principal
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Balana Mchindergarh (HR.)


While it is mandatory for the student to have undergone the complete course as mentioned in ANNEXURE - 1 to be eligible for a Course Completion Certificate. In case he/she opts out due to any reason an appropriate certificate will be issued for only for that course completed by the student. Students will not be eligible for Certification for the courses that they have not completed.

CADD Centre will not issue "Certificate of Completion" to the successful student, if full payment is not made. Neither CADD Centre nor CADD Centre's Franchisee will refund the portion of the fees once paid, if the student opts out or discontinues the course after commencement of the course other than for reasons beyond the control of the College or student.

JURISDICTION

All matters, queries, disputes or differences, whatsoever, arising between the parties touching the construction, meaning, operation or effect of this Memorandum of Understanding or out of or relating to this Memorandum of Understanding or breach thereof shall be settled through arbitration in accordance with the relevant Arbitration Act in force at such time. The Arbitration award shall be binding on both parties




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

This Memorandum of Understanding shall come into effect from the date of agreement
aforementioned.

For RPS College of Engineering
& Technology



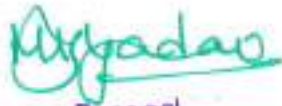
Name: Mr. Mahesh Yadav
Designation: Director
Date: 23rd April 18
March

For: CADD CENTRE TRAINING
Services Pvt.Ltd.



Name: Mr. Lokesh Saini
Designation: Centre Head
Date: 23rd April 18
March




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

ANNEXURE - 1

For Civil Engineering Students:

Semester	Course	Software	Duration	Min. Students	Fee (Rs.)
4th & 6 th Sem.	Computer Aided Land Survey (CALs)	AutoCAD Civil 3D	24	50	1800



M. Yadav
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergam (HR.)

MEMORANDUM OF UNDERSTANDING

BETWEEN

RPS Group of Institutions
www.rpsinstitutions.org

And

Swar Yantra Technologies Pvt. Ltd.
www.swaryantra.com

This Memorandum of Understanding (MoU) is entered into as of 6 December, 2018, by and between the RPS Group of Institutions and Swar Yantra Technologies Pvt. Ltd.

The partners have entered into this MoU because they:

Express the willingness of both parties to engage in an effort to improve employment opportunities for students of RPS Group of Institutions.

Swar Yantra Technologies has developed an innovative interviewing and assessment solution, which is being used by the organizations, which does not want to travel to multiple campuses but want to recruit candidates through campus placements.

Recognize the mutual interest in the fields of Training and Placement, Consultancy and dissemination of knowledge

Recognize the importance of career counselling in shaping the career path of the candidates.

Recognize the importance of the Industry Partner within its field of

The parties hereby agree to establish collaboration according to terms and conditions set out in the articles following hereunder.

Scope of Collaboration

The general purpose of this MOU is to facilitate industry and institute based upon the principles of mutual benefit and may include the following general cooperation areas:

1. Joint industry-academia and research activities.
2. Specific activities under this MOU will identified through consultation between the two parties. Swar Yantra Technologies agree to provide specific assistance to RPS Group of Institutions improving recruitment of their students with the use of their innovative solution. Swar Yantra Technologies will work with their clients to bring openings on its solution and all eligible students of RPS Group of Institutions will participate for job interviews on the platform from their campuses.



Swar Yantra Technologies Pvt. Ltd.

Handwritten signature

Director

Handwritten signature
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

3. As a preliminary activity, both Swar Yantra Technologies and RPS Group of Institutions will appoint a coordinator for effective communication that will happen throughout the session. Then RPS Group of Institutions will ensure all interested students download the android app and login using assigned RPS Group of Institutions code. Once login, students will complete their digital profiles and upload CV.
4. Time to time, Swar Yantra Technologies will bring campus recruitment opportunities on the solution and will communicate with RPS Group of Institutions coordinator and TPO. RPS Group of Institutions will ensure all eligible students participate in those interviews. Coordinator will share status report with Swar Yantra Technologies.
5. At times Swar Yantra Technologies may provide preparatory opening to students and RPS Group of Institutions will ensure all students will participate in those interviews. Result of these interviews will be shared with RPS Group of Institutions and TPO office will use it to give feedback to students. This feedback will be shared with Swar Yantra Technologies too.
6. RPS Group of Institutions agrees to work with and coordinate with Swar Yantra Technologies to improve and expand campus recruitments for their students. They also agree to allow Swar Yantra Technologies to interact and assess their students for campus recruitment related activities.

General Terms & Conditions

1. This MOU is not intended to, and does not create any right, benefit, or trust responsibility, substantive or procedural, enforceable at law or equity, by either party, its officers, employees, or agents against the other party, its officers, employees, or agents.
2. This MOU shall be operational upon signing and will have an initial duration of one year. All activities conducted before this date within the vision of the joint collaboration will be deemed to fall under this MOU.
3. This MOU is solely work for the development of students, faculty, industry executives and staff, community provides self-employment, training and skill development.
4. In order to carry out and fulfill the aims of this agreement, each party will appoint an appropriate person(s) to represent its organization and to coordinate the implementation of activities.
5. This whole engagement will be free of cost for RPS Group of Institutions and its students. Both the party cannot charge any kind of commercial for this service.
6. Each party agrees that after execution of the MOU, shall not disclose any information in relation to these activities or the affairs of business or method of carrying on the business of the other without consent of both parties.
7. The partnership covered by this MOU shall terminate upon completion of the agreed upon period. The agreement may also terminate with a written one-month notice from either side. In the event of non-compliance or breach by one of the parties of the obligations binding upon it, the other party may terminate the agreement with immediate effect.



Swar Yantra Technologies

[Handwritten Signature]

Director

[Handwritten Signature]
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

8. RPS Group of Institutions will allow Swar Yantra Technologies to use all reports, content for expanding services for benefit of students.
9. In the event any company not willing to visit RPS Group of Institutions for campus recruitment or no student is selected from RPS Group of Institutions by company, RPS Group of Institutions cannot hold Swar Yantra Technologies responsible for any liability what so ever.
10. All notice, demands and other communication under this agreement in connection herewith shall be written in English language and shall be sent to the last known address, email, or fax of the concerned party. Any notice shall be effective from the date on which it reaches the other party.
11. Nothing in this MOU obligates either party to commit or transfer any funds, assets, or other resources in support of projects or activities between the parties unless expressly stated in this agreement.
12. Both parties agree to submit outcomes of their joint collaboration, whilst safeguarding their own copyright and any patents that may produce by their collaboration.
13. The activities of this MOU must be carryout in accordance with appropriate laws and regulations existing in India.
14. RPS Group of Institutions will promote ethical practice among students and encourage them to conduct ethically during interview and assessments.
15. In the event of legal/health/family situations of selected candidates, where student cannot join organization, RPS Group of Institutions' HOD and HR coordinator will inform Swar Yantra Technologies giving all factual information.

The Agreement

1. At RPS Group of Institutions, Registrar/Prof. In-charge – CAOC will administer this MOU. At Swar Yantra Mr. Neeraj Upreti, CEO will administer this MOU.
2. The parties may enter into specific written agreements under authority of this MOU to clarify and define the nature, extent and terms of operation for the proposed collaborations, including intellectual property ownership and funding.



Swar Yantra Technologies Pvt. Ltd.

Neeraj

Director

Mishra
Principal
R.P.S. College of Engg. & Tech
Balahna Mohindergarh (HR.)

RPS Group of Institutions,
Mahendergarh

Swar Yantra Technologies Pvt. Ltd.
Faridabad

Signed By Dr. Mahesh Kumar Yadav

NEERAJ UPRETI
Signed By
Swar Yantra Technologies Pvt. Ltd.

Signature



Signature

Director

Date 06/12/2018

Date

Official Stamp

Official Stamp



Mahesh Kumar Yadav

Principal

B.B.S. College of Engg. & Tech
Balana Mahendergarh (HR.)



Sofcon Training
An ISO 9001:2008 Company



(NSDC is a PPP promoted by Ministry of Skill Development & Entrepreneurship, Govt. of India)
Mission 2020:100,000 Placements

MEMORANDUM OF UNDERSTANDING

Between

SOFCON India Pvt. Ltd., New Delhi



AND
Rao Pahlad Singh College of Engineering &
Technology, Balana,
Mahendragarh, Haryana

Dated this 17th Day of April, 2018

R. P. Yadav
Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)

MEMORANDUM OF UNDERSTANDING

This Memorandum of Understanding ("MoU") is made on the day 18th of April, 2018

WHEREAS, Sofcon India Private Limited, an existing company within the meaning of Companies Act'1956 having its registered office at 705, Pearl Omex , Netaji Subhash Place, Pitampura, Delhi -110034 (hereinafter called **SOFCON INDIA**) and "Rao Pahlad Singh College of Engineering & Technology, Balana, Mahendragarh (Haryana)" have agreed to enter into a collaborative agreement, recognizing the need to cultivate an industry – institution interaction, urgent need of hands-on training in the field of rapidly growing automation & Embedded technology to passing engineers and perpetual need to keep abreast with latest developments in the field of Industrial Automation.

(SOFCON India Pvt. Ltd and Rao Pahlad Singh College of Engineering & Technology, Balana, Mahendragarh (Haryana) are here in after individually referred to as "**PARTY**" and collectively referred to as "**Parties**")

Roles & Responsibilities

- Sofcon India Pvt. Ltd, New Delhi has agreed to act as knowledge provider & will do assessment for skill competency , Sofcon agreed to conduct training & assessment at the premises of Rao Pahlad Singh College of Engineering & Technology, Balana. All the software & accessories required for conducting this training will remain sole property of Sofcon India Pvt. Ltd, New Delhi.
- Rao Pahlad Singh College of Engineering & Technology, Balana has agreed to provide Lab infrastructure covering training space, lighting, air conditioning, furniture, computer hardware, UPS supply etc. required for Training.
- Rao Pahlad Singh College of Engineering & Technology Balana has agreed to facilitate the trainer/s with boarding and food facilities.



Conduct of Training:

- Both the parties have agreed to conduct a job oriented training of 200 hours in the college premises:
- 120hours of training will be provided at the college premises and 80 hours of training at different branches of Sofcon when the students turn up for placement opportunities for one month tenure.
- The training will commence after the completion of 6th semester exams in the college campus.
- Training will be conducted in college campus as per the suitability of both parties.
- After the competition of seventh semester exam, students will report to the nearest branch of Sofcon India Pvt. Ltd. For a duration of one month.

[Handwritten signature]

[Handwritten signature]
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

- During the one month the students will be offered a brush up program with placement opportunities followed by immediate joining.
- Rao Pahlad Singh College of Engineering & Technology, Balana, Mahendragarh (Haryana) has agreed to issue NOC to the selected candidates.

Conditions for Placement:

- The students will be offered with placement opportunities in Pvt. Ltd. Or Ltd. Companies.
- The students will be offered placement under the payrolls of the company.
- Students will be placed as Project Engineer/Service Engineer/Application Engineer/Design Engineer/GET or any other similar core profile.
- The students will be offered a minimum salary of Rs.10000 (for B.Tech) and Rs.8000 (For diploma). Though both the parties understand that higher packages offered will be an achievement and matter of pride for the parties.
- In case the company provides food/accommodation/both the parties agree that the minimum salary might differ over a maximum range of Rs. 2000 against the facilities provided.

Terms & Conditions:

- Learning is best when training is conducted continuously. Sofcon should be allotted sessions at regular intervals to complete this training program.
- Sofcon will establish temporary lab at your campus, and will carry all hardware/Software and kits.
- Arrangement of training lab (Having LCD projector) and computers in 1:2 PC: student ratio) in your scope.
- Training will start after 6th semester examination.
- Students will enroll for placement assured module.
- Sofcon will provide certificates after completion of training.
- Minimum students strength of each branch should be 30.
- The offered fees will be Rs 25000/- per student according to the branch available. The offered fees will hike to 28000/- if strength will be less than 30.
- Both the parties agree that the entire fee will be refunded back to the student if the former fails to place the candidate in desired core profile before 30th August 2019.
- The students will be offered with multiple job opportunities until provided with placement.
- If the student denies for 3 opportunities provided/doesnot turn up for interview, he/she will not be offered with further opportunities. Further the candidate will not be entitled for fee refund.
- If the candidate denies to join after selection or leaves the organization immediately after joining the candidate will not be offered with further opportunities. Further the candidate will not be entitled for fee refund.
- The candidate will be entertained with a maximum leave of 2 days for their final presentation during their 8th semester.
- If the candidate opts for further higher studies/ opts for Govt. Vacancies he/she will not be entitled for fee refund. However he/she can opt for placement opportunity over a span of one year after the completion of training.



Paypai

Murghada
Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)

Commercials:

- SOFCON India Pvt. Ltd. shall charge fees per student per technology /module as mentioned below.

Technology /Module	Duration of total training	Fee offered per Module**
IAE	200Hrs(120hrs in campus+ 80 hrs at Sofcon)	25000
IME	200Hrs(120hrs in campus+ 80 hrs at Sofcon)	25000

- 33% at the commencement of training.
- 34% after the date commencement of training.
- 33% after two months from second instalment.
- Candidates will be entitled for placement only when the entire commercials are cleared.
- The refund policies of training fee are as mentioned in the terms and conditions.

** The offered fees will hike to 28000/- if the strength of trainees will be less than 30 for each trade.

Commitment of Association

- Rao Pahlad Singh College of Engineering & Technology, Balana will not hire engineers employed by Sofcon India Pvt. Ltd, New Delhi.
- Each party agrees that the existence and terms of this MOU are confidential and shall not be disclosed to any third party.
- This MOU constitutes an expression of intent only and does not constitute a legally binding offer or contract. A binding agreement will arise only when all material terms have been set forth in a definitive agreement executed and delivered by authorized representatives of both the parties.
- All agreements, drafts, memorandum and other communications with respect to this MOU shall be considered only preliminary and shall have no legal effect unless subsequently incorporated into a definitive agreement or agreements.
- We the undersigned have read and agreed to sign this MOU :

Pushkar Bajpayee
17.4.2018

PUSHKAR BAJPAYEE

DIRECTOR
Signed for and on behalf of
SOFCON INDIA PVT. LTD.

For SOFCON India Pvt. Ltd., New Delhi

M. Yadav
17.4.2018

Director

R.P.S. College of Engg. & Tech.

Balana (M/Garh)

Signed for and on behalf of

Rao Pahlad Singh College of Engineering
& Technology, Balana, Mahendragarh
(Haryana)

M. Yadav
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

MEMORANDUM OF UNDERSTANDING

This Memorandum of Understanding ("MOU") is made on Jan 24, 2019 and shall be effective from the said date ("EFFECTIVE DATE") BY AND BETWEEN

Triedge Solutions Pvt. Ltd, a corporation incorporated under the Companies Act, 1956 and having its registered office at 5/5 West Patel Nagar, New Delhi 110008 and Corporate Office at 403, 4th Floor Prem Sadan, 11 Rajendra Place, New Delhi 110008 hereinafter referred to as the "**Service Provider**" or "**Triedge**"

AND

RPS Group of Institutions having its registered office at Balana, Mahendragarh-Haryana hereinafter referred to as the "**Institution**"

The Service Provider and the Institution shall be known individually as "**PARTY**" and collectively as "**PARTIES**".

WHEREAS


1. The Service Provider is engaged in the business of providing Recruitment, Lateral Hiring, Campus Hiring, Staffing and Contract Management Services, Internships, Trainings, Resume Writing Services and other Career Related Services collectively known as "**CAREER SERVICES**"
2. The Institution is desirous of increasing career opportunities for its students and has agreed to sign this MOU so that the students of the Institution can avail of the Career Services provided by Triedge.

NOW IT IS HEREBY AGREED BY AND BETWEEN THE PARTIES HERETO AS FOLLOWS:

1. OBJECTIVES OF THE MOU

The objectives of this Memorandum of Understanding are:

- a. To enhance career opportunities for the students of the Institution.


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)
Director
R.P.S. Group of Institutions
Balana, Mohindergarh
(Haryana)




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)


- b. To enable Triedge to recommend the Institution and its students to its corporate clients for internships and final placements.
- c. To promote interaction and provide a formal basis for interaction between Triedge and the Institution.

2. Service Provider's Obligations

- a. The Service Provider shall allow access to career services and opportunities to those students of the Institution who register on its website www.triedge.in ("**Registered Students**") and agree to abide with the Terms and Conditions.
- b. The Registered Students of the Institution will have access to the following sections of the Triedge website:
 - I. Profile Page & Dashboard
 - II. Internship Opportunities
 - III. Job Opportunities
 - IV. Career Related Article Library
 - V. Free Trainings
- c. Triedge will host internship and placement opportunities posted by its Clients across functions and sectors including HR, Sales & Marketing, Finance, Analytics, Operations, Digital Marketing, Telecom, Electronics, Construction, Healthcare, Sports, Fitness and Leisure, IT-ITES, Retail, Apparel, Logistic, Media, BFSI, Handicrafts, Beauty and Wellness, Tourism and Hospitality etc.

3. Institution's Obligations

- a. The Institution's Placement Cell or Team will register on www.triedge.in so that internship and job opportunities can be shared with the Placement Cell of the Institution.
- b. The Institution's Placement Cell or Team will periodically circulate through email and social media career opportunities and services hosted on www.triedge.in with their students.


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Director
R.P.S. Group of Institutions
Balana, Mohindergarh
(Haryana)


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



- c. The Institution will provide a link of website www.triedge.in on its official Website and / or Placement Cell Website.
- d. The Institution will encourage its students to register on www.triedge.in so that the students can apply for positions posted on it.
- e. The Institution will nominate 2 students who will be the point of contact for Triedge.

4. Financial Obligation

This MOU will not result in any financial obligation and neither Party will be required to make any payment to the other Party for the services mentioned in this MOU.

5. Publicity

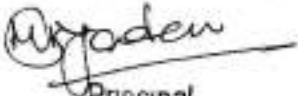
Each Party may use the name and logo of the other party as a placement or recruitment or internship or training partner in the public domain on their websites, brochures, presentations and other marketing mediums or materials.

6. Term of MOU

- a. This MOU will be valid for a period of two year from the Effective Date. The MOU can be renewed for further term(s) upon mutual agreement between the Parties.
- b. The MOU may be terminated, with or without cause, by either Party by giving a notice of one month to the other Party

1. Other Terms

- a. It is agreed that notwithstanding anything to the contrary contained herein, the Service Provider or its Clients or any Corporate who posts career services or opportunities on www.triedge.in shall have no obligation whatsoever to hire any particular candidate or student referred by the Institution.


Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)
Director
R.P.S Group of Institutions
Balana, Mohindergarh
(Harvana)


Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)



- b. It is also agreed that the Institution and the Service Provider will provide all its services on "best efforts basis" only.
- c. The terms of the MOU may be changed by the Parties through mutual consent. Any change in the terms and conditions or amendment in the terms of the MOU will be in writing.

BY SIGNING BELOW, the parties, acting through their duly authorised officers, has caused this Memorandum of Understanding to be executed, effective as of the day and year first above written

For and on behalf of RPS Group of Institutions

Authorized Signatory

Signature M. S. Yadav
Name Dr. Mahesh Kumar Yadav
Designation Director
Date 24-01-2019

Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)
Director
R.P.S Group of Institutions
Balana, Mohindergarh
(Haryana)

For and on behalf of Triedge Solutions Pvt Ltd.

Authorized Signatory

Signature

Name

Designation

Date



M. S. Yadav
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



Date: July 14, 2021

MEMORANDUM OF UNDERSTANDING

This Memorandum of Understanding ("MoU") is entered into as of July 14, 2021 (the "Execution Date") by and between, **RPS Group of Institutions** (hereinafter referred to as "RPS GOI")

AND

TESTBOOK EDU SOLUTIONS PRIVATE LIMITED (PAN: AASCS8515R and CIN: U72200MH2013PTC241118), a private limited company incorporated under the Companies Act, 1956, engaged in providing online educational courses to students, having its registered office at 1st and 2nd Floor, Zion Building, Plot no. 273, Sector No. 10, Kharghar, Navi Mumbai, Raigarh, Maharashtra - 410210 (hereinafter referred to as "Testbook", which expression shall unless repugnant to the context or meaning thereto shall mean and include its successors and permitted assigns) represented herein by its Director, Mr. Ashutosh Kumar, duly authorised by its board of directors vide resolution dated 16th November, 2019.

RPS GOI and Testbook are individually referred to as a "Party" and collectively as "Parties".

WHEREAS:

- A. Testbook will provide its services under **Testbook Skilled Campus Program** for use by RPS GOI in respect of "End Users" (all students who are presently enrolled in any programme with the institution), in accordance with the terms and conditions set out herein, and Testbook has agreed to the same.
- B. Pursuant to the foregoing, the Parties have agreed to enter into this MoU to set forth the terms and conditions of their arrangement in following sections.

As a part of this MoU, both the parties have identified and hereto agree to the following responsibilities respectively:

1. RESPONSIBILITIES

1.1 Responsibilities of Testbook

- A. Testbook with the help of RPS GOI, shall get all the willing students of RPS GOI to sign up on Testbook's platform with email ID to avail the services under Testbook Skilled Campus Program.
- B. There will be no financial implications involved between Testbook and RPS GOI during the "Term" (defined hereafter) of this MoU and the End Users can get these benefits under Testbook Skilled

TESTBOOK EDU SOLUTIONS PVT. LTD.

K. Yadav

Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Campus Program:

- Placement Preparation Activities for a period of 1 year which can include Live Tests (Minimum of 5) along with a detailed analysis of RPS GOI End Users' performance to the institute
- Career mentorship sessions from industry experts (Minimum of 5)
- Access to all the content under Testbook Pass for a period of 01 month
- Chance to get internships & full time opportunities

1.2 Responsibilities of RPS GOI

- To inform the availability of such free services as referred above to the End Users for upskilling and assessment by circulating necessary information.
- To provide support in scheduling the Live Tests and informing the End Users that would help them evaluate their readiness for placements and institute to know the current preparation status of their students.
- To provide End Users' detailed feedback of Testbook's platform usage to Testbook.

2. Other provisions:

- This MoU shall be valid for an initial period of 1 (one) year from the Execution Date ("Term ") unless terminated earlier by Parties.
- Testbook shall keep all the data collected from the students confidential and shall NOT share/disclose to anyone in any form whatsoever without the prior written permission from the students. Testbook also agrees that the data so collected shall be used for the purpose envisaged in this MoU and not for any other purpose.

AGREED AND ACCEPTED:

For and on behalf of RPS GOI :

For and on behalf of TESTBOOK EDU
SOLUTIONS PVT LTD



Signature:

Dr. Mahesh K Yadav

Signature:

Name: Dr. Mahesh K Yadav

Name: Ashutosh Kumar

Title: Director

Title: CEO

Date: 21 July 2021

Date:



TESTBOOK EDU SOLUTIONS PVT. LTD.

Dr. Mahesh K Yadav
Principal

R.P.S. College of Engg. & Tech
Satana Mohindergarh (HR.)

भारतीय गैर न्यायिक



INDIA NON JUDICIAL

हरियाणा HARYANA

G 719683

MEMORANDUM OF UNDERSTANDING
FOR
INSTITUTIONAL COLLABORATION

BETWEEN

RAO PAHLAD SINGH GROUP OF INSTITUTIONS

AND

CSIR - CENTRAL ELECTRONICS ENGINEERING RESEARCH
INSTITUTE (CSIR-CEERI)




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

19948
28/12/86

10000/- अंशक र. प. स.

उत्तर (मध्य प्रदेश) राज्य सरकार
अर्थ विभाग, इंदौर

अग्रवाल

28/12/86



अग्रवाल
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergam (HR.)

भारतीय गैर न्यायिक



INDIA NON JUDICIAL

हरियाणा HARYANA

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MEMORANDUM OF UNDERSTANDING FOR INSTITUTIONAL
COLLABORATION

BETWEEN

RAO PAHLAD SINGH GROUP OF INSTITUTIONS

AND

CSIR - CENTRAL ELECTRONICS ENGINEERING RESEARCH
INSTITUTE (CSIR-CEERI)



This Memorandum of Understanding (hereinafter referred to as "MoU") entered into on this 27th day of July 2021 by and between:

Rao Pahlad Singh Group of Institutions (hereinafter referred to as "RPS-GOI") is a premier institute in South Haryana, with its main campus in Balana, Satnali Road, Mahendragarh-123029 (Haryana). The Institute, which was founded in 2008, provides B.Tech. courses in Computer Science & Engineering, Mechanical Engineering, Information Technology, and

Principal Page 2 of 7
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)

19968

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9/11/2022



Principal
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

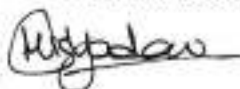
Electronics & Communication Engineering. RPS Institute of Management, which offers MBA, BBA, and BCA degrees, was founded in 2010. Both institutes were merged and renamed RPS Group of Institutions in 2011. The B.Tech. programme in Civil Engineering was launched in 2011. The institute began offering M.Tech. programme in Computer Science & Engineering in 2012. In 2013, the institute launched the Electrical Engineering B.Tech. programme, as well as MTech. programmes in Electronics and Communication Engineering and Mechanical Engineering. In 2015, the institute started offering Engineering Diploma in Mechanical and Civil Engineering. RPS-GOI currently offers B.Tech. programmes in CSE, ECE, ME, Civil, and EE branches, as well as MTech. programmes in CSE, ECE, and ME, as well as full-time MBA, BBA, and BCA programmes, and a Polytechnic Diploma in Engineering in Civil and Mechanical Engineering.

AND

CSIR-Central Electronics Engineering Research Institute, (hereinafter referred to as "**CSIR-CEERI**") established in 1953, is a constituent establishment of the **Council of Scientific and Industrial Research (CSIR), New Delhi**, having its campus and administrative office in Pilani - 333 031, Rajasthan, India. It is devoted to R&D activities in the following areas: (1) Advanced Electronic Systems: Image processing and DSP, Internet of Things (IoT), Embedded System Design, Electronic Instrumentation, Industrial Control & Automation, Power Electronics, Robotics, VLSI Design (Digital, Analog, Mixed Signal), etc.; (2) Advanced Semiconductor Electronics: MEMS, Micro-sensors, Opto-electronic Technologies, Photonic Devices and Sub-systems, Nano-electronics, LTCC and Advanced Packaging technologies, etc.; (3) Microwave Tubes: Klystron, Magnetron, Travelling Wave Tubes, Gyrotron, Plasma Tubes, Tera Hertz devices etc. CSIR-CEERI also has Centers at Chennai, Delhi and Jaipur.

Collectively hereinafter referred to as "institutions"

This MoU is based on the principal of reciprocity and expresses the interest of both institutions in exchanging scholars, students, academics information and materials in the belief that the research and educational process at both institutions will be enhanced and that mutual understanding between their respective scholars and students will be increased by the establishment of such exchange programs as per CSIR Guidelines.



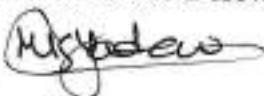
Page 3 of 7
Principal


R.P.S. College of Engg. & Tech.
Balana Mohindergarh (HR.)

1. The institutions agree to encourage the development of the following exchange programs based on their respective academic and educational needs:
 - Submission of joint research project proposals to funding agencies
 - Joint collaboration with international institutes/Universities
 - Exchange of scientific staff
 - Exchange of students (undergraduate and / or graduate)
 - Joint supervision of B. Tech, M.Tech., M.S. and Ph.D. students
 - Exchange of academic information and materials
 - Organization of joint research courses
 - Organization of joint conferences
 - Organization of other academic exchanges agreeable to both institutions
 - Use of laboratory facilities on mutually agreed terms and conditions

Areas to start this collaboration are listed in Annexure 1. Both the institutions can revisit this list after mutual consultation. The above activities shall be undertaken as per CSIR guidelines.

2. The parties recognize that the implementation of any exchange program will depend upon the academic interests and expertise of individual staff members and upon the availability of financial resources. Accordingly, the implementation of each exchange program based on this agreement shall be separately examined and determined by both institutions. The institutions shall enter into separate agreements regarding the individual exchange programs.
3. Faculty/ Scientists of either of the institute initiating collaborative work will take care of the usage of their institute resources and conduction of activities as per institute norms. Dr. Mahesh Kumar Yadav, Professor, Department of Electronics Engineering, and Director **RPS-GOI**, shall be the Coordinator of the **CSIR-CEERI & RPS-GOI**, Collaboration and will coordinate with a scientist from **CSIR-CEERI** for the implementation of this initiative.
4. Each institution will adhere to the intellectual laws of India. Intellectual property developed during the visit of an exchange student/researcher/faculty/staff will be governed by the rules of the host institute unless otherwise specified. The two institutions shall jointly own results of clearly defined collaborative projects and exchange programs. This joint ownership also entitles each party to explore commercialization. However, transfer of jointly developed technology and associated




Principal
R.P.S. College of Engg. & Tech.
Balana Mohindergarh (HR.)

sharing of revenue shall be governed by a separate agreement. This cost of IP filing will be equally shared by both Institutions.

Furthermore, if one institution receives any information from the partner under a clearly defined non-disclosure agreement, necessary and reasonable care will be taken to protect the intellectual property received.

5. This MoU is not intended to be a legally binding document. It is meant to describe the nature and to suggest the guidelines of the cooperation described above. Nothing therefore shall diminish the full autonomy of either institution, nor will any constraints be imposed by either upon the other in carrying out the agreement. Any disputes shall be resolved through mutual discussion between the highest officials of the respective institutions.
6. Any addition, deletion and /or alteration to this MoU may be effected by writing. A document containing the additions, deletions and /or alterations, and signed by all Parties hereto, shall form an annexure to and be deemed to be a part of this MoU.
7. The agreement shall become effective on the day representatives of both institutions affix their signatures and seals, will be in force for a period of 5 years, and is subject to revision or modification by mutual agreement. It is also understood that either institution may terminate the agreement at any time, although it is assumed that such action would only be taken after mutual consultation at least six months in advance in order to avoid any possible inconvenience to the other institution.



M. Yadav

M. Yadav
Principal
R.P.S. College of Engg. & Tech
Balana, Mohindergarh Page 5 of 7

IN WITNESS WHEREOF, the institutions hereto have offered signatures :

For: RPS Group of Institutions,
Mahendragarh, Haryana

Director


Signature: 

Date: 28-07-2021

Seal:



Witness :

Signature: 

Name: Dr. Devender S. Yadav

Designation: Registrar.

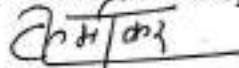
Signature: 

Name: Dr. J.K. GODHWAL

Designation: Vice-Principal.

For: CSIR-Central Electronics
Engineering Research Institute, Pilani

Head-Technology Business Development

Signature: 
ABHIJIT KARMAKAR

Date: 28-07-2021

Seal:

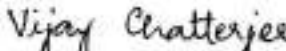
प्रमुख, प्रौद्योगिकी व्यवसाय विकास यूनिट
Head, Technology Business Development Unit
सीएसआरईआर-सीएसी / CSIR-CEERI,
पिलानी (राज.) भारत / Pilani (Raj., 333031 INDIA

Witness :

Signature: 

Name: PRASAD R. TANWAR

Designation: PRINCIPAL SCIENTIST.

Signature: 

Name: VIJAY CHATTERJEE

Designation: SCIENTIST




Principal

Annexure 1

MoU between RPS Group of Institution, Mahendragarh and CSIR-CEERI

Areas from RPS-GOI (but not limited to)	Areas from CSIR-CEERI (but not limited to)
<ol style="list-style-type: none">1. VLSI Design and CAD2. Machine Learning3. Sensor Design4. Imaging and Multimedia5. IoT and Smart Embedded systems	<ol style="list-style-type: none">1. ASIC Design, Post silicon validation, Embedded Systems and Real Time Embedded and IoT Applications2. Semiconductor processing technologies3. MEMS and Microfluidics based Sensor's design, fabrication and characterization4. Nano-sensors, Nano-devices and Advanced Packaging5. GaN-based Optoelectronic Devices and Photonics Crystal based Structures and Devices6. RF MEMS based Switches, Filters and Devices7. Computer Vision, Machine Learning and Artificial Intelligence Algorithms8. Signal Processing9. Instrumentation & Optimization Techniques10. IoT Technology and systems11. Cyber Physical Systems12. Power Electronics13. Microwave Devices

CSIR-CEERI, has expertise in semiconductor processes, device design and fabrication with state-of-the-art facilities and is planning to offer short duration training on same under Semiconductor High-Impact Learning Programme (SHILP) initiative. In UG/ PG/ PhD programs RPS-GOI offers Electronics courses with semiconductor, CMOS, VLSI Design and related fields as their constituents. Students from RPS-GOI, shall visit CSIR-CEERI to get a practical understanding of Semiconductor Design & Fabrication processes. This may be included, as part of their curriculum where students from each affiliated college shall get an opportunity to visit and execute semiconductor labs related training at CSIR-CEERI, as per CSIR Guidelines **on chargeable basis**. CSIR-CEERI shall demonstrate following to the students:

- Demonstration of Semiconductor Unit processes
- Unit process integration, to realize a devices/ device structure
- Unit Process Characterizations and
- Device characterization



CSIR-CEERI would offer a bouquet of programs with duration varying from one week to one month for UG and PG students of affiliated/ constituent institutes of RPS-GOI. A calendar of the courses and programs would be made available to the institutes. RPS-GOI, will proliferate it and motivate the target students to take maximum advantage of these facilities.

UG, PG and PhD students enrolled at RPS-GOI would be exposed to the facilities at CSIR-CEERI, in order to take suitable topics of their curriculum/ research where they can harness the facilities of CSIR-CEERI.

Under various schemes, RPS-GOI and CSIR-CEERI would coordinate joint Faculty Development Programs for the engineering teachers.

Principal
RPS College of Engg. & Tech.
Balana, Mahendragarh
Page 7 of 7

MEMORANDUM OF UNDERSTANDING
Between
ELEATION
AND
RAO PAHLAD SINGH GROUP OF INSTITUTIONS.

The following terms of service [the "Agreement"] will be effective from July 01, 2021

Between: ELEATION

Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan, Pune, Maharashtra – 411021

AND : RAO PAHLAD SINGH GROUP OF INSTITUTIONS

At Balana, 8th Milestone, Satnali-Mahendergarh Road, District Mahendergarh (HARYANA) PIN 123029

General Terms of services for ELEATION:

- ◆ For 2nd Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of Design Engineers"
 - ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial internship on CREO software with ELEATION.
 - ELEATION will provide Certificate of Training on CREO software.
 - ELEATION will provide Free licensed version software.
 - ELEATION will provide Internship letter, letter of recommendation and experience letter.
 - Based on Students interests ELEATION will conduct Paid Workshop (online/offline)

- ◆ For 3rd Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of CAE (Simulation / Analysis) Engineers"
 - ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial internship on ANSYS software with ELEATION.
 - ELEATION will provide Certificate of Training on ANSYS software.
 - ELEATION will provide Free licensed version software.
 - ELEATION will provide Internship letter, letter of recommendation and experience letter.
 - Based on Students interest ELEATION will conduct Paid Workshop (online/offline)

- ◆ For 4th Year – Mechanical, Civil, Production and Automobile Engineering students
 - ELEATION will conduct On-Campus Placement process to recruit / hire students from your college, as CAE Engineers for ELEATION Services Pvt. Ltd.
 - ELEATION will conduct FREE (online – Virtual or Offline – Physical) Expert Lecture on "Industry needs of CAE (Simulation / Analysis) Engineers"
 - ELEATION will conduct Internship Drive and select minimum 5 students to do FREE online (Self-learning) Training and Virtual Industrial internship on ANSYS software with ELEATION.
 - ELEATION will provide Certificate of Training on ANSYS software.
 - ELEATION will provide Free licensed version software.



Office Number 9, 3rd Floor, Pentium Residency,
Bhavdhan, Pune – Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email : spoorvbapat@eleation.com
www.eleation.com

K. Jyadav



K. Jyadav
Principal

R.P.S. College of Engg. & Tech
Balana Mahendergarh (HR.)

- ELEATION will provide Internship letter, letter of recommendation and experience letter.
- Based on Students interest ELEATION will conduct Paid Workshop (online/offline)

❖ For Faculties of Mechanical, Civil, Production and Automobile Engineering.

- ELEATION will conduct FREE Virtual Faculty Development Program on CAD (CREO) and CAE (ANSYS and HyperWorks Software) for all the faculties.
- ELEATION will provide Certificate of Faculty Development Program
- ELEATION will provide Certificate of Training
- ELEATION will provide Free Licensed Version Software to all the Faculties.

General Terms of services for RAO PAHLAD SINGH GROUP OF INSTITUTIONS:

- > College will provide faculty / Coordinator to organize expert lecture of 2nd, 3rd and 4th Year students
- > College will provide faculty / Coordinator to organize internship drive for 2nd, 3rd and 4th Year students.
- > College will provide faculty / Coordinator to organize on-campus Placement process for 4th Year students.

Notes :

- For Expert Lecture neither college nor ELEATION will charge any fees from Students.
- To organize expert lecture, internship drive and on-campus placement drive, college will share concern faculty / coordinator Name, Email ID, Mobile number and designation with ELEATION via Email.
- Paid workshop will only be organized based on student's interest after the Guest lecture conducted by ELEATION.
- Fees of Paid workshop will be decided by ELEATION and College and then informed to students.
- Fees of Paid workshop will be collected either by College or ELEATION based on mutual understanding.
- For organizing paid workshop ELEATION will share 10% of total collected fees with college.
- For Placement in ELEATION Company as CAE Engineer neither ELEATION nor college will charge any fees from Students.
- The term of MOU is for 4 Years from the date of executing the MOU.
- After 4 Years College and ELEATION will sign new MOU.
- ELEATION will attend (if needed) any government body meetings in college (Physically / virtually), required for College level accreditation by Government bodies.
- To terminate this service of Agreement, College and/or ELEATION has to send official mail to concern person responsible for the MOU.
- College can use ELEATION logo for any (marketing) activities.
- While using ELEATION logo for any (marketing) activities, college has to inform ELEATION via send a mail to official email ID of ELEATION mentioned on this service agreement.

To,
ELEATION,
Office Number 9, 3rd Floor, Pentium Residency, Bhavdhan,
Pune - Maharashtra
411021
For and on Behalf of ELEATION

Signature and Seal

Name: Apoorv Bapat
Designation: CEO and Founder



Office Number 9, 3rd Floor, Pentium Residency,
Bhavdhan, Pune - Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email : apoorvbapat@eleation.com
www.eleation.com

Handwritten signature of Apoorv Bapat

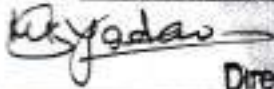


Handwritten signature of Prakash
Prakash
R.P.S. College of Engg. & Tech
Balajinagar, (HR.)

Mobile Number: 7720040021 / 7387403493
Official Email ID: apoorvbapat@eleation.com

To,
RAO PAHLAD SINGH GROUP OF INSTITUTIONS
At Balana, 8th Milestone, Satnali-Mohindergarh Road, District Mahendergarh (HARYANA) PIN 123029

For and on Behalf of Rao Pahlad Singh Group Of Institutions



Director

Signature / Seal

R.P.S Group of Institutions
Balana, Mohindergarh
(Haryana)

Name: Dr. Mahesh K Yadav

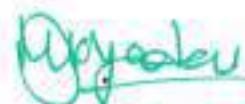
Designation: Director

Mobile Number: 8053117441

Official Email ID: principal@rpsinstitutions.org



Office Number 9, 3rd Floor, Pentium Residency,
Bhavdhan, Pune - Maharashtra - 411021
Mob: 7720040021 / 7387403493
Email : apoorvbapat@eleation.com
www.eleation.com



Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR)



ELEATION's Sign-up Confirmation

1 message

apoorvbapat@eleation.com <apoorvbapat@eleation.com>
To: placement@rpsinstitutions.org

Fri, Jun 18, 2021 at 11:04 AM

Dear Satyavir Sharma,

Greeting from ELEATION.

Thanks for showing interest in ELEATION.

I would like to inform you that you have successfully completed your signup process.

Please use : https://eleation.com/my_account/login.php

Username : placement@rpsinstitutions.org

Password : 9099177745

Note : This is an auto-generated mail, if you need any update/information from us feel free to contact us via

apoorvbapat@eleation.com

query@eleation.com

support@eleation.com

hr@eleation.com

or reach us via

+91-7720040021

+91-7387403493

ELEATION's ANSYS (CAE) Basic To Professional Training Program:

Complete Process Video : <https://youtu.be/gEIJYlpjto>

Course Content : https://eleation.com/courses/ansys/course_content/

Registration Process : <https://eleation.com/courses/ansys/about>

Course Fees : INR 1000/- (Self Learning - Recorded Video Based Training Program)

ANSYS Software Setup and license download link : <https://www.ansys.com/en-in/academic/free->

student-products

ELEATION's HyperWorks (CAE) Basic to Professional Training Program

Complete Process Video : <https://youtu.be/n0sIJXabMic>

Course Content : https://eleation.com/courses/hyperworks/course_content/

Registration Process : <https://eleation.com/courses/hyperworks/about/>

Course Fees : INR 1000/- (Self Learning - Recorded Video Based Training Program)

HyperWorks Software Setup and license download link : <https://altairuniversity.com/free-altair->

student-edition/

ELEATION's CREO (CAD) Basic to Professional Training Program

Complete Process Video : <https://youtu.be/EiqETyship4>

Course Content : https://eleation.com/courses/creo/course_content/

Registration Process : <https://eleation.com/courses/creo/about/>

Course Fees : INR 1000/- (Self Learning - Recorded Video Based Training Program)

CREO Software Setup and license download link : <https://www.ptc.com/en/academic->

program/academic-products/free-software/creo-college-download

ELEATION's CAD(CREO) Contest : 2nd Edition

Complete Process Video : <https://youtu.be/8oyOBufXn-g>

Course Content : https://eleation.com/contest/cad/course_content.php

Registration Process : https://eleation.com/contest/cad/complete_process.php

Registration Fees : INR 1500/- (Register now to get INR 500/- off)

CREO Software Setup and license download link : <https://www.ptc.com/en/academic->

program/academic-products/free-software/creo-college-download



M. J. G. D.
Principal
R.P.S. College of Engg. & Tech
Balaria, Mohindergarh (HR.)

ELEATION's CAE Contest : 3rd Edition

Complete Process Video : <https://youtu.be/xQ7d78rALQQ>

Course Content : https://elevation.com/contest/cae/course_content.php

Registration Process : https://elevation.com/contest/cae/complete_process.php

Registration Fees : INR 1500/- (Register now to get INR 500/- off)

ANSYS Software Setup and license download link : <https://www.ansys.com/en-in/academic/free-student-products>

academic/free-student-products

ELEATION's Placement Process :

Please use the below link to know the detailed placement process.

https://elevation.com/dashboard/hiring/complete_process/

Please use the below link to apply for the same

<https://elevation.com/dashboard/hiring/>

Please use the below link to download ELEATION's Mobile Application

<https://play.google.com/store/apps/details?id=com.elevation.elevation>

Follow us on :

Twitter : @apoorvbapat

LinkedIn : ELEATION

Facebook : ELEATION - By Apoorv Bapat

Instagram : elevation_apoorv_bapat

YouTube : ELEATION By Apoorv Bapat

Regards

Apoorv Bapat

Founder and CEO

ELEATION

7720040021 / 787403493



K. S. Yadav
Principal

RPS College of Engg. & Tech
Baidya Narayan (M.R.)

ELEATION's Internship Drive : Complete Process : RPS Group of Institutions

HR ELEATION <hr@eleation.com>
To: placementrps@gmail.com
Cc: placement@rpsinstitutions.org

Fri, Jun 18, 2021 at 1:05 PM

Dear Satyavir Sharma,

Greetings from ELEATION...!!!

Thanks for showing interest in ELEATION's Virtual Internship Drive for 2nd and 3rd Year Mechanical, Civil, Production and Automobile Engineering Students.

PLEASE SHARE THE BELOW DETAILS AND ALL THE 3 ATTACHMENTS WITH 2ND AND 3RD YEAR STUDENTS OF MECHANICAL, CIVIL, PRODUCTION AND AUTOMOBILE ENGINEERING BRANCH.

Please use the below YouTube link containing the video in which we have explained :

<https://youtu.be/5yanfR6G5Yc>

- ❖ Who we are ? (About ELEATION Company)
- ❖ What is CAE – Computer Aided Engineering
- ❖ Difference between CAD and CAE
- ❖ Why to learn CAE software?
- ❖ About ELEATION's Training and Internship Program
- ❖ How to Download Certificate of attendance
- ❖ How to Register and attend the ELEATION's Internship Online Test
- ❖ How to start the training and Internship Program
- ❖ Questions and Answer

Key Features of ELEATION's Virtual Internship Process :

- ❖ Complete Training on ELEATION's ANSYS Basic To Professional Training Program.
- ❖ Industrial Internship Project on CAE
- ❖ ELEATION's ANSYS Basic To Professional Training Program : Certificate.
- ❖ Internship Letter
- ❖ Letter of recommendation
- ❖ Experience letter
- ❖ Free Licensed Version Software.



M. Prasad
Principal

R.P.S. College of Engg. & Tech
Balana, Mohindergarh (H.K.)

ernship Drive is Schedule on : 02-07-2021

Students can attend the online internship test anytime from 10 AM to 5 PM.

How to Register and attend the Online Test :

1. Open www.eleation.com
2. Click on Login (if you are existing user on ELEATION's Website) or click on Signup (if you are new user on ELEATION's Website)
3. Once you are logged in to ELEATION's website, then on Students dashboard page click on College Test button
4. Then Click on Register Button
5. Then Enter the College Code : ELPL2007, and other details and click on register
6. On 02-07-2021 any time between 10 AM to 5 PM, Click on Start Test Button
7. Once you complete the test you can view the score using View score button.

er 48 Hours from the test end time we will share the results and further process with all the students and college faculty.

Please find the attached PDF containing :

- > How to Register and Attend the ELEATION's Internship Online test
- > How to Start Virtual (online) Training and Internship Program
- > General Questions and Answers.

ELEATION's Online test Details :

1. ELEATION's Training and Internship Selection Test Duration is 60 Minutes.
2. Students can start the test anytime between 10 AM to 5 PM – as per your convenience.
3. Total Marks of ELEATION's Training and Internship Online Test is 100
4. Total Number of Questions are 50.
5. All the questions will be multiple choice questions.
6. All the questions will be from general aptitude, strength of material and mechanics
7. Top 5 students from each college will be selected from ELEATION's Training and Internship Online Test.
8. Selected students will have 100% Free Lifetime access to complete Training of ELEATION's ANSYS Basic To Professional Training Program.

If you need any update/information from us feel free to contact us.

Regards,

Apoorv Bapat

Founder and CEO

ELEATION

+91-7387403493



Mujpadaw
Apoorv Bapat


RPS College of Engg. & Tech.
Balaharipur


20040021


www.eleation.com

Share your reviews

3 attachments

 General Questions and Answers.pdf
521K

 How to Register and Attend the ELEATION's Internship Online test.pdf
1349K

 How to Start Virtual (online) Training and Internship Program.pdf
1640K



M. Yadav
Principal

T.P.S. College of Engg. & Tech.
Balana Mohindergarh (HR)

MEMORANDUM OF UNDERSTANDING (MoU)

BETWEEN

**Rao Pahlad Singh Group of Institutions
AND
KHUSHBU ENTERPRISE**

This Memorandum of Understanding (hereinafter called as the 'MoU') is entered into on this theday of September Month 2021 between Rao Pahlad Singh Group of Institutions, the First Party represented herein by its Director, **Dr. Mahesh K. Yadav**, and KHUSHBU ENTERPRISE the Second party, and represented herein by its Centre Head / Director / Managing Director, **Halder Hussain Shaikh**,

WHEREAS:

- A) First Party is a Higher Educational Institution named: **Rao Pahlad Singh Group of Institutions**
- B) First Party & Second Party believe that collaboration and co-operation between themselves will promote more effective use of each of their resources, and provide each of them with enhanced opportunities.
- C) The Parties intent to cooperate and focus their efforts on cooperation within area of Skill Based Training, Education, Placement, Industrial Visit, Expert Lecture.
- D) **Khushbu Enterprise** the Second Party is engaged in Service Sectors, Construction and Real Estate of Government as well as Corporate Sectors

NOW THEREFORE, IN CONSIDERATION OF THE MUTUAL PROMISES SET FORTH IN THIS MOU, THE PARTIES HERETO AGREE AS FOLLOWS:

CLAUSE 1

CO-OPERATION



- 1.4 Both Parties are united by common interests and objectives, and they shall establish co-operation.
- 1.5 First Party and Second Party co-operation will facilitate effective utilization of the intellectual capabilities.
- 1.6 The parties shall co-operate with each other and shall as promptly as is responsibly practical, relevant agreement.

CLAUSE 2



M. K. Yadav

SCOPE OF THE MoU

M. K. Yadav
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

2.1 Industrial Training & Visits: Industry and Institution interaction will provide an insight into the latest developments / requirements of the industries; the Second Party to permit the Faculty and Students of the First Party to visit its group companies and also involve in Industrial Training Programs for the First Party. This will provide confidence & smooth transition for students work. Also the Second party may register on the AICTE Internship Portal for the benefit of students.

2.2 Guest Lectures: Second Party to extend the necessary support to deliver guest lecturers to the students of the First Party on the technology trends and in house requirements.

2.3 Placement of trained students: second party will actively engage to help the delivery of the training and placement of the students of the first party on the technology trends and in house requirements.

2.4 There is no financial commitment on the part of the **Rao Pehlad Singh Group of Institutions** the first party to take up any program mention in MoU. If there is any financial consideration, it will be dealt separately.

2.5 Both Parties to obtain all internal approvals, consents, permissions, and licenses of whatsoever nature required.

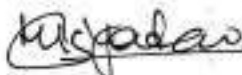
CLAUSE 3 VALIDITY

3.1 This Agreement will be valid until it is expressly terminated by either Party on mutually agreed terms, during which period, the Second Part.

CLAUSE 4 RELATIONSHIP BETWEEN THE PARTIES

5.1 It is expressly agreed that First Party and Second Party are acting under this MOU as independent contractors, and the relationship established under this MOU shall not be construed as a partnership.

First Party



Director



Second Party

KHUSHBU ENTERPRISES


Centre Head

Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

MEMORANDUM OF UNDERSTANDING (MoU)

BETWEEN

**Rao Pahlad Singh Group of Institutions, Mohindergarh
AND
Clariant IGL Specialty Chemicals Private Limited**

This Memorandum of Understanding (hereinafter called as the 'MoU') is entered into on this the 24th day of September 2021 by and between.

Rao Pahlad Singh Group of Institutions, the First Party represented herein by its Director, **Dr. Mahesh K. Yadav**, And **Clariant IGL Specialty Chemicals Private Limited**, the second party, and represented herein by its HR Head & Factory Manager, **Ajay Kumar**.

WHEREAS:

- A) First Party is a Higher Educational Institution named: **Rao Pahlad Singh Group of Institutions**
- B) First Party & Second Party believe that collaboration and co-operation between themselves will promote more effective use of each of their resources, and provide each of them with enhanced opportunities.
- C) The Parties intent to cooperate and focus their efforts on cooperation within area of Skill Based Training, Education, Placement, Industrial Visit, Expert Lecture.
- D) **Clariant IGL Specialty Chemicals Private Limited**, the Second Party is engaged in manufacturing of Bulk Chemicals.

NOW THEREFORE, IN CONSIDERATION OF THE MUTUAL PROMISES SET FORTH IN THIS MOU, THE PARTIES HERETO AGREE AS FOLLOWS:

CLAUSE 1 CO-OPERATION

- 1.1 Both Parties are united by common interests and objectives, and they shall establish co-operation.
- 1.2 First Party and Second Party co-operation will facilitate effective utilization of the intellectual capabilities.
- 1.3 The parties shall co-operate with each other and shall as promptly as is responsibly practical, relevant agreement.

CLAUSE 2 SCOPE OF THE MoU

2.1 Industrial Training & Visits: Industry and Institution interaction will provide an insight into the latest developments / requirements of the industries; the Second Party to permit the Faculty and Students of the First Party to visit its group companies and also involve in Industrial Training Programs for the First Party. This will provide confidence & smooth transition for students work. Also the Second party may register on the AICTE Internship Portal for the benefit of students.



2.2 Guest Lectures: Second Party to extend the necessary support to deliver guest lecturers to the students of the First Party on the technology trends and in house requirements.

2.3 Placement of trained students: second party will actively engage to help the delivery of the training and placement of the students of the first party on the technology trends and in house requirements.

2.4 There is no financial commitment on the part of the **Clariant IGL Specialty Chemicals Private Limited**, the first party to take up any program mention in MoU. If there is any financial consideration, it will be dealt separately.

2.5 Both Parties to obtain all internal approvals, consents, permissions, and licenses of whatsoever nature required.

CLAUSE 3

VALIDITY

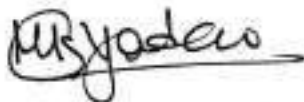
3.1 This Agreement will be valid until it is expressly terminated by either Party on mutually agreed terms, during which period, the Second Part.

CLAUSE 4

RELATIONSHIP BETWEEN THE PARTIES

4.1 It is expressly agreed that First Party and Second Party are acting under this MOU as independent contractors, and the relationship established under this MOU shall not be construed as a partnership.

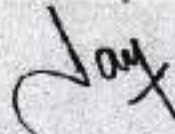
First Party



Dr. Mahesh K. Yadav
Director
RPS Group of Institutions, Mohindergarh



Second Party



Ajay Kumar
HR Head & Factory Manager
Clariant IGL Specialty Chemicals Pvt Ltd



Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

MEMORANDUM OF UNDERSTANDING (MoU)

BETWEEN

Rao Pahlad Singh Group of Institutions, Mohindergarh
AND
India Glycols Limited - Kashipur

This Memorandum of Understanding (hereinafter called as the 'MoU') is entered into on this the 24th day of September 2021 by and between.

Rao Pahlad Singh Group of Institutions, the First Party represented herein by its Director, Dr. Mahesh K. Yadav, And India Glycols Limited-Kashipur. The second party, and represented herein by its HR Head & Factory Manager, Mr. Rakesh Kumar.

WHEREAS:

A) First Party is a Higher Educational Institution named: **Rao Pahlad Singh Group of Institutions**

B) First Party & Second Party believe that collaboration and co-operation between themselves will promote more effective use of each of their resources, and provide each of them with enhanced opportunities.

C) The Parties intent to cooperate and focus their efforts on cooperation within area of Skill Based Training, Education, Placement, Industrial Visit, Expert Lecture.

D) India Glycols Limited-Kashipur, - the Second Party is engaged in manufacturing of green technology based bulk, specialty and performance chemicals and natural gums, spirits, Sanitizer & industrial gases.

NOW THEREFORE, IN CONSIDERATION OF THE MUTUAL PROMISES SET FORTH IN THIS MOU, THE PARTIES HERETO AGREE AS FOLLOWS:

CLAUSE 1

CO-OPERATION

- 1.1 Both Parties are united by common interests and objectives, and they shall establish co-operation.
- 1.2 First Party and Second Party co-operation will facilitate effective utilization of the intellectual capabilities.
- 1.3 The parties shall co-operate with each other and shall as promptly as is responsibly practical, relevant agreement.

CLAUSE 2

SCOPE OF THE MoU

2.1 Industrial Training & Visits: Industry and Institution interaction will provide an insight into the latest developments / requirements of the industries; the Second Party to permit the Faculty and Students of the First Party to visit its group companies and also involve in Industrial Training Programs for the First Party. This will provide confidence & smooth transition for students work. Also the Second party may register on the AICTE Internship Portal for the benefit of students.

M. Yadav



M. Yadav
Principal
R.P.S. College of Engg. & Tech.
Batala Mohindergarh (H)



2.2 Guest Lectures: Second Party to extend the necessary support to deliver guest lecturers to the students of the First Party on the technology trends and in house requirements.

2.3 Placement of trained students: second party will actively engage to help the delivery of the training and placement of the students of the first party on the technology trends and in house requirements.

2.4 There is no financial commitment on the part of the India Glycols Limited -Kashipur, the first party to take up any program mention in MoU. If there is any financial consideration, it will be dealt separately.

2.5 Both Parties to obtain all internal approvals, consents, permissions, and licenses of whatsoever nature required.

CLAUSE 3

VALIDITY

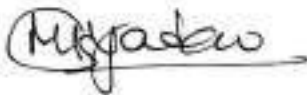
3.1 This Agreement will be valid until it is expressly terminated by either Party on mutually agreed terms, during which period, the Second Part.

CLAUSE 4

RELATIONSHIP BETWEEN THE PARTIES

5.1 It is expressly agreed that First Party and Second Party are acting under this MOU as independent contractors, and the relationship established under this MOU shall not be construed as a partnership.

First Party



Dr. Mahesh K. Yadav
Director
RPS Group of Institutions, Mohindergarh

Second Party



Rakesh Kumar
HR Head & Factory Manager
India Glycols Limited- Kashipur



Principal
R.P.S. College of Engg. & Tech
Bahadur Nagar, Mohindergarh (HR.)

MEMORANDUM OF UNDERSTANDING (MoU)

BETWEEN

**Rao Pahlad Singh Group of Institutions
AND
Noor Electricals**

This Memorandum of Understanding (hereinafter called as the 'MoU') is entered into on this the 23rd day of September 2021 by NOOR Electricals and between Rao Pahlad Singh Group of Institutions, the First Party represented herein by its Director, Dr. Mahesh K. Yadav, And NOOR Electricals the Second party, and represented herein by its Centre Head / Director / Managing Director Mohammad Hussain Shaikh.

WHEREAS:

- A) First Party is a Higher Educational Institution named: **Rao Pahlad Singh Group of Institutions**
- B) First Party & Second Party believe that collaboration and co-operation between themselves will promote more effective use of each of their resources, and provide each of them with enhanced opportunities.
- C) The Parties Intent to cooperate and focus their efforts on cooperation within area of Skill Based Training, Education, Placement, Industrial Visit, Expert Lecture.
- D) **Noor Electricals** the Second Party is engaged in Construction and Real Estate

NOW THEREFORE, IN CONSIDERATION OF THE MUTUAL PROMISES SET FORTH IN THIS MOU, THE PARTIES HERETO AGREE AS FOLLOWS:

CLAUSE 1

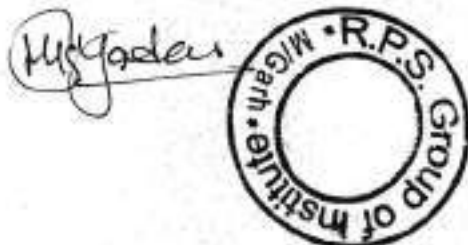
CO-OPERATION

- 1.1 Both Parties are united by common interests and objectives, and they shall establish co-operation.
- 1.2 First Party and Second Party co-operation will facilitate effective utilization of the intellectual capabilities.
- 1.3 The parties shall co-operate with each other and shall as promptly as is responsibly practical, relevant agreement.

CLAUSE 2

SCOPE OF THE MoU

2.1 Industrial Training & Visits: Industry and Institution interaction will provide an insight into the latest developments / requirements of the industries; the Second Party to permit the Faculty and Students of the First Party to visit its group companies and also involve in Industrial Training Programs for the First Party. This will provide confidence & smooth transition for students work. Also the Second party may register on the AICTE Internship Portal for the benefit of students.



Principal
R.P.S. College of Engg. & Tech
Baramulla Mohindergarh (HR.)

2.2 Guest Lectures: Second Party to extend the necessary support to deliver guest lecturers to the students of the First Party on the technology trends and in house requirements.

2.3 Placement of trained students: second party will actively engage to help the delivery of the training and placement of the students of the first party on the technology trends and in house requirements.

2.4 There is no financial commitment on the part of the **Rao Pehlad Singh Group of Institutions** the first party to take up any program mention in MoU. If there is any financial consideration, it will be dealt separately.

2.5 Both Parties to obtain all internal approvals, consents, permissions, and licenses of whatsoever nature required.

CLAUSE 3

VALIDITY

3.1 This Agreement will be valid until it is expressly terminated by either Party on mutually agreed terms, during which period, the Second Part.

CLAUSE 4

RELATIONSHIP BETWEEN THE PARTIES

5.1 It is expressly agreed that First Party and Second Party are acting under this MOU as independent contractors, and the relationship established under this MOU shall not be construed as a partnership.

First Party

Kuryadan

Director



Second Party

NOOR ELECTRICAL

Datta
Centre Head



Kuryadan
Principal

R.P.S. College of Engg. & Tech
Baliana, Mohinderghar (HP.)

MEMORANDUM OF UNDERSTANDING (MoU)

BETWEEN

Rao Pahlad Singh Group of Institutions, Mohindergarh
AND
Sona Mandhira Pvt. Ltd., IMT Manesar

This Memorandum of Understanding (hereinafter called as the 'MoU') is entered into on this the 4th day of October 2021 by and between Rao Pahlad Singh Group of Institutions, the First Party represented herein by its Director, Dr. Mahesh K. Yadav, and Sona Mandhira Pvt. Ltd., Plot 30, Sector 5, IMT Manesar, the second party, and represented herein by its Head HR & Admin, Vikas Yadav.

WHEREAS:

- A) First Party is a Higher Educational Institution named: **Rao Pahlad Singh Group of Institutions**
- B) First Party & Second Party believe that collaboration and co-operation between themselves will promote more effective use of each of their resources, and provide each of them with enhanced opportunities.
- C) The Parties intent to cooperate and focus their efforts on cooperation within area of Skill Based Training, Education, Placement, Industrial Visit, Expert Lecture.
- D) Sona Mandhira Pvt. Ltd, the Second Party is engaged in the manufacture and distribution of wide range of parts for passenger cars/SUV, utility vehicles and small commercial vehicles.

NOW THEREFORE, IN CONSIDERATION OF THE MUTUAL PROMISES SET FORTH IN THIS MOU, THE PARTIES HERETO AGREE AS FOLLOWS:

CLAUSE 1

CO-OPERATION

- 1.1 Both Parties are united by common interests and objectives, and they shall establish co-operation.
- 1.2 First Party and Second Party co-operation will facilitate effective utilization of the intellectual capabilities.
- 1.3 The parties shall co-operate with each other and shall as promptly as is responsibly practical, relevant agreement.

CLAUSE 2

SCOPE OF THE MoU

- 2.1 Industrial Training & Visits: Industry and Institution interaction will provide an insight into the latest developments / requirements of the industries; the Second Party to permit the Faculty and Students of the First Party to visit its group companies and also involve in Industrial Training Programs for the First Party. This will provide confidence & smooth transition for students work. Also the Second party may register on the AICTE Internship Portal for the benefit of students.
- 2.2 Guest Lectures: Second Party to extend the necessary support to deliver guest lecturers to the students of the First Party on the technology trends and in house requirements.



Mahesh K. Yadav
Principal
R.P.S. College of Engg. & Tech.
Batana Mohindergarh (Hr.)



2.3 Placement of trained students: second party will actively engage to help the delivery of the training and placement of the students of the first party on the technology trends and in house requirements.

2.4 There is no financial commitment on the part of the **Sona Mandhira pvt. Ltd**, the first party to take up any program mention in MoU. If there is any financial consideration, it will be dealt separately.

2.5 Both Parties to obtain all internal approvals, consents, permissions, and licenses of whatsoever nature required.

CLAUSE 3

VALIDITY

3.1 This Agreement will be valid until it is expressly terminated by either Party on mutually agreed terms, during which period, the Second Part.

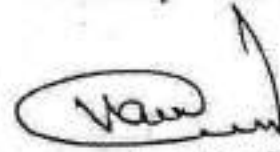
CLAUSE 4

RELATIONSHIP BETWEEN THE PARTIES

5.1 It is expressly agreed that First Party and Second Party are acting under this MOU as independent contractors, and the relationship established under this MOU shall not be construed as a partnership.

First Party

Second Party



Dr. Mahesh K. Yadav
Director
RPS Group of Institutions, Mohindergarh

Vikas Yadav 08/10/2021
Head HR & Admin
Sona Mandhira pvt. Ltd, IMI, Gurugram




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



Training & Placement at RPSGOI

Dear Ravindra Ji, As per our discussion I am forwarding MoU duly signed by our Group Director Dr. M K Yadav. Please find the attached pdf file. Kindly revert back to Puneet, Mr. Mahesh, Devendra

Dec 30, 2019
4:35 PM (GMT+05:30)

Dear Vikas Ji,
Greetings of the day!!

Trust the entire RPS Family is healthy and safe during this critical time.

It was nice speaking with you over the phone to discuss possibilities for collaboration. Thanks for sharing the signed MoU. In continuation of the same I'm forwarding the MoU. Please find attached the same.

AIC-MUJ is working under the Atal Innovation Mission of NITI Aayog, Govt. of India. AIC-MUJ supports and encourage innovative technology-based start-ups and/or Impact in the core sectors of the economy. We would provide the start-ups with necessary guidance, tech support, infrastructure, access to invest facilitating a host of other resources that may be required for the start-up to survive and scale.

Just to give you a background, the Manipal Education and Medical Group is an established leader in the field of education, research and healthcare. In a span of 50 years, it has transformed the lives of more than 3,00,000 students from over 59 countries. The group includes five Universities - Manipal Academy of Higher Education, Manipal University (Sikkim), American University of Antigua (Caribbean Islands), Manipal International University (Malaysia) and Manipal University Jaipur.


I trust we will work together to strengthen and promote the Innovation Eco-System for young students and Start-ups of tomorrow.

With Best Regards
Ravindra Yadav
Community Manager
Atal Incubation Centre- MUJ
(supported by NITI Aayog, Atal Innovation Mission, Govt)



Jaipur-Ajmer Express Highway | Dehmi Kalan | Jaipur | Rajasthan 303007 | India




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

Memorandum of Understanding

Between

Atal Incubation Centre- Manipal University Jaipur



And

Rao Pahlad Singh Group of Institutions, Mahendragarh



R. P. S. G.
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

MEMORANDUM OF UNDERSTANDING

This Memorandum of Understanding (hereinafter referred to as "MOU") is executed on the day of 1st January 2022 at Jaipur/ Mahendragarh.

BY AND BETWEEN

Atal Incubation Centre-Manipal University Jaipur, (hereinafter referred to as "AIC MUJ Incubation Foundation"), (Atal Incubation Centre at Manipal University Jaipur which is supported by Atal Innovation Mission, NITI Aayog) is promoted by Manipal University Jaipur for supporting and promoting innovation and entrepreneurship. AIC MUJ Incubation Foundation is registered as a Section 8, Company under The Companies Act 2013, having its registered office at Jaipur-Ajmer Express Highway, Dehmi Kalan, Near GVK Toll Plaza, Jaipur, Rajasthan 303007. AIC-MUJ I F is an Incubation Centre in academic institution promoting and nurturing Incubation and Entrepreneurship by providing support and environment for conceiving, realizing, promoting and nurturing entrepreneurship culture and development of knowledge-based entrepreneurship amongst Students, Faculty & Staff of the institution and other institutes as well as any other aspiring entrepreneurs in Rajasthan leading to successful ventures.

AND

Rao Pahlad Singh Group of Institutions, Balana, a Technical Institute incorporated under Rao Pahlad Singh Education Society, approved by AICTE (New Delhi) and affiliated to I. G. U. Rewari having its registered office at Balana, Satnali Road, Mahendragarh, Haryana-123029 India; hereinafter referred to as "RPSGOI" which term shall excluded included their successors and permitted assigns, of the OTHER PART.





Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

"AIC-MUIIF" and "Rao Pahlad Singh Group of Institutions, Balana, Mahendragarh" are collectively referred to herein as the "Parties" and individually referred to as a "Party"


WHEREAS:

- A. The Parties shall jointly organize various activities related to development of Startups, Entrepreneurship and Innovation environment in the state of Rajasthan targeting grass root Innovators and entrepreneurs.
- B. The Parties have recognized various domains of entrepreneurship management and technology, on which they tend to work jointly towards creating various platforms and support structures for Startups and Entrepreneurs. Some of the joint activities might be, but not restricted to above can be:
- To promote the cultural of Startups in the institutions and nearby area.
 - Mentoring the existing Startups in business development, financial planning and other sectors.
 - Knowledge sharing programs with students and teachers.
 - Joint Hackathons, competitions and other platforms which promote the culture of Innovation and Entrepreneurship within the students of the institutions.
 - Conduct Entrepreneurship Development Programs jointly in collaboration with other institutions as per need.
 - Knowledge exchange: Learning and Sharing best practices on Innovation and Startups Ecosystem development at Micro and Macro level.
 - Identification of further collaborations
 - Providing Incubation support.
- C. The Parties recognize the vital importance of the collaboration in the Entrepreneurship, Innovation and Incubation space.

In order to promote future institutional cooperation and collaboration between them, the Parties hereto wish to enter into this Memorandum of Understanding ("MOU").

NOW THEREFORE, THE PARTIES HEREBY, CONFIRM AND ACKNOWLEDGE THAT:




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

1. **Objective.** The objective of this MOU is to outline the possible ways in which AIC- MUJ I F and Rao Pahlad Singh Group of Institutions, Balana, Mahendragarh could develop, support and promote Innovation and entrepreneurs. To provide platform to startup and prospective entrepreneurs for converting their innovative ideas into commercially viable products.
2. **Scope of Activities.** AIC-MUJ I F and Rao Pahlad Singh Group of Institutions, Balana, Mahendragarh could develop joint programs to provide support to other technical institutions in India to design Incubation Programs towards promotion of startup entrepreneurship in the country.

The scope of collaboration under this MOU may include, but not limited to, the following:

I. Deliverables of RPSGOI:

- Provide opportunity for faculties, professors and students to create awareness on Innovation, Entrepreneurship and Startups with support of AIC MUJ I F.
- In house infrastructure and incubation support facilitated by AIC MUJ I F.
- Organizing Joint Events to promote Innovation, Entrepreneurship and Startups
- Infrastructure support for various events.

II. Deliverables of AIC MUJ I F:

- Incubation support for faculties, staff, students and Startups.
- Creating awareness on Innovation, Entrepreneurship and Startups.
- Exposure to various mentors for Startups.
- Exposure to funding agencies eg. Angel Investors, Venture Capitalists.
- Connecting to Industry and Domain to Startups.
- To provide co-working space and fabrication lab to Startups.
- Preference to Startups, nominated by the institute.




3. **Tenure of MOU:** This MOU is valid subject fulfilment, for a period of 1(one) year from the date of signing the MOU. However it may be extended or amended with the mutual consent of the parties and may be terminated by either party by giving a prior written notice of one month to the other party.


Principal
R.P.S. College of Engg. & Tech
Balana, Mohindergarh (HR.)

4. **Not Legally Binding.** This MOU is not intended to be and is not to be construed as a legally binding agreement. Signing of this MOU does not result in any material, financial or other obligation for either of the parties hereto. By signing this MOU, the parties are signifying their desire for future collaboration. Specific initiatives may be considered and agreed upon, on a case by case basis, including the contributions and obligations of each institution. Subsidiary MOU may be signed as required.
5. While this MOU in no way restricts either party from participating with other agencies, organizations and individuals on similar arrangements or other memorandum of understanding, the Parties agree and acknowledge that such other MOU shall not conflict and/or impinge upon a Party's ability to effectively fulfil its responsibilities under this MOU.
6. Neither party, without the express prior consent of the other party, shall use trademarks, service marks, proprietary words or symbols of the other party.
7. Except for claims of intellectual property infringement or breach of confidentiality obligations, in no event shall either Party be liable to the other Party for any lost profits or savings, lost business, loss of data, loss of revenue, loss of use or money, loss of business, loss of opportunity or any incidental, special, indirect, or consequential damages (whether or not also constituting one of the foregoing specific types of loss), whether based on breach of contract, tort (including without limitation negligence), or otherwise and whether or not such Party has been advised of the possibility of such damage.
8. Both parties agree that they may be required to share some confidential information during their collaboration. The Parties agree to not to share such confidential information with any other third party as long as the information was indicated to be such at the time of sharing.




Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

This MOU shall be governed by Laws of India and the Courts at Jaipur (Rajasthan) alone.

Shall have exclusive jurisdiction in respect of any or all matters/disputes relating to or connected with this MOU.

IN WITNESS WHEREOF the parties have executed this MOU by their respective duly authorized representatives as of the day and year first above written.

Director
Sudhakar
R.P.S. Group of Institutions
Balana, Mohindergarh (HR.)
For and on behalf of
Rao Pahlad Singh Group of Institutions,
Balana, Mahendragarh

Punit
For and on behalf of
AIC-MUJIF



Principals
Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)

SAYLOR ACADEMY AND RAO PAHLAD SINGH GROUP OF INSTITUTIONS
SUPPLEMENTAL SKILL DEVELOPMENT AGREEMENT

This Skill Development Agreement ("Agreement") is made effective as of January 2022 by and between The Constitution Foundation d/b/a the Saylor Academy ("Saylor"), a not-for-profit foundation with a representative office in Annapolis, Maryland, USA and Rao Pahlad Singh Group of Institutions refer as RPS GOI an accredited institution of higher education located in Haryana, India. Saylor and may hereinafter be referred to individually as a "Party" or, collectively, as the "Parties".

Whereas, RPS Group of Institutions, is an accredited, recognized leader in providing high-quality, collegiate learning opportunities; and

Whereas, Saylor, a respected open education provider that, among other things, builds freely available college level courses, desires to provide no cost skills training to people around the world; and

Whereas, RAO PAHLAD SINGH GROUP OF INSTITUTIONS and Saylor desire to work together to provide new pathways to increase access to higher education and otherwise develop innovative solutions toward that end.

NOW, THEREFORE, in exchange for the non-financial promises and covenants herein, intending to be mutually bound, Saylor and RPS GROUP OF INSTITUTIONS, now agree to this supplemental skill development partnership. The principal terms of this Agreement follow.

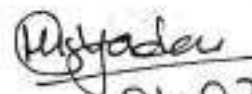
1. RESPONSIBILITIES.

(a) RAO PAHLAD SINGH GROUP OF INSTITUTIONS agrees to inform its students about Saylor's free courses to enable them to learn additional skills to supplement their degree program learning. RAO PAHLAD SINGH GROUP OF INSTITUTIONS will provide Saylor with a list of courses it recommends to its students that Saylor may post on its website on a dedicated landing page.

(b) Saylor will (1) create a dedicated landing page for RAO PAHLAD SINGH GROUP OF INSTITUTIONS students to direct them to the selected courses; (2) provide RAO PAHLAD SINGH GROUP OF INSTITUTIONS with student participation and completion date on a quarterly basis; and (3) inform RAO PAHLAD SINGH GROUP OF INSTITUTIONS students about the process for them follow to submit their completed certificates to designated officials at RPS GROUP OF INSTITUTIONS.

2. Intellectual Property and Usage.

(a) License of Marks. Saylor and RAO PAHLAD SINGH GROUP OF INSTITUTIONS will license to the other Party on a royalty-free, non-exclusive basis


01.02.2022


Principal

R.P.S. College of Engg. & Tech
Balana Mohinderghar (HR.)

the right to use its applicable Marks (as defined below) solely for the purpose of fulfilling such party's obligations with respect to this Agreement, provided that such license shall automatically terminate upon termination of this Agreement without the requirement of further notices or any other action by any Party. For the purposes hereof, "Marks" shall mean a Party's trademarks, trade names, service marks and/or logos provided to the other Party for the business purposes outlined herein, or such additional or replacement Marks as either Party may permit in writing the other Party to use solely in connection with the performance of this Agreement. Saylor will review the specifications and guidelines for all RAO PAHLAD SINGH GROUP OF INSTITUTIONS symbols and marks contained in the graphic identity manual provided. The marks contained in this manual are the only marks which are authorized for use and are not to be altered in any way.

(b) Usage.

The parties may display trademarks, trade names, service marks and/or logos provided by the other Party solely to promote this transfer acceptance agreement.

3. Student Privacy.

RAO PAHLAD SINGH GROUP OF INSTITUTIONS and Saylor will protect student privacy in a professional manner with due care and skill in accordance with their respective privacy policies and all applicable laws.

4. Term and Termination.

(a) This Agreement will have a three (3) year term commencing upon execution hereof.

(b) Notwithstanding any other provision contained herein, either Party may terminate the Agreement for convenience (i.e. for any reason or no reason) during the term upon at least ninety (90) days prior written notice to the other Party. Upon termination of this Agreement pursuant to this paragraph, neither Party shall have any liability or obligation to the other Party.

(c) Either Party may terminate the Agreement upon a material breach by the other Party if such breach remains uncured for ninety (90) days following receipt of written notice to cure by the breaching Party.

5. Notices. Any required notices or other contractual communications, such as termination, hereunder shall be made in writing and served by electronic mail to the person(s) at the email address set forth below or such other address as may be designated in writing hereafter, in the same manner:

M. Yadav
01.02.2022

M. Yadav
Principal

R.P.S. College of Engg. & Tech
Balsara, Mohindergarh (HR.)

IF TO RPS GROUP OF INSTITUTIONS:

If to Saylor:
Jacqueline Arnold
Director, Strategic Communications
and Relationships
The Constitution Foundation,
(dba Saylor Academy)
jacqueline.arnold@saylor.org
Tel: 202-333-4005

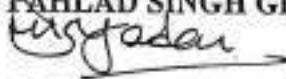
With a copy to:
Jeff Davidson
Executive Director
The Constitution Foundation
(dba Saylor Academy)
jeff.davidson@saylor.org
contact@saylor.org

7. **Entire Agreement.** This Agreement, including attached schedules and exhibits if any, which by reference are fully incorporated as if set forth in entirety herein, constitute the entire agreement between the parties related to the subject matter. This Agreement may be executed through signatures to any number of counterparts, but any or all of such counterparts and documents shall constitute but one agreement.

IN WITNESS WHEREOF, the parties hereto have caused this Agreement to be executed in their names and on their behalf by and through their duly authorized representatives, as of the day and year first above written.

SIGNATURES:

FOR RAO PAHLAD SINGH GROUP OF INSTITUTIONS

BY: 

DATE: 01.02.2022

FOR THE SAYLOR ACADEMY

BY: _____
Jeffery S. Davidson
Executive Director

DATE: _____




RPS College of Engg. & Tech.
Balaha, Indore (M.P.)

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NOW, THEREFORE, in exchange for the non-financial promises and covenants herein, intending to be mutually bound, Saylor and RPS GROUP OF INSTITUTIONS, now agree to this supplemental skill development partnership. The principal terms of this Agreement follow.

1. RESPONSIBILITIES.

(a) RAO PAHLAD SINGH GROUP OF INSTITUTIONS agrees to inform its students about Saylor's free courses to enable them to learn additional skills to supplement their degree program learning. RAO PAHLAD SINGH GROUP OF INSTITUTIONS will provide Saylor with a list of courses it recommends to its students that Saylor may post on its website on a dedicated landing page.

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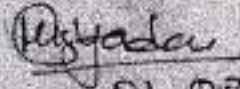
2. Intellectual Property and Usage.

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JSD
02/01/2022


Principal
R.P.S. College of Engg. & Tech
Balana, Mohindergarh (HR.)


01. Director
R.P.S. Group of Institutions
Balana, Mohindergarh
(Haryana)

the right to use its applicable Marks (as defined below) solely for the purpose of fulfilling such party's obligations with respect to this Agreement, provided that such license shall automatically terminate upon termination of this Agreement without the requirement of further notices or any other action by any Party. For the purposes hereof, "Marks" shall mean a Party's trademarks, trade names, service marks and/or logos provided to the other Party for the business purposes outlined herein, or such additional or replacement Marks as either Party may permit in writing the other Party to use solely in connection with the performance of this Agreement. Saylor will review the specifications and guidelines for all RAO PAHLAD SINGH GROUP OF INSTITUTIONS symbols and marks contained in the graphic identity manual provided. The marks contained in this manual are the only marks which are authorized for use and are not to be altered in any way.

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5. Notices. Any required notices or other contractual communications, such as termination, hereunder shall be made in writing and served by electronic mail to the person(s) at the email address set forth below or such other address as may be designated in writing hereafter, in the same manner:



JSD

02/01/2022

Rajyadev

01.01.2022

R.P.S. Group of Insttu
Balana, Mohinderghar
(Haryana)

Rajyadev
R.P.S. College of Engg. & Tech
Balana, Mohinderghar (HR.)

IF TO RPS GROUP OF INSTITUTIONS:

If to Saylor:
Jacqueline Arnold
Director, Strategic Communications
and Relationships
The Constitution Foundation,
(dba Saylor Academy)
jacqueline.arnold@saylor.org
Tel: 202-333-4005

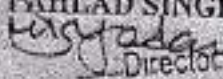
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SIGNATURES:

FOR RAO PAHLAD SINGH GROUP OF INSTITUTIONS


BY: 
Director
R.P.S Group of Institutions
Balana, Mohindergarh
FOR THE SAYLOR ACADEMY

DATE: 01-02-2022



BY: Jeffery S. Davidson
Jeffery S. Davidson
Executive Director

DATE: 02/01/2022


Principal
R.P.S. College of Engg. & Tech.
Balana Mohindergarh (HR)

PEARSON UNDERGRADUATE ENTRANCE EXAM
Institution Recognition Form

Please complete using **BLOCK CAPITALS** for each recognizing program within your institution.

Fields marked * are mandatory

* Institution ("Institution")	Rao Pahlad Singh Group of Institutions
* Authorizing Contact	Dr. Mahesh Kumar Yadav
* Designation	Director
* Email	director@rpsinstitutions.org
* Telephone (Incl. area code)	01285-241431
* Institutional Web Address	https://www.rpsinstitutions.org/
* Institution/Organization Address (including CITY, STATE, PINCODE, COUNTRY)	Rao Pahlad Singh Group of Institutions Balana- Satnali Road, Distt: Mahendragarh -123029 (Haryana)

* Program Address (if different)

Address1 Rao Pahlad Singh Group of Institutions

Address2 Balana- Satnali Road

City Mahendragarh

State/Province/County Haryana, INDIA

PostCode/ Zip Code 123029



To become a recognizing institution please complete your details
 Fields marked * are mandatory.

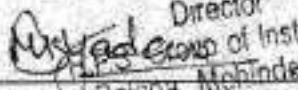
As the admission criteria "Institution" agrees to recognize Pearson Undergraduate Entrance Exam scores to grant admissions to its Undergraduate Courses, The Institution shall treat Pearson Undergraduate Entrance Exam scores at par with any other entrance/admission test scores and subject to candidates fulfilling the eligibility requirements setup by the Institution. Pearson India Education Services Pvt. Ltd (hereinafter referred to as "Pearson" or "Pearson VUE") may use the name and score requirements of Institutions that recognize scores in official Pearson VUE documentation.

(Signature)
 Director
 RPS Group of Institutions
 Balana, Mohindergarh
 (Haryana)



Pearson VUE will not charge any cost to Institution for providing services under this Agreement. No personal names or contact details will be published.

*By signing this form, I represent that I am authorized to accept Pearson Undergraduate Entrance Exam scores for my institution/s and I accept the terms and conditions of this agreement ("Agreement"). I also accept that I comply with Pearson websites Terms of Use and Privacy Policy.

Institution Signature  Director of Institutions
Balaram Mohindergam Date 09-02-2022

Pearson VUE Signature For Pearson India Education Services Pvt. Ltd. Date _____

Return this completed form to:
Pearson VUE

Ground Floor, SB Tower, 1A/1, Sector 16A, Noida 201301, Uttar Pradesh, INDIA
Attr: Pearson Undergraduate Entrance Exam Help Desk

Pearson Undergraduate Entrance Exam Terms and Conditions for Recognizing Institutions/ Organizations

1. Definitions

1.1 "Calendar Year" shall mean January 1st through December 31st.

1.2 "Candidate" shall mean any individual who registers with Pearson VUE to take the Pearson Undergraduate Entrance Exam with respect to a possible admission with the Institution.


1.3 "Effective Date" means the date that Pearson VUE signs and dates this Agreement.

1.4 "Intellectual Property Rights" means (i) all rights, benefits, title or interest in or to any Pearson VUE's Intellectual Property, anywhere in the world (whether registered or not and including all applications for the same).

1.5 "Institution" shall mean the institution on page one (1) contracting with Pearson VUE to recognize the Pearson Undergraduate Entrance Exam as part of its admission criteria.

1.6 "Pearson VUE's Intellectual Property" means: (a) Confidential Information; (b) copyrights; (c) patents; (d) patent applications; (e) technology and technical information; (f) invention; (g) Trademarks; (h) rights in designs and database; (i) any and all intellectual or proprietary rights in relation to the Pearson VUE, its affiliates or its licensor's software, printed materials, processes, databases, or supporting documentation, including but not limited to, the Pearson VUE, its affiliates or its licensor's Delivery System, or any part thereof, and includes any and all adaptations, enhancements, improvements, modifications, revisions, or translations to any of the aforementioned and relating to or arising from any or all of the foregoing, and all extensions and




R.P.S. College of Engg. & Tech.
Balaram Mohindergam (HR)



renewals thereof in India or anywhere in the world and leading to achieving the same or better results in activities carried out and the programmes administered by Pearson VUE or its affiliates; in each case whether registered or unregistered and including applications for the grant of any of the foregoing and all rights or forms of protection having equivalent or similar effect to any of the foregoing whether owned or controlled by or licensed to Pearson VUE or its affiliates.

1.7 "Pearson Undergraduate Entrance Exam" means the Undergraduate Admission Test for Universities, Colleges and Educational Institutions developed and delivered by Pearson VUE.

1.8 "Results" shall mean an individual test taker or a group of test takers qualitative or quantitative measurement(s) attributed to such individual or group's performance on the Pearson Undergraduate Entrance Exam.

1.9 "Testing Center" shall mean a physical facility operated by or on behalf of Pearson VUE used in administering the Pearson Undergraduate Entrance Exam.

1.10 "Trademark" shall mean a general reference to registered and non-registered trademarks, service marks or certification marks.

2 Use of Intellectual Property.

2.1 The Institution may use the Licensed Materials solely in its printed/on-line information and promotional materials only after express written approval of the same by Pearson VUE. The Institution will not publish or distribute Pearson VUE or Pearson Undergraduate Entrance Exam promotional materials before obtaining Pearson VUE's written consent as set forth in this Subsection. Institution acknowledges that the complete trademark for the Pearson Undergraduate Entrance Exam is "Pearson Undergraduate Entrance Exam by Pearson VUE". Institution may use either or both trademarks consistent with these terms and conditions, but may not use variants thereof, when referring to the Pearson Undergraduate Entrance Exam.

2.2 The Institution shall not copy, modify, publish, release, lend, sell, rent, provide access to, create derivative works from or otherwise disclose the Results to anyone other than authorized staff within the Institution. Pearson VUE is the sole owner of, and shall retain the entire rights to, any copyrights, trademark, trade secret, and any other rights in the Results.

2.3 Institution will place an appropriate Pearson VUE's Trademark and/or Pearson VUE's copyright notice on the title or copyright page or other appropriate location of each edition or version of Institution's promotional materials containing any reference to or use of the Pearson VUE's Intellectual Property, along with an appropriate tagline attribution to, or such other notice as Pearson VUE may reasonably request and provide in advance. Institution will not contest Pearson VUE's Intellectual Property Rights in the Pearson VUE Intellectual Property and shall not act in a manner that would tarnish, adversely affect or disparage the Pearson VUE's intellectual property rights and its reputation. Without limiting the foregoing, Institution will not, except as expressly permitted by Pearson VUE, use or apply for registration of (a) any of Pearson VUE's Intellectual Property, or (b) any marks or names that, in the opinion of Pearson VUE, are confusingly or deceptively similar to, or that otherwise incorporate Pearson VUE's Trademarks or other design. Upon expiration or termination of this Agreement, Institution agrees to cease all display, advertising and use of Pearson VUE Intellectual Property. Upon termination or expiration of this Agreement, Institution shall forthwith return to Pearson VUE all Pearson VUE Intellectual Property including soft and hard copies of the Pearson VUE Intellectual Property that are in the



[Signature] Director
R.P.S. Group of Institutions
Balana, Mohindergarh
(Haryana)

[Signature] Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



possession of and/or control of Institution and/or its respective employees and agents. If so requested by Pearson VUE, Institution shall provide written confirmation to Pearson VUE of its compliance with the terms of this Section. Institution recognizes Pearson VUE's ownership and title to the Pearson VUE Intellectual Property and agrees that it will do nothing inconsistent with or adverse to such ownership, and that all use of the Pearson VUE Intellectual Property will accrue to Pearson VUE only. Institution recognizes the goodwill associated with Pearson VUE Intellectual Property and acknowledges that such goodwill belongs exclusively to Pearson VUE.

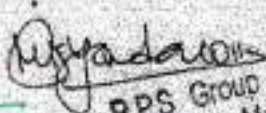
2.4 Access and Use of the Results. Results are only for use by authorized staff members employed by the Institution who have read and agreed to these terms and conditions, Pearson website Terms of Use and Privacy Policy. The Institution agrees to minimize access to the Results to those who legitimately require access to them. Pearson VUE reserves the right to monitor the access and use of the Results by the Institution and its authorized staff members. Pearson VUE reserves the right to discontinue the Institution access to the Results if it is discovered that the Institution has violated the terms and conditions.

2.5 The Institution agrees to access the Results online as directed by Pearson VUE in a secure way, which will not interfere with Pearson's website or its network. Pearson VUE shall share the Results of the candidates who have opted for the Institution while filling their registration form, in a comprehensible format and extend the necessary support in relation to use of the Results.

2.6 Use of the Institution's Trademark/s. During the term of this Agreement, the Institution grants Pearson VUE the right to create Pearson VUE promotional materials using the institution owned materials pursuant to this Agreement, for such promotional materials in relation to Pearson Undergraduate Entrance Exam subject to prior review by the Institution. For such period, the Institution grants Pearson VUE, and Pearson VUE accepts a non-exclusive, non-transferable, royalty-free, worldwide license to use the Institution's Trademarks if such use is in connection with Pearson VUE's promotional activities associated with the delivery of services here under. The Institution so grants Pearson VUE the right to create a webpage for the Institution on the Pearson Undergraduate Entrance Exam website using the logos/promotional materials from the institution owned materials subject to prior review and approval by the Institution for the term of the agreement. Upon expiration or termination of this Agreement, Pearson VUE agrees to cease all display, advertising and use of the Institution's Trademarks. Pearson VUE shall not use for any purpose thereafter any information included in or derived from the Institution's Trademark or Institution's Intellectual Property. Pearson VUE recognizes the Institution's ownership and title to the Trademarks and agrees that it will do nothing inconsistent with or adverse to such ownership, and that all use of the licensed Trademarks will accrue to the Institution. Pearson VUE recognizes the goodwill associated with the Institution's Trademarks and acknowledges that such good will belongs exclusively to the Institution and shall not act in a manner that would tarnish, adversely affect or disparage the Institution's intellectual property rights and its reputation.

2.7 Sublicense and Authorization. Institution grants Pearson VUE a non-exclusive, non-transferable, limited, revocable, royalty free, worldwide license during the Term to sublicense to its affiliates and their third-party vendors, the right to use Institution's Trademarks as set forth in Subsection 2.6 above.

2.8 Use of Pearson VUE Trademarks. During the term of this Agreement only, Pearson VUE grants to the Institution, and the Institution accepts, a non-exclusive, non-transferable, royalty-free, worldwide license to use relevant Pearson VUE Trademarks in connection with their promotional activities of its


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(Haryana)

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Balana Mohindergarh (HR.)



Tests pursuant to this Agreement. The Institution will place on the title or copyright page or other appropriate location of each edition or version of the Institution's promotional materials containing any reference to or use of Pearson VUE Trademarks, if any, an appropriate tagline attribution to, or such other notice as Pearson VUE may reasonably request and provide in advance. Any use of Pearson VUE's Trademarks will be as approved by Pearson VUE in advance. The Parties agree that the Pearson VUE shall review and approve the promotional material incorporating Pearson VUE's proprietary material proposed to be used by the Institution for promotional purposes under this Agreement. Upon expiration or termination of this Agreement, the Institution agrees to cease all display, advertising and use of Pearson VUE's Trademarks. The Institution recognizes Pearson VUE's ownership and title to the Trademarks and agrees that it will do nothing inconsistent with or adverse to such ownership, and that all use of the licensed Trademarks will accrue to Pearson VUE. The Institution recognizes the goodwill associated with Pearson VUE's Trademarks and acknowledges that such goodwill belongs exclusively to Pearson VUE.

3. Term and Termination.


3.1 This Agreement commences on the Effective Date and shall continue, unless terminated as provided in this Agreement, for an initial term of One (01) year ("Term"). Following the initial Term, this Agreement will automatically renew on the same terms and conditions for successive periods of one (01) year each, unless terminated earlier as provided in this Agreement. Nothing in this Agreement shall be interpreted as requiring either party to renew or extend this Agreement.

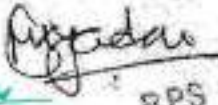
3.2 Termination. Either party can terminate the Agreement by giving thirty (30) days written notice to the other party. Neither party shall terminate the Agreement under clause 3.2 once the Pearson Undergraduate Entrance Exam process starts for the year. Either party can terminate the Agreement under this clause only before first day of October of the year in which the Pearson Undergraduate Entrance Exam registration has started for the successive year. Pearson VUE shall terminate this Agreement with thirty (30) calendar days' notice if Pearson VUE decides not to conduct Pearson Undergraduate Entrance Exam.

3.3 Termination based on Proprietary or Confidential Information. Effective immediately upon written notice to the other party, Pearson VUE may terminate this Agreement, and all rights and licenses granted herein, if the Institution violates or infringes, misappropriates, or otherwise violates the intellectual property, proprietary rights, or any Confidential Information of Pearson VUE, or Candidate.

4. Confidential Information. Each party acknowledges that in the course of performing under this Agreement, or in the course of discussing or negotiating statement of work(s) and/or any Exhibits or future agreements between the parties, a party may learn confidential, trade secret, or proprietary information concerning the other party or third parties to whom the other party has obligations of confidentiality ("Confidential Information"). The party receiving Confidential Information will be referred to as the "Receiving Party" and the party disclosing its Confidential Information will be referred to as the "Disclosing Party".

a) "Confidential Information" means any and all information disclosed to the Receiving Party by the Disclosing Party, or its Agents either orally or in writing: (a) of a technical or conceptual nature consisting of or relating to the databases, software, software documentation, computer based test delivery system, systems, products, services or component parts owned, licensed to, developed or being developed by the Disclosing Party, including, without limitation, the information ascertained from plans, drawings, schematics, sketches, models or descriptions of processes, or


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Director
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(Hariana)




from an inspection of facilities, or from computer programs, databases, software, computer hardware components, or other components of a similar nature; (b) relating to business plans, marketing plans or business opportunities of the Disclosing Party; (c) relating to the Disclosing Party's finances, business, or methods or proposed methods of doing business; (d) All candidate data including, but not limited to, Personal data of candidates; or (d) other information that should reasonably have been understood by the Receiving Party, because of legends or other markings, the circumstances of disclosure, or the nature of the information itself, to be confidential to the Disclosing Party. Confidential Information shall expressly include any and all information derived from a party's proprietary information and the terms and conditions of this Agreement. Each Party's Confidential Information shall include any intellectual property or licensed materials, except logo, trademark and trade name. Each party acknowledges that it acquires only the right to use the Confidential Information of the other party under the terms and conditions of this Agreement for as long as this Agreement is in effect and that neither party shall acquire any rights of ownership or title in the Confidential Information. Upon termination or expiration of this Agreement, each party will return to the other party or certify that it has destroyed all materials containing any of the other party's Confidential Information that is held by that party or its employees, agents or contractors. If so requested by the Disclosing Party, the Receiving Party agrees to provide written confirmation to the Disclosing Party of its compliance with the terms of this Section.

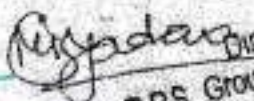
b) Confidential Information does not include information which:

(aa) is or becomes a part of the public domain without breach of this Agreement or another agreement; (bb) is disclosed to the Disclosing Party by third parties without restrictions on disclosure; (cc) is developed independently by the Receiving Party without reference to the Disclosing Party's materials or information; (dd) was in the Receiving Party's possession and the Receiving Party was able to disclose this information without breach of any other confidentiality arrangement before receiving such information from the Disclosing Party; or (ee) comes into the party's possession without breach by that party of any obligations of confidentiality.

c) Protection of Confidential Information. The Receiving Party shall protect the Disclosing Party's Confidential Information by using the same degree of care, but no less than a reasonable degree of care, to prevent the unauthorized use, dissemination, or publication of the Confidential Information as the Receiving Party uses to protect its own Confidential Information of a like nature. Except as may be authorized by the Disclosing Party in writing or necessary for Pearson VUE to deliver the Pearson Undergraduate Entrance Exam under this Agreement, the Receiving Party will (a) not disclose Confidential Information to any person who is not a party to this Agreement; (b) limit dissemination of Confidential Information only to its Agents having a "need to know"; and (c) have an appropriate written agreement with its Agents requiring that they comply with all of the provisions of this Agreement. Pearson VUE shall not be liable for disclosure of confidential information to a Candidate or as reasonably necessary to perform the services here under.

d) In the event that the Receiving Party, or its Agents are compelled to disclose any Confidential Information pursuant to a valid order of a court or other government body, the Receiving Party will promptly notify the Disclosing Party and provide reasonable cooperation and reasonable efforts to the Disclosing Party in connection with the Disclosing Party's efforts to lawfully avoid or limit disclosure and preserve the confidentiality of the Confidential Information in such circumstances, if made in a fashion that maximizes the protection of the Confidential Information from further disclosure.


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)


DIRECTOR
R.P.S. Group of Ins.
Balana, Mohindergarh
(Haryana)



e) Notwithstanding anything herein, Institution authorizes Pearson VUE to provide with a copy of this Agreement to its affiliates along with other information or data as reasonably necessary to provide the services here in.

4.1 Data Protection. The Institution shall comply with, and shall not act in any way, which may breach, any law or regulation dealing with the processing of privacy and/or personal data relating to any individual or corporation (including without limitation the Information Technology Act, 2000; the (Indian) Contract Act, 1872 and any other applicable law or regulation. The Institution agrees to establish secure safeguards to protect such information from unauthorized use, disclosure and/or misuse. The Institution agrees to immediately inform Pearson VUE of any unauthorized use, breach, loss or disclosure of the Results.

5. Warranty. Both Parties hereby represents and warrants to each other that:


- a) Both Parties have been established and validly existing under the laws of India and Institution has obtained all requisite licenses/ approvals required by it to impart Undergraduate Programs in India
- b) Both Parties have obtained all the approvals, consents and permits necessary or applicable under any applicable law for the execution, delivery and performance by it of this Agreement. The execution and delivery of this Agreement has been duly authorized and approved and does not require any further authorization or consent of any third party
- c) any representation or warranty made by the Parties in this Agreement or in any certificate or other instrument delivered pursuant to this Agreement neither contains any untrue statement nor omits to state any material fact necessary to make the statements contained herein or there in misleading
- d) Upon execution, this Agreement will be its legal, valid and binding obligation, enforceable in accordance with its terms.
- e) The Institution represents that it has independently perused the contents, methods of the Pearson Undergraduate Entrance Exam and is satisfied about its efficacy
- f) Both Parties represent and warrant that they will not use each other's IP in such a manner so as to amount to infringement of any third-party IP rights.

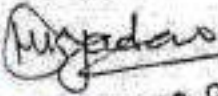
5.1 WARRANTY DISCLAIMER: THE WARRANTIES IN THIS AGREEMENT REPLACE ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, INCLUDING ANY WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE. ALL OTHER WARRANTIES ARE DISCLAIMED AND EXCLUDED BY THE PARTIES.



6. Indemnification.

Institution agrees to indemnify, defend, and hold harmless Pearson VUE and Pearson VUE's directors, officers, employees, successors, and assigns from and against any and all third party claims, demands, losses, liabilities, actions, lawsuits, proceedings, judgments, awards, and expenses (including reasonable attorneys' fees) to the extent resulting from Institutions (a) breach of this Agreement; (b) breach of Confidentiality provisions; (c) Violation of Pearson's Website Terms of Use and Pearson Privacy Policy; (d) Violation of Laws (e) infringement of Pearson VUE's Intellectual Property; or (f) failure to accept Pearson Undergraduate Entrance Exam scores subject to candidate fulfilling Institution's admissions eligibility criteria.

7. Limitation of Remedies and Limitation of Liability.


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Director
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7.1 In no event shall Pearson VUE be entitled to Institution for indirect, special, incidental, or consequential loss or damages

7.2 Regardless of the form of action, except for the Indemnification Obligations contained herein, either party's aggregate liability in any Calendar Year during the term of this Agreement for damages, claims, costs, settlement amounts, and/or awards will not exceed Ten Lakhs Indian Rupees (INR 10,00,000.00). For the purposes of applying this Limitation of Liability, each instance of liability is applied to the Calendar Year in which the earliest date of the circumstance giving rise to the liability occurs.

8. General

8.1 Non-Exclusive Arrangement. None of the provisions of this Agreement shall be deemed to constitute a partnership between the Parties and no Party shall have any authority to bind the other Party otherwise than under this Agreement or shall be deemed to be the agent of the other in any way. Nothing contained in this Agreement shall in any way restrict Pearson VUE's right to provide services or facilities similar to the Services and matters contemplated under this Agreement for any other school, university or institute in India or elsewhere in the world.

8.2 Force Majeure. The obligations of the parties under this Agreement (including all obligations of Pearson VUE relating to time limits and deadlines for implementation and updating under this Agreement) shall be suspended, to the extent a party is hindered or prevented from complying therewith because of acts of state or governmental authorities, acts of terrorism, natural catastrophes, fires, storms, floods, earthquakes, riots, insurrection, civil disturbance, sabotage, embargos, blockades, acts of war, acts of God, power failure, failure of Internet access or service, communication line failures, epidemic or any other cause whatsoever beyond a party's control.

8.3 Failure to Perform. Pearson VUE's failure to perform under this Agreement shall be excused if such failure to perform is due any cause whatsoever beyond Pearson VUE's control. If Pearson VUE decides to not conduct Pearson Undergraduate Entrance Exam for whatever reasons, then Pearson VUE will be excused from its obligation and the agreement shall stand terminated.

8.4 Entire Agreement. This Agreement constitutes the entire understanding between the parties regarding the subject matter hereof, and supersedes all prior express or implied, negotiations, proposals, bids, orders, communications and agreements. This Agreement shall not be deemed or construed to be modified, amended, rescinded, canceled or waived in whole or in part, through a purchase order or otherwise, except by written amendment duly executed by the parties hereto. The parties acknowledge that they have not been induced to enter into this Agreement by any representations or statements not found in this Agreement.

8.5 Assignment. Institution may not assign this Agreement, by operation of law or otherwise, without the prior written approval of Pearson VUE, which approval will not be unreasonably withheld, conditioned or delayed.

8.6 Survivability. It is mutually agreed that any provisions of this Agreement, which by their nature, should reasonably survive termination or expiration of this Agreement will survive.

8.7 Independent Contractor. Pearson VUE's relationship to the Institution is that of an independent contractor. Neither party shall be deemed to be or hold itself out as a partner, agent, employee or joint venture partner of the other party.


Principal
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Balana Mohindergarh (HR.)


Director
RPS Group of Ins
Balana, Mohindergarh
(Haryana)



8.8 Governing Law, Venue Attorneys' Fees and Arbitration.

This Agreement and its performance shall be governed by and construed in all respects in accordance with the laws of India. In the event of a dispute relating to any of the matters set out in this Agreement, parties to the dispute shall each appoint one nominee/representative who shall discuss in good faith to resolve the difference. In case the difference is not settled within 30 (thirty) days, it shall be referred to arbitration in accordance with the Arbitration & Conciliation Act, 1996 to a sole arbitrator mutually appointed by the Parties. The place of arbitration shall be New Delhi. The award of the arbitral tribunal shall be final and conclusive and binding upon the Parties.

8.9 No Third-Party Beneficiaries. This Agreement is solely for the benefit of the parties hereto and no provision of this Agreement shall be deemed to create any rights in, be deemed to have been executed for the benefit of, nor confer upon any other person or entity not a party hereto any remedy, claim, liability, reimbursement, cause of action or other rights.

8.10 Disclaimer.

- a) Pearson does not warrant that access to the Results will be uninterrupted; free of viruses or that the Results themselves will be error free. The Institution is solely responsible for all costs, expenses and damages arising out of its access to the Results on account of such interruptions, viruses or errors. Pearson VUE shall not be liable to the Institution for direct, indirect, special, consequential loss or damages of any nature whether such liability is asserted on the basis of contract, tort or otherwise. Nothing in these terms and conditions shall exclude either party's liability to the as a result of any fraudulent misrepresentation or negligence of the other party.

8.11 How to Contact Us. If you have any questions or concerns about the terms and conditions, please contact us at atpvapchannelsales@pearson.com.



Signature
Director
R.P.S. Group of Ins
Balana, Mohindergarh
(Harayan)

Signature
Principal

R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



MEMORANDUM OF UNDERSTANDING

This MEMORANDUM OF UNDERSTANDING ("M.O.U"/ "Agreement") is made as on the day Wednesday, 25th May, 2022 by and between

Edify Educational Services Pvt Ltd, located at Hitech City, Hyderabad hereafter referred as "EdifyPath" which expression shall unless repugnant to the context or meaning thereof include its successors and assignees.

And

Rao Pahlad Singh Group of Institutions located at Balana, Mahendragarh- Haryana hereafter referred as "RPSGOI", which expression unless repugnant to the context or meaning thereof be deemed to include, legal representative, executors, administrators, successors and permitted assigns of the other PART.

Each individually a Party and collectively referred to as Parties.

WHEREAS, the EdifyPath and RPSGOI have come together to collaborate for up-skilling the students of RPSGOI under subscription of EdifyPath Certification Program and providing opportunities for Internship and jobs to excellent students

WHEREAS As of the date hereof both Parties as above have expressed a desire of entering into a Memorandum of Understanding (M.O.U) agreement to meet their respective objectives, which are set out here in below.

NOW, THEREFORE, It is hereby agreed by and between the undersigned Parties as follows:

BACKGROUND OF THE PARTIES

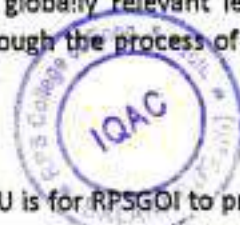
EdifyPath is a global online experiential e-learning platform that is focused on bridging the talent-gap across rising technology demands and helping learners acquire industry-specific skills that make them corporate-ready and ease their transition into the corporate world. EdifyPath offers a range of professional certified courses by various industry experts which are high in demand in the current day job markets. Its association and tie-ups with global industry leaders gives EdifyPath an edge in designing unique content that keeps our learners much ahead in the learning curve. EdifyPath through one of its unique offerings "EdifyTalks" provides unique power clips from industry leaders and senior executives that offer valuable insights for career prospects to its learning community.

RPSGOI is an Education institute that intends to offer its students a globally relevant learning experience, by providing high quality, affordable and accessible education. RPSGOI through the process of co-creation intends to elevate its students to serve the emerging talent needs of Industry.

PURPOSE

The purpose of the collaborative relationship contemplated by this M.O.U is for RPSGOI to promote a talent pool of young students, while facilitating their upskilling using EdifyPath's Platform (as defined below) and enabling them acquire new and relevant competencies as per the current market requirements and for EdifyPath to nurture the young talent, making the students more employable and industry ready ("Purpose"). For Achieving the Purpose, either parties hereby agree to collaborate with each other and enter into this MOU for non-commercial purposes and further agree that the relationship contemplated by this MOU is non-monetary in nature.


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R.P.S. College of Engg. & Tech
Balana, Mahindergarh (HR.)



Edify Educational Services Private Limited,
Villa No 32, G Floor, Bollineni Homes, Madhapur,
Hyderabad, Telangana, India, 500081



+91 40 4425 1111
+91 40 4425 1122



info@edifypath.com
www.edifypath.com

DELIVERABLES:

EdifyPath agrees to provide the following forms of support to the RPSGOI on a good faith basis:

- a. Provide access to a world of knowledge across rising technology demands and helping its learners acquire industry specific skills
- b. Provide access to Edify Talks to enable learners gain insights from industry leaders and senior executives that will help in getting the bigger picture of various industries and the required competencies (domain, technical, behavioral and communication) to enter and excel in the career.
- c. EdifyPath to extend at a special promotional Price, which shall be applicable exclusively for the RPSGOI.
- d. EdifyPath to provide services enabling its learners acquire new competencies in accordance with current market requirements anytime, anywhere upon subscription.
- e. EdifyPath to provide opportunities for Internship and placement support for excelling candidates upon successful completion of EdifyPath Certification Program(s).
- f. EdifyPath to conduct Technical workshops for the Students of RPSGOI.
- g. EdifyPath to provide access to Khelo Application as part of the subscription as per the terms detailed below in this Agreement.

RPSGOI Deliverables:

RPSGOI by and through its principals and agents, agrees to provide opportunities to "EdifyPath" and its center of excellences, as appropriate, on a good faith basis,

- a. To promote EdifyPath and EdifyTalks amongst the student community, faculty and staff for skill-development.
- b. To support EdifyPath in to run running awareness campaigns in RPSGOI premises.
- c. To render any additional support to achieve the deliverables mentioned in this Agreement.

Platform:

EdifyPath will provide RPSGOI access to its online learning interface where RPSGOI can access the courses, content, marketing materials that are being offered including a limited period subscription to certain third party applications and materials as a value addition to the products being offered to RPSGOI.

License Grant

Except for the license and access rights granted in this Agreement, nothing in this Agreement grants any title or ownership interest in or to any Intellectual Property Rights in or relating to, the Platform, marketing materials or third party materials, whether expressly, by implication, estoppel or otherwise. All title and ownership interest in and to the Platform, marketing materials and the third party materials are and will remain with EdifyPath and the respective rights holders in the third party materials.

Khelo RPSGOI Clad Application:

As part of the offerings and through its collaboration with third parties and as a value addition, EdifyPath will provide a limited period free subscription and access to the Khelo RPSGOI Clad Application ("Khelo") for the benefit of RPSGOI for a period of 12 months from the Effective Date ("Initial Period"). Khelo will be a complimentary product offering provided pursuant to this Agreement that either works as an independent application or as an integrated application with the Platform. Khelo is being offered as part of the service offering which can provide for student engagement through knowledge sharing, event hosting, contests, promotional events and sharing of articles, contents among the students etc. Post the expiry of the Initial period certain subscription fee might be applicable for continued utilization of Khelo as agreed upon between the RPSGOI and the applicable third party owners.



Disclaimer of warranties:

Except for the express warranties provided in this Agreement, all applications, the Platform and materials are provided "as is" and EdifyPath hereby disclaims all warranties, whether express, implied, statutory or other, and EdifyPath specifically disclaims all implied warranties of merchantability, fitness for a particular purpose, and all warranties arising from course of dealing, usage or trade practice. Without limiting the foregoing, EdifyPath makes no warranty of any kind that the applications, the platform, materials, or any products or results of the use thereof, will meet RPSGOI's or any other person's requirements, operate without interruption, achieve any intended result, be compatible or work with any software, system or other services except if and to the extent expressly set forth in the specifications, or be secure, accurate, complete, free of harmful code or error free. All third-party materials are provided "as is" and any representation or warranty of or concerning any third party materials is strictly between RPSGOI and the third-party owner or distributor of the third-party materials.

Confidentiality:

RPSGOI will hold in strict confidence the confidential information disclosed by EdifyPath in furtherance of this Agreement. RPSGOI shall use the confidential information in accordance of the terms and solely for achieving the Purpose of this Agreement. RPSGOI agrees not to disclose confidential information to any other parties without the prior written consent of EdifyPath. RPSGOI will exercise at least the same degree of care it uses to protect its own confidential information.

The obligations of confidentiality do not apply to information (i) that becomes publicly available for no fault of the RPSGOI; (ii) can be demonstrated by written evidence that it was in the possession of the receiving Party prior to receipt from EdifyPath; (iii) independently developed by the Parties without use of information disclosed by the other Party.

Limitation of liability

The Parties shall not be liable for any incidental, special, indirect or consequential damages arising out of or relating to this Agreement.

Intellectual Properties:

GOI hereby grants EdifyPath a royalty-free, non-exclusive, non-transferable, non-sub licensable, limited term license to use RPSGOI's marks solely for the purpose of aligning the appearance of its products branding and only as specifically authorized by, and subject to any restrictions stated in, this Agreement. Such license shall be limited to the duration of this Agreement. During the Term of the Agreement, EdifyPath may include RPSGOI in any of EdifyPath's customer lists and testimonials, solely for the purpose of identifying RPSGOI as a customer of EdifyPath. EdifyPath acknowledge that the provisions of this paragraph do not convey any right, title or ownership interest in RPSGOI's marks to EdifyPath Except for the license and access rights granted under this Agreement nothing in this Agreement grants any title or ownership interest in or to any Intellectual Property Rights of one Party to the other. RPSGOI hereby unconditionally and irrevocably grants to EdifyPath an unrestricted license to use including all Intellectual Property Rights relating thereto.

Information Sharing:

In connection with this Agreement either Parties shall during the Term of this Agreement shall provide, accommodate and make available as required access to each other's information (students databases by RPSGOI and any customer information shared by EdifyPath) and hereby agree to share such information with each other solely for the accomplishment of the Purpose of this Agreement. Either Parties acknowledge and agree not to use,

decimate to any third party, share or use such information for any other purposes otherwise than as stated in this Agreement and hereby agree to maintain such information in strictest confidence.

Term of the Agreement

This Agreement shall commence from the Effective Date above and shall continue to be in force unless terminated by either Parties as per the terms of this Agreement ("Term").

Marketing Collaboration:

Either Parties to this Agreement agree to cooperate with each other in the marketing and promotion of the products and services of the Parties in furtherance of achieving the Purpose of this Agreement. Such cooperation shall include the reasonable provision, at the Party's expense, reasonable participation and assistance, as agreed to by the Parties, with trade shows, conferences, company sales conferences and education seminars etc.

Termination

engagement contemplated between the Parties under this M.O.U. is at-will. Upon the discretion of the either of the Parties the collaborative relationship under this M.O.U. may be terminated with an advance written notice of 30 days to the other Party. Upon termination of the Agreement for any reason either Parties shall promptly return to the other Party all confidential information of the other Party. Except for the obligations which are logically ought to survive, all other rights and obligations of the Parties under this Agreement shall expire upon termination of this Agreement.

Entire Agreement


This M.O.U. is the final and complete understanding and agreement of the undersigned Parties. No other promises, agreements, nor warranties have been provided. This M.O.U. may only be amended by a written agreement as provided in this M.O.U.

Applicability

The terms and provisions in this MOU also apply to any subsequent Addendum(s) to this Agreement.

IN WITNESS WHEREOF, the undersigned Parties hereto have executed this MOU on the day Saturday, 17th October,

	Edify Educational Services Pvt. Ltd.		RPSGOI
<u>Signature</u>			 25.5.2022
<u>Name</u>	K E Ajay Varma		Dr. Mahesh K. Yadav
<u>Title</u>	Business Development Manager		Director R.P.S. Group of Institutions Balana, Mohindergarh (Haryana)


Principal
R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



DRAGONCHAIN

Memorandum of Understanding
Between

Rao Pahlad Singh Group of Institutions
Balana, Dist: Mahendragarh, Haryana-123029

Represented by: **Dr. Mahesh K Yadav**
Designation: Director
Address: Balana, Dist: Mahendragarh, Haryana-123029
and

India Block Chain Alliance, IBA /TPCRA World
Represented by: **Mr. Raj A. Kapoor**
Founder
India Block Chain Alliance, New Delhi

Towards
Global Block Chain Centre of Excellence,
Rao Pahlad Singh Group of Institutions
Powered by
India Blockchain Alliance, TPCRA World and Dragonchain,
USA




Principal
R.P.S College of Engg. & Tech
Balana Mohindergarh (HR.)



DRAGONVHO

This Memorandum of Understanding ("MOU") is executed as of date: 28 March 2022 ("Effective Date") between

Party 1 –Rao Pahlad Singh Group of Institutions refer as RPS GOI

RPS GOI, Balana a private group of institutions offering education in Engineering, Science, Arts Management & Polytechnic was formed with a goal to find solutions to the greatest technological and social problems of the 21st century. The students of RPS GOI are trained to become future leaders who will have the capability to lead giant organizations in the emerging corporate landscape. RPS GOI is dedicated to provide students with real world and practical academic exposure that will transform them into successful professionals.

Address – Balana,Dist: Mahendragarh, Haryana-123029, India

Party 2 – Indian Blockchain Alliance,IBA/ TPCRA World

TPCRA World Along with IBA promotes all emerging technologies like Blockchain, AI, IoT, AR-VR, Robotics and other latest technologies by having collaborations across the Globe. The working model is wherein targeted specialist and expert Global companies are engaged to develop projects and contents to be delivered in Education Institutions, Industry or Government depending on the Service extended

The India Blockchain Alliance, IBA was established in 2010, with the purpose of mutual assistance in the field of business development, networking, cooperation and a joint approach to defending the interests of the members of the alliance. It also seeks to raise awareness of the importance of the blockchain technology among the professional and lay public, and, therefore, organizes various events and training courses. It also cooperates with the government authorities in the field of the relevant legislation.

The India Blockchain Alliance is a key player in the process of creating a setting that will transform India into a global blockchain destination. The members will work harmoniously and in unison for the benefit of the individual and collective business development of blockchain companies.

Today, (IBA/TPCRA World) is the most influential voice in the blockchain industry. It is a not-for-profit organization that promotes evidence-based adoption of Blockchain and Distributed Ledger Technologies (DLT) across the public and private sectors.



Page 2 of

Signature
Principal

RPS College of Engg. & Tech
Balana, Mahendragarh (Haryana)



DRAGONWORLD

PREAMBLE

Whereas, RPS Group of Institutions referred as RPS GOI, at its various engineering and sciences departments is envisioned with responsibility of training technical and scientific manpower in various front-line areas of importance for the Nation and is also contributing to the rapidly growing scientific and technological knowledge and professional excellence in Science & Technology by undertaking industrial & applied research and consultancy.

WHEREAS, Indian Blockchain Alliance hereby referred as IBA/TPCRA World, is engaged in training, research and development blockchain and emerging technologies, research, design and development and consultancy in the field of Blockchain, Fintech, DeFi and multiple emerging technologies and related fields.

WHEREAS, both RPS GOI and IBA/TPCRA World, now

- Recognizing the importance of research and development in the areas of blockchain and multiple emerging technologies, as well as imparting industrial training to the engineering/technology/sciences students and professionals.
- Appreciating the need for creation of large reservoir of highly qualified manpower in all fields related to blockchain and multiple emerging technologies.
- Desiring to club their efforts by pooling their expertise and resources
- Networking with collaborations in the emerging area of Blockchain Technology
- Generating outcomes in terms of better opportunities to the beneficiaries in terms of projects, internship, consultancy

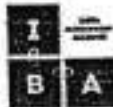
INTEND to form a nucleus for promoting excellent quality manpower in the fields of engineering, technology and sciences with special emphasis on blockchain and multiple emerging technologies.

NOW, THEREFORE, in consideration of the mutual promises made herein and of good and valuable consideration, the receipt and sufficiency of which both RPS GOI and IBA/TPCRA World hereby acknowledge, RPS GOI and IBA/TPCRA World hereby agree to sign a memorandum of understanding (MOU)



Anjadar
Principal

R.P.S. College of Engg. & Tech
Balana, Mohindergerh (HR.)



DRAGONCHAIN

ARTICLE-I: SCOPE OF THE MOU

This MOU details the modalities and general conditions regarding collaboration between RPS GOI and IBA/TPCRA World for enhancing the availability of highly qualified manpower in the areas of blockchain and multiple emerging technologies without any prejudice to prevailing rules and regulations in RPS GOI and IBA/TPCRA World without any disregard to any mechanism evolved and approved by the competent authorities under Govt. of India in so far as such mechanism applies to RPS GOI and IBA/TPCRA World. The areas of cooperation can be extended through mutual consent.

ARTICLE-II: SCOPE AND TERMS OF INTERACTIONS

Both RPS GOI and IBA/TPCRA World shall encourage interactions between the Engineers, Scientists, Research fellows, faculty members and students of both the organizations through setting up a Centre of Excellence with the skills hub where government and industry will secure blockchain expertise and all their resource requirements. The Center of Excellence at SAGE College, Bhopal cofounded by RPS GOI and IBA/TPCRA World and Dragon Chain which would be called


**Global Blockchain Centre of Excellence,
RPS Group of Institutions
Powered by**

**India Blockchain Alliance, TPCRA World and Dragonchain,
USA**

is developed and will be enhanced with collaborators in global blockchain industry organization, Queensland Government, Blockchain Collective, Local Australian companies and evolving partnerships of either parties to deliver the goals. The activities carried out in the CoE will be

- Education/ training / certification
- Integrated programs with International Universities
- Internships
- Strategic mentoring
- Business networking
- Government partnership projects
- Joint Research Funding Opportunities
- Industry events




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R.P.S. College of Engg. & Tech
Balana Mohindergarh (HR.)



DRAGONVHO

- Blockchain Employment Placements
- Blockchain Consulting
- Joint Consultancies

The RPS GOI and IBA/TPCRA World partners will also be able to connect, collaborate with the alliance partners jointly in these activities

Besides the above the following activities are also proposed:

- Organization of joint conferences and seminars;
- Practical training of RPS GOI students, professionals
- Joint guidance of student projects in blockchain and multiple emerging technologies and other areas of national interest at RPS GOI by IBA/TPCRA World on mutually agreeable terms.
- IBA/TPCRA World may depute its personnel as visiting faculty at College to teach any of the regular Course or specialized topics when requested.
- IBA/TPCRA World may assist in recommending an expert faculty to deliver courses/workshops/trainings to the students/staff of RPS GOI.
- Gateway towards the learning opportunities, internships and advance education to the universities who also become part of the alliance.
- IBA/TPCRA World may showcase its business activities at the seminar/workshop/conference, etc. at RPS GOI.
- In any of the projects mentioned, wherever financial aspects are involved, amount, payment conditions, etc. would be spelt out clearly before starting the activity.

ARTICLE-III: SHARING OF FACILITIES

- RPS GOI and IBA/TPCRA World shall make provisions to share their respective important infrastructure facilities in order to promote academic and research interaction in the areas of cooperation.
- IBA/TPCRA World and RPS GOI will be sharing software and other materials and components developed in-house in the areas of cooperation, if permissible within the rules governing the two institutions. However, responsibility for safety of software and other materials during the exchange will rest on respective Head of academic department/section of the College.

ARTICLE-IV: CO-ORDINATION OF THE PROGRAMME INCLUDING FINANCIAL ARRANGEMENTS



Page 6 of

[Signature]
Principal

R.P.S. College of Engg. & Tech
Balana Mohinder Garh (HR)